MODELING OF TRANSIENT HEAT PIPE OPERATION

Final Report

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SUMMARY

Mathematical models and an associated computer program have been developed for heat pipe startup from the frozen state. The models have been checked against previously published analytical and experimental data. Agreement is relatively good for most situations examined.

When a liquid metal heat pipe is started by introducing heat to one end while cooling the other, internal working fluid dynamics may greatly affect temperature distributions and fluid properties within the pipe as well as the overall conductance of the pipe. For example, if the working fluid is initially frozen, during startup melting will occur in the capillary structure and the vapor will experience free molecular, choked, and continuum flow at various times. These changing internal conditions generally make the heat pipe relatively slow to transport energy from heated to cooled ends and very large radial and axial temperature gradients may develop.

The present work uses finite element formulations of the governing equations written for each heat pipe region for each operating condition experienced during startup from a frozen state. In the shell, energy transport is by conduction only. In the capillary structure, conduction and heat of fusion are considered. In the vapor region different sets of governing equations are utilized for regions undergoing free molecular, choked and normal continuum flow. The various models were checked against analytical and experimental data available in the literature for three specific types of operation. For example the models used to predict melting in the capillary structure were checked against analytical results previously published for melting in a corner region.

Computation using the methods developed in the present work were made for

a space shuttle reentry mission where a heat pipe cooled leading edge was used on the wing. This wing had a sodium heat pipe built into the wing near the leading edge. Charles J. Camarda of NASA Langley Research Center made experimental measurements of startup behavior for such a heat pipe. Results computed in this work compared well with Camarda's data.

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LIST OF SYMBOLS

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a	condensation or evaporation coefficient
Α	area
A_{c}	cross-section area of the vapor space
c _p	specific heat
С	volumetric heat capacity
D	height of the vapor space
E_f	energy factor
f	dimensionless stream function
$f_i(x)$	functions which describe the curvatures of the wing section
F	friction factor
Fo	Fourier number
h	enthalpy
h _{cr}	heat transfer coefficient
h_f	enthalpy of saturated liquid
h_{fg}	latent heat of vaporization
Н	enthalpy per unit volume
H_{ls}	latent heat of phase change
k	number of nodes assigned to the element
K	thermal conductivity
K _n	Knudsen number
l	direction cosine
L	total length of heat pipe
$\triangle L_i$	side length of element
m	number of elements at the interface

'n	rate of condensation or evaporation per unit area
М	molecular weight
M_f	momentum factor
n	unit outward normal direction
N_i	shape function
Р	pressure
\dot{Q}	heat input rate
Ä	heat input rate per unit area
R	solution domain
R_{g}	thermal resistance
R_u	universal gas constant
Re_{\circ}	wall Reynolds number
S_i	interface position
S	chordwise direction
t	time
Т	temperature
T_m	temperature of phase change
T_{\circ}	initial temperature
T,	specified surface temperature
T_{∞}	reference temperature
U	X - component of velocity
$U^{*}(0)$	average velocity at $X = 0$
v	specific volume of vapor
v_f	specific volume of saturated liquid
v_{g}	specific volume of saturated vapor
V	average velocity at cross section

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V^*	Y - component of velocity
$ar{V}$	control volume
V_{\circ}	velocity at porous wall
W	width of the vapor space
X	coordinate direction
X_q	quality of vapor
Y	coordinate direction
<u>Greek symbols</u>	
α	thermal diffusivity
$oldsymbol{eta}$	$\sigma arepsilon LT^3/K$
γ	ratio of specific heats
ε	porosity of wick
ε	emissivity
λ	length of mean free path
μ	dynamic viscosity
ν	kinematic viscosity
ρ	density
σ	Stefan-Boltzmann constant
$oldsymbol{\psi}$	angle used to identify chordwise location
au	shear stress
arphi	stream function
ω	dimensionless length coordinate
Subscripts	
1	heat pipe shell
2	capillary structure
21	old phase

22	new phase
a	adiabatic section
c	condenser
CT	convection
e	evaporator
f	liquid state
g.	vapor state
i	index
0	liquid-vapor interface
r	radiation
x	X direction
у	Y direction
<u>Superscripts</u>	
*	transition from free molecular to continuum flow
(e)	element

CHAPTER I

INTRODUCTION

1.1 Statement of the problem

Since the heat pipe concept was first introduced independently by Gaugler[1] in 1942 and Grover[2] in 1963, theoretical and experimental studies have been underway to understand and develop heat pipe technology. Most theoretical studies concern certain portions of the heat pipe, such as the evaporator, condenser, capillary structure, and vapor flow region. The overall performance of the entire heat pipe, including the thermal behavior along the heat pipe wall and capillary structure, vapor flow dynamics, and the various types of boundary conditions on the evaporator and condenser surfaces have received less attention. However, the steady state characteristics of heat pipe performance at low temperatures and under normal operating conditions are relatively well understood, and heat pipes have been successfully applied in various fields.

Little research has been done on the transient case. Transient behavior of heat pipes have been experimentally and numerically studied for low temperatures and working fluids with high vapor density by Chang and Colwell[3,4,5].

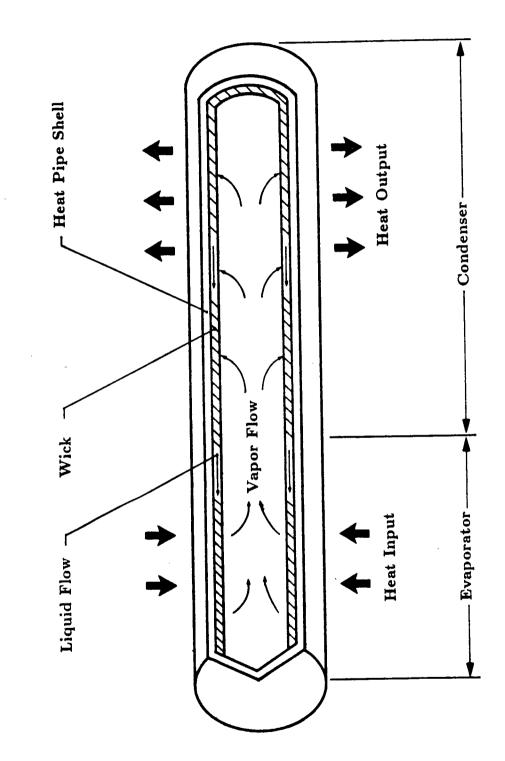
Recently, use of the heat pipe has been considered as a means of reducing the peak temperature and alleviating the thermal gradients at the leading edges of reentry vehicles and hypersonic aircraft, and in nuclear reactors. In these applications, the rate of heat transfer may be large, and the range of operating temperatures broad, from ambient to high temperature, so that liquid metal, which is in the solid state at ambient temperature, may be used as the working fluid. Under these conditions, the working fluid in the capillary structure may be in the solid or liquid state, or may be freezing or thawing, with some liquid and some solid present. The vapor flow may be free molecular, continuum, choked, or some combination of these. No complete research has been reported on this subject.

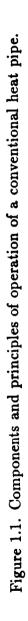
The primary objective of this research is to investigate analytically the performance of an entire heat pipe with metallic working fluid during startup from a frozen state. To accomplish this goal, a mathematical model has been developed, and a numerical solution technique tested to predict the transient temperature distributions along the heat pipe, and the optimal heat transfer rate.

1.2 Description of heat pipe operation

Many scientists and engineers have observed the phenomenon of surface tension in nature and tried to understand, formulate, and apply it for improving human life. Among many natural phenomena, the action of surface tension can raise liquid against a gravity force within a small vertical tube or gauze with a portion immersed in liquid. This capillary action can transport liquid through suitable materials without using external power. When phase change takes place from one state to another, the change of enthalpy is rapid, and the difference between enthalpies of two states is large. Therefore a large amount of energy may be absorbed or released depending on the direction of phase change, and without a large temperature gradient. These two phenomena are utilized in a heat pipe.

A heat pipe consists mainly of a shell as the container, a capillary structure or wick to transport liquid by using surface tension, and a vapor space to provide vapor passage as shown in Figure 1.1. Heat pipe shells have been made of stainless steel, copper, nickel alloys, hastelloy, et cetera. Wire screen, fiber glass, porous metal, and woven cloth have been used as capillary structures. Narrow grooves cut lengthwise in the interior pipe wall have also served as a capillary structure. The capillary





structure is saturated by the working fluid in the liquid state, and the vapor space is occupied by the working fluid in the vapor state. Heating and/or cooling devices are applied to the outer surface of the heat pipe shell. In the longitudinal direction, the heat pipe consists of an evaporator and a condenser.

Heat added to the evaporator is transferred to the working fluid by conduction and causes vaporization of the working fluid at the surface of the capillary structure. Vaporization causes the local vapor pressure in the evaporator to increase and vapor to flow towards the condenser thereby transporting the latent heat of vaporization. Since energy is extracted at the condenser, the vapor transported through the vapor space is condensed at the surface of the capillary structure, releasing the latent heat. The radius of curvature of the meniscus in the capillary structure of the evaporator is decreased and that in the condenser is increased. This difference in radii between the two sections creates the pumping force that transports the liquid from the condenser to the evaporator through the capillary structure. This process continues so long as no extreme heat fluxes are encountered.

Hence, in a heat pipe energy is transported by utilizing phase change of the working substance instead of a large temperature gradient and without external power. Also, the amount of energy transferred through a small cross-section is much larger than that by conduction or convection. Heat pipes may be operated over a broad range of temperatures by choosing an appropriate working fluid, as shown in Table 1.1[6].

However, this useful device has some operating limitations such as the sonic limit, the capillary limit, the entrainment limit, and the boiling limit. When any of these limitations is encountered, the capillary structure may dry out leading to failure of the heat pipe. In addition to these limitions, when liquid metal is used as the working fluid, startup difficulty may take place due to possible solid state of

Medium	Melting	Boiling point	Useful range		
	point	at atmos. press.			
	(°C)	(°C)	(°C)		
Helium	- 272	- 269	- 271 -	- 269	
Nitrogen	- 210	- 196	- 203 -	- 160	
Ammonia	- 78	- 33	- 60	- 100	
Freon 11	- 111	24	- 40	- 120	
Pentane	- 130	28	- 20	- 120	
Freon 113	- 35	48	- 10	- 100	
Acetone	- 95	57	0	_ 120	
Methanol	- 98	64	10	_ 130	
Ethanol	- 112	78	0	- 130	
Heptane	- 90	. 98	0	- 150	
Water	0	100	30	- 200	
Toluene	- 95	110	50	_ 200	
Mercury	- 39	361	250	- 650	
Cesium	29	670	450	- 900	
Potassium	62	774	500	- 1000	
Sodium	98	892	600	- 1200	
Lithium	179	1340	1000	- 1800	

Table	1.1	Heat	pipe	working	fluids	from	Ref.	6	

the working fluid and extremely low vapor density.

1.3 Literature review

The heat pipe is a highly effective device for transporting heat between a source and a sink. Since Gaugler[1] received a patent on the heat pipe concept applied to a refrigeration system and Grover[2] referred to a "heat pipe" in a patent filed for the United States Atomic Energy Commission in 1963, scientists and engineers have been developing heat pipe technology. The first paper which described the basic principle of operation of a heat pipe was published by scientists at the Los Alamos National Laboratory[7] in 1964. They built two heat pipes with water and sodium as the working fluids for an initial qualitative experiment. Work at Los Alamos[8,9] continued actively, emphasizing space applications for the transfer of very high heat fluxes between two components and for the elimination of temperature gradients over relatively large areas. For high temperature applications, lithium and silver were tested as the working fluid at 1300°C and 2000°C, respectively. For the first actual flight test, a stainless steel heat pipe with distilled water as the working fluid operated successfully. At this stage, research on heat pipes was also conducted in England and Italy[6].

Cotter[10] developed the general basic theory for making certain quantitative calculations of heat pipe behavior. This analysis was confined to right circular cylinders of large length-to-diameter ratio and emphasized the vapor flow. Uniform injection or suction were assumed for a steady state condition. The axial transport of energy was modeled with the vapor flow carrying the latent heat of vaporization while neglecting axial conduction and radiation in the vapor space. After this pioneering effort, several books[6,11,12] were published which describe the basic theory of conventional heat pipe operation at steady state and low temperature.

Busse[13] studied the pressure drop in laminar vapor flow in a long, cylindrical heat pipe. The vapor density was assumed to be constant. The Navier-Stokes equations were simplified by a boundary layer approximation and solved by approximating the axial velocity component as a polynomial of the fourth power of the radius, with a correction function which varied only in the flow direction.

Levy[14,15] used a one-dimensional approach in solving the vapor flow problem, taking into account compressibility, shear stress at the liquid-vapor interface and the vapor dissociation-recombination reaction. The analytical results indicated that the shear stress is the most important factor, which reduces the maximum rate of heat transfer from that based on the sonic limit.

Brovalsky et al.[16] described the vapor flow for alkali-metals by using averaged equations of motion over the cross-section. Compressibility and friction at the liquid-vapor interface were considered. Momentum and energy factors, and the friction factor were evaluated based on theoretical data available for incompressible vapor flow in a channel with porous walls. The comparison of numerical results with available experimental data indicated a maximum discrepancy of 10 %. The temperature drop along the heat pipe was also observed.

Bankston and Smith[17] studied the fluid dynamics of the vapor flow at three different Reynolds numbers; 0.01, 4, and 1000. The Navier-Stokes equations for steady, incompressible, laminar vapor flow in a cylindrical heat pipe were solved by a finite difference method in which the dependent variables were transformed to the stream function and the vorticity. Inflow and outflow boundary conditions were described at the wall as blowing and suction through a porous wall pipe, but no thermodynamic change of phase was actually employed in the analysis. Their results show that vapor flow in the condenser is more complex than that in the evaporator, and that the vapor pressure varies not only in the axial, but also in the radial direction for large Reynolds numbers.

A numerical analysis of steady two dimensional heat and mass transfer in the vapor-gas region of a gas loaded heat pipe was made by Tien and Rohani[18]. In this study, the radial component of velocity at the wall was determined by writing an energy balance equation at the liquid-vapor interface. Numerical results show that considerable pressure variations in the axial direction exist for large heat fluxes, due to friction at the liquid-vapor interface. Thus, a temperature drop in the axial direction occurs and vapor pressure variations play a significant role in overall performance of the heat pipe.

Vapor flow dynamics in a flat plate heat pipe with asymmetric boundary conditions was studied by Ooijen and Hoogendoorn[19]. The numerical study was confined to two-dimensional, steady state, laminar and incompressible flow. From computational results, velocity profiles were plotted in the evaporator and condenser for wall Reynolds numbers of 2, 10, and 50, and were compared with parabolic Poiseuille profiles for three locations. Flow reversal was observed, and similarity did not exist for high wall Reynolds numbers in the condenser section. For small Reynolds numbers, the pressure drop is similar to the Poiseuille flow model. However, for high wall Reynolds number, the large difference in velocity profiles in the condenser section causes a higher pressure drop than that resulting from the Poiseuille model. Good agreement was observed between experimental and computational results for nitrogen gas.

Ismail and Murcia[20] studied combined liquid and vapor flow in a tube with a porous wick. Governing equations for the flow of viscous incompressible fluid were solved using the separation of variables with known evaporation or condensation rates. For the case of small Reynolds number, analytical results were obtained.

Demichele[21] investigated the two-dimensional, steady state and compressible

flow problem by using an integral transformation of the general compressible flow equation introducing stream tubes which can be thought of as a set of concentric nozzles. For each stream tube equations were derived with a different initial condition. Numerical solutions predicted velocity, pressure, and temperature profiles. Effects of viscous terms on pressure recovery were deemed to be important.

Compressible, transient and axisymmetric Navier-Stokes equations were numerically solved to derive a friction coefficient expression to be used in one-dimensional heat pipe vapor models by Bowman[22]. The equation for the friction coefficient was expressed in terms of local axial Reynolds number, Mach number, pipe aspect ratio and radial Reynolds number. The one-dimensional model with the friction coefficient showed good agreement with experimental results.

Overall thermal performance of a heat pipe at steady state was studied theoretically and experimentally, by Sun and Tien[23,24]. In the analysis, a simple conduction model was developed for a single-component heat pipe in one dimension with uniform saturated vapor temperature and uniform mass injection or suction. Axial wall temperature distributions were predicted. Theoretical predictions were compared with measured results for gas-loaded heat pipes and good agreement was reached.

As the digital computer was developed numerical techniques were used to solve more complicated models. The simple conduction model developed by Sun and Tien was extended by Kuramae[25] to transient heat pipes with time varying thermal loads. In this model, the temperature was assumed to vary only in the axial direction for the wall but in both the axial and radial directions for the wick structure. It was assumed that the vapor temperature was dependent on time but uniform in space. A numerical method was used to solve the governing equations and the calculated axial temperatures were compared with typical experimental results. Experimental and numerical studies were conducted for transient operating characteristics of low temperature heat pipes by Chang and Colwell[3,4,5]. The computational model assumed that two-dimensional conduction in the heat pipe shell and wick are the dominant heat transfer modes. A lumped mass model was used for a combination of vapor space and central composite slab wick. Thermal resistance at the liquid-vapor interface and along the vapor space was neglected. To provide boundary conditions at the interface between the heat pipe wall and the vapor space, the vapor region was modeled assuming that the vapor temperature was a function of time only. A finite-difference method was used to predict performance.

Cotter[26] described three basic transient modes for heat pipe startup. A frontal startup mode was observed when the vapor density is so low that the molecular mean free path exceeds the diameter of the vapor passage. In this mode of startup, the vapor in the hot zone is in continuum flow and that in the cold zone is in free molecule flow. A large temperature gradient is developed and decreases with time. Eventually, an isothermal steady state could be reached.

Ivanovskii et al.[11] carried out experimental studies of the temperature distribution along the length of a sodium heat pipe in which the working fluid was in the solid state at ambient temperature. The temperature distributions were measured with the aid of a movable microthermocouple placed directly in the vapor channel. Ivanovskii observed three simultaneous flow regimes in the condensation zone for intense heat removal in a pipe operating at the sonic heat transfer limit: continuum vapor flow at the start of the condensation zone and intermediate and free molecular regimes futher on.

Neal[27] investigated the successful startup of a heat pipe with water as the working fluid. The water in the condenser was initially frozen, but that in the evaporator remained in the liquid phase. Experimental results showed that a large temperature gradient developed along the heat pipe length with increasing time and even for a small heat flux the heat pipe failed to start up.

Shlosinger[28] studied the startup behavior of low temperature heat pipes with the water initially frozen. With a heat input of 15 watts, the heat pipe working fluid melted without wick dryout and normal operation began after approximately one hour. Use of an auxilliary heat pipe which had a working fluid with a lower melting point greatly improved the startup of the primary heat pipe without local overheating and the transient period was reduced.

Deverall et al. [29] made a series of tests to study the startup problem with water and metallic heat pipes. They described the transient behavior of heat pipe startup based on their experiments. With the working fluid in the solid state, startup was possible, but was highly dependent on the heat rejection rate at the condenser. For successful startup, the heat rejection rate at the condenser had to be low enough to enable the heat to melt the working fluid in the condenser, and allow liquid to return through the wick structure before the evaporator was depleted of fluid. Heat rejection by radiation is a self-compensating system and automatically controls the heat rejection rate. Therefore, startup difficulties were not normally encountered under these conditions. Another method suggested to aid the startup of a heat pipe was the addition of a small amount of inert noncondensable gas which has a result similar to that of radiation.

Camarda[30] investigated the performance of a heat pipe cooled leading edge, experimentally and analytically. In the analysis, it was assumed that the temperature was uniform throughout the continuum flow region and the melting process of the working fluid was neglected. Temperatures were calculated by a lumped system method which used a volumetric heat capacity per unit length of heat pipe. Rates of continuum vapor region growth, which were predicted using simple energy balances, were compared with experimental results.

Most experimental studies [27,28,29] attempted simply to see if it was possible to obtain successful startup from the frozen state. It has been noted that startup difficulties are normally encountered when the working fluid is initially in the solid phase. No analytical studies which include the effects of phase change of the working fluid and vapor flow dynamics have been reported, and further more, comprehensive and qualitative research on startup from the frozen state has not been carried out experimentally and numerically.

CHAPTER II

MODELING OF STARTUP

2.1 Introduction

The use of heat pipes is being considered as a means of reducing the peak temperature and large thermal gradients at leading edges of reentry vehicles and hypersonic aircraft, and in nuclear reactors[31,32]. In the basic cooling concept, the heat pipe, which is a highly effective heat transport device, covers the leading edge, a portion of the lower wing surfaces, and a portion of the upper wing surface. Aerodynamic heat is mainly absorbed at the leading edge, and transported through the heat pipe to the upper and lower wing surfaces, where it is rejected by thermal radiation and convection. Once fully operational, the near isothermal heat pipe virtually eliminates temperature gradients and reduces peak temperatures.

A previous feasibility study[31] of heat pipes for this application recommends a rectangular cross-section for the heat pipe based on weight per unit surface area of heat pipe cooling structure and fabrication considerations. A schematic diagram of the physical model based on results presented in reference[31] is shown in Figure 2.1.

Previous experimental observations [26-32] suggest the following sequence of events during heat pipe startup from the frozen sate. Initially, the working fluid is in the solid state and the vapor density is extremely low, so that free molecular flow conditions prevail throughout the vapor space. The input flux over the evaporator starts to melt the frozen substance in this region, while the heat transport from the hot zone to the adjacent zone proceeds quite slowly via axial conduction through working fluid and capillary structure, while heat transfer in the vapor is almost

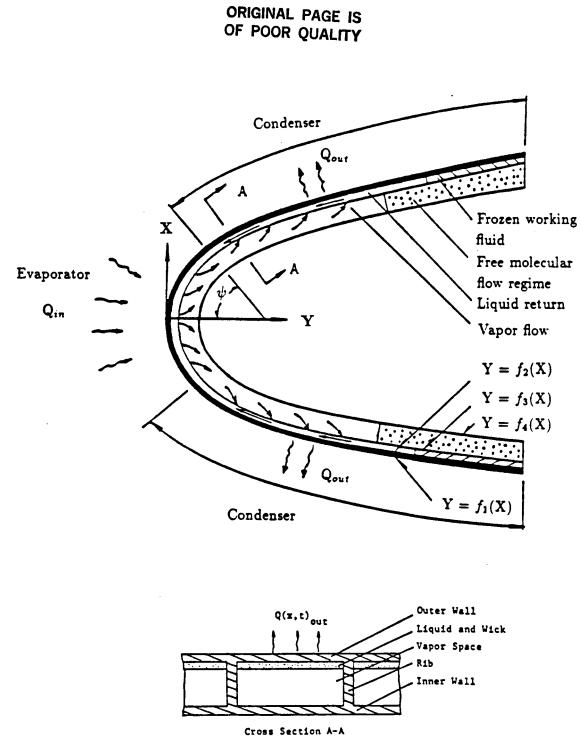


Figure 2.1. Schematic diagram of a heat pipe cooled leading edge.

negligible.

When energy is continuously added to the evaporator, the frozen working fluid in the evaporator is melted, so that evaporation can take place at the liquid-vapor interface and vapor flows into the condenser section due to the large pressure gradient. Vapor therefore freezes on the inner surface of the frozen working fluid in the cold zone and the vapor-solid interface temperature increases until the melting temperature is reached. During this stage, energy is mainly transferred as latent heat owing to vaporization in the heated zone, and condensation and freezing in the cooled zone. The vapor flow may be choked at the exit of the evaporator because of very low pressure in the cold zone.

This process continues until the frozen working fluid is completely melted and the continuum flow regime reaches the end of the heat pipe, at which time liquid returned to the evaporator is sufficient for normal transient operation. Eventually the heat pipe may reach a steady state condition. As suggested, during the startup of the heat pipe from a frozen state, the behavior of vapor flow may be divided into three distinct phases for convience of analysis.

- **Phase I:** Vapor flow in the heat pipe is in free molecular condition through the vapor space.
- Phase II: In the vapor space, a region of continuum flow is established in the heated zone and a continuum flow front moves toward the heat pipe cooled end. Vapor flow may be choked at the end of the evaporator.
- **Phase III:** Continuum flow exists over the entire heat pipe length in the vapor region and the sonic limit is not encountered.

2.2 Mathematical model development

On the basis of experimental observations, basic governing equations are written to determine the startup, transient, and steady state performance of a heat pipe which has initially frozen alkali-metal as the working fluid. These equations can be coupled by several types of boundary conditions on the heat pipe surface, such as specified temperature, heat flux, convection and radiation boundary conditions. The boundary condition at the liquid-vapor interface depends on the three phases of vapor flow dynamics mentioned in section 2.1.

2.2.1 Transition temperature

Continuum flow in the vapor space is considered to be established when the mean free path, λ , is substantially less than the minimum dimension,D, of the vapor flow passage, e.g.,

$$K_n \equiv \frac{\lambda}{D} \le 0.01 \tag{2.1}$$

From kinetic theory of gases[33], the dynamic viscosity and the mean molecular velocity can be expressed as

$$\mu = 0.5\rho\lambda V \tag{2.2}$$

$$V = \sqrt{\frac{8R_u T}{\pi M}} \tag{2.3}$$

Eliminating the mean free path from Equations(2.1) and (2.2) yields the temperature of the vapor space corresponding to the given mean free path,

$$T^* \ge \frac{\pi}{2 \times 10^{-4}} \frac{M}{R_u} \left(\frac{\mu}{\rho D}\right)^2 \tag{2.4}$$

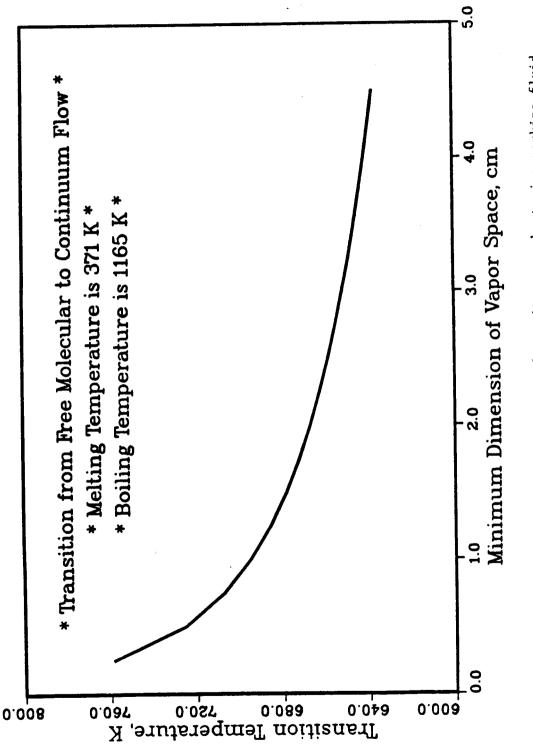
where ρ is the density of the vapor, μ is the dynamic viscosity of the vapor, R_u is the universal gas constant, and M is the molecule weight.

Iterations are required to obtain a value of T^* due to the temperature dependence of properties. Figure 2.2 illustrates the transition temperature, T^* , from free molecular to continuum flow as a function of minimum vapor passage for sodium. When the temperature of the vapor space is greater than that calculated by Equation(2.4), continuum flow is assumed to be established in the vapor space.

2.2.2 Heat pipe shell and capillary structure with working fluid

Unlike the case of a conventional cylindrical heat pipe, aerodynamic heating for the heat pipe shown in Figure 2.1 will cause the highest temperature to occur at the outer shell of the heat pipe. Thus, to simplify the analysis, it is assumed that the inner shell is sufficiently thin to neglect its thermal resistance and capacitance. Furthermore, the following additional assumptions are made. The thicknesses of the heat pipe and the rib are assumed to be much smaller than the width and therefore temperature gradients would be developed primarily in the chordwise direction during heat pipe is assumed to be symmetric about the stagnation line so that the upper half section of the heat pipe only is considered. Hence, a twodimensional model is considered for mathematical formulation. A simplified cross section is shown in Figure 2.3.

The unsteady, two-dimensional conduction equation is applied to the heat pipe shell and the capillary structure to evaluate the temperature distributions under





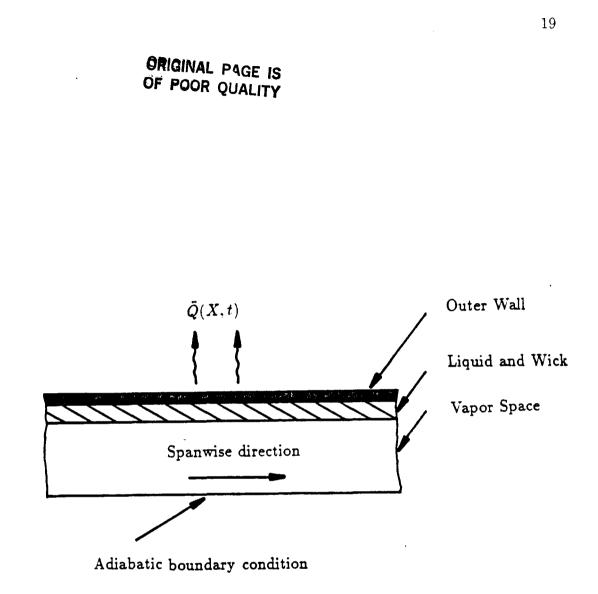


Figure 2.3. Simplified cross-section A-A of Figure 2.1.

the following assumptions:

- The heat transferred through the wick and working fluid is by conduction only since liquid flow velocity is very low, liquid layer is thin and thermal conductivity is very high;
- The presence of the wick structure does not affect the melting of the working substance, and melting occurs over a small, finite temperature range, △T, around the melting temperature;
- 3. Boundary conditions at the liquid-vapor interface are subject to the phases of vapor flow dynamics noted in section 2.1.
- 4. Radiation heat transfer at the liquid-vapor interface is neglected based on the small thermal emissivity of liquid sodium[34].

The governing equations and boundary conditions for the heat pipe shell and capillary structure with working fluid are expressed in one form:

$$C_{i}\frac{\partial T_{i}}{\partial t} = \frac{\partial}{\partial X}\left(K_{i}\frac{\partial T_{i}}{\partial X}\right) + \frac{\partial}{\partial Y}\left(K_{i}\frac{\partial T_{i}}{\partial Y}\right) , \quad i = 1,2$$
(2.5)

$$T_i = T_o \qquad \text{for } t < 0 \tag{2.6}$$

$$K_1 \frac{\partial T_1}{\partial n} = \ddot{Q}(X, t) \quad \text{at} \quad Y = f_1(X) \quad \text{for} \quad 0 \le \psi \le \psi_e \tag{2.7}$$

$$-K_1 \frac{\partial T_1}{\partial n} = h_{cr}(T_1 - T_{cr}) + \sigma \varepsilon (T_1^4 - T_r^4) \quad \text{at} \quad Y = f_1(X) \quad \text{for} \quad \psi_e \le \psi \le \psi_c$$
(2.8)

$$T_1 = T_2$$
 and $K_1 \frac{\partial T_1}{\partial n} = K_2 \frac{\partial T_2}{\partial n}$ at $Y = f_2(X)$ for $0 \le \psi \le \psi_c$ (2.9)

$$\frac{\partial T_i}{\partial S} = 0$$
, $i = 1, 2$ at $\psi = 0$ and $\psi = \psi_c$ (2.10)

where the subscripts 1 and 2 denote the heat pipe shell and the capillary structure, n represents the unit outward normal direction, and S_d represents the chordwise direction.

In X - Y coordinates

$$K\frac{\partial T}{\partial n} = K\frac{\partial T}{\partial X}l_{x} + K\frac{\partial T}{\partial Y}l_{y}$$
(2.11)

where l_x and l_y are the direction cosines between the surface outward normal, n, and the X and Y axes, respectively.

2.2.3 Analysis of the vapor flow

Analysis of the vapor flow is necessary to provide the boundary condition at the liquid-vapor interface when continuum flow is established in part of the vapor space. However, the behavior of the vapor flow as mentioned in section 2.1 is very complicated due to the extremely small vapor density of the metallic working fluid at low vapor pressure, and the large pressure gradient in the chordwise direction. Limits on vapor flow are encountered, and considerable thermal resistance exists at the liquid-vapor interface due to phase change of the working fluid. The case of a flat plate heat pipe with asymmetrical boundary conditions shown in Figure 2.3 is considered for the vapor flow passage.

2.2.3.1 Evaporation and condensation

From kinetic theory, a significant thermal resistance exists at the liquid-vapor interface for liquid metal[35] and this resistance increases with decreasing vapor pressure. This means that the difference between the vapor temperature and the interface temperature is not negligible. At the interface, interphase mass transfer has been stated from the viewpoint of kinetic theory as a net molecular flux which is the difference between the rate of arrival of molecules from the vapor space towards the interface and vice-versa. While condensation is proceeding, the arrival rate of molecules exceeds the departure rate. During evaporation, the reverse is true, and during the equilibrium state, the net molecular flux is zero. Hence, evaporation and condensation are modeled by using an expression for the net rate derived from the kinetic theory of gases[36]:

$$\dot{m}_{\circ} = \left(\frac{2a\epsilon}{2-a}\right) \sqrt{\frac{M}{2\pi R_u}} \left[\frac{P_f}{\sqrt{T_f}} - \frac{P_g}{\sqrt{T_g}}\right]$$
(2.12)

where a is the condensation or evaporation coefficient which is assumed to be unity, ϵ is the porosity of the wick, \dot{m}_{o} is the rate of condensation or evaporation per unit area, M is the molecular weight, R_{u} is the universal gas constant, P_{f} and T_{f} are the pressure and temperature, respectively, at the interface, and P_{g} and T_{g} are the pressure and temperature of the vapor, respectively.

2.2.3.2 Limitations of vapor flow

After continuum flow is established in the vapor space, because of the low density of vapor at low pressure and the large pressure gradient, the vapor flow is choked at the end of the evaporator, even for a low heat flux, just as it is at the throat of a convergent nozzle for large pressure gradient. This sonic limit is the first among several limitations encountered, and the performance of the heat pipe is restricted until the vapor temperature increases accordingly until the velocity of the vapor leaving the evaporator is less than the sonic velocity.

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The expression for the sonic limit[15,29] in terms of flow conditions at the beginning of the evaporator, from an energy balance on a control volume enclosing the entire evaporator, is:

$$Q_s = \frac{\rho_{\circ} A_c h_{fg} \sqrt{\gamma R_u T_{\circ}}}{\sqrt{2(\gamma+1)M}}$$
(2.13)

where A_c is the cross-section area of the vapor space, h_{fg} is the enthalpy of vaporization, γ is the ratio of specific heats, M is the weight of a molecule, R_u is the universal gas constant, T_o is the vapor temperature at the beginning of the evaporator and ρ_o is taken as the saturation density corresponding to T_o . Experimental verification of Equation(2.13) has been made by Kemme[37] for sodium, potassium and cesium heat pipes.

Figure 2.4 shows the sonic limit, the entrainment $\limit[12]$ and the axial Reynolds number for a heat pipe which has a cross-sectional area of 0.55 cm², hydraulic radius of 0.32 cm, 100 mesh screen wick, and sodium as the working fluid. The type of limitation restricting performance of a heat pipe is determined by which limitation has the lowest value at the temperature under consideration. Thus, the first limit encountered is the sonic limit, as shown in Figure 2.4. However, when the actual chordwise heat transfer required is below these limits, no limits are encountered.

2.2.3.3 Modeling of vapor flow during phase II

Even though some of the working substance is in the liquid state, the transition temperature from free molecular flow to continuum flow is much greater than the melting temperature, so that the vapor flow is assumed to be free molecular during phase I, and an adiabatic boundary condition is applicable at the interface. However, during phase II, a region of continuum flow is assumed to be established in the ORIGINAL PAGE IS OF POOR QUALITY

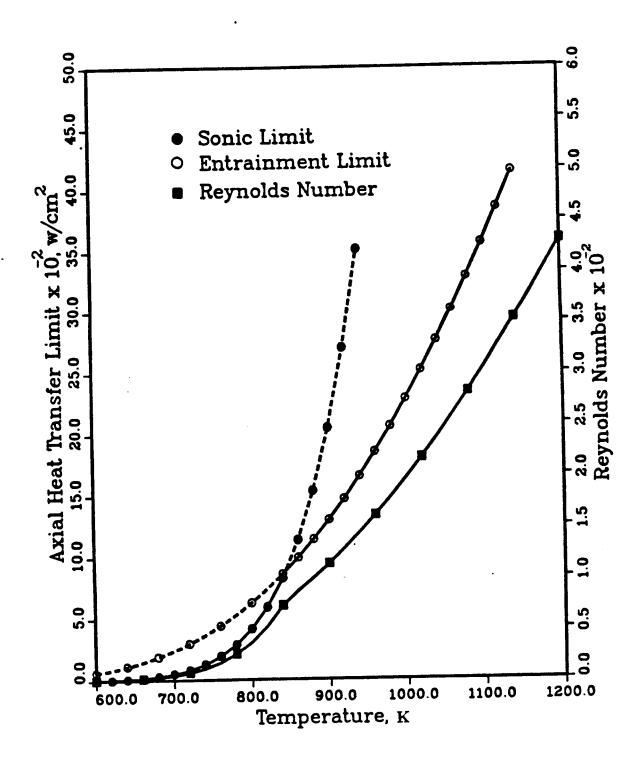


Figure 2.4. Heat pipe vapor flow limits and corresponding Reynolds numbers.

adjacent vapor space when the interface temperature is greater than the transition temperature, while in the cold zone the vapor is still in free molecular flow. The continuum flow region grows until it reaches the end of the heat pipe. The temperature in the region of free molecular flow remains unchanged except in the vicinity of the continuum flow region. Therefore, an imaginary plane, which is adiabatic and normal to the liquid-vapor interface, is assumed to divide the two vapor flow regions at the point of the transition temperature, and the dividing plane moves toward the cooled end of the heat pipe as the location of the transition temperature at the interface moves.

In the continuum flow region, energy is mainly transported as latent heat of the working fluid, and variations of temperature and pressure in the chordwise direction are significant. Even though continuum flow exists in the vapor space, the vapor pressure is low and the pressure gradient in the chordwise direction is large, so the heat transfer is limited by the choked flow condition, and supersonic vapor flow and a shock front [6,11,23,29] may occur in the condenser.

In this research, the overall performance of a heat pipe is of more interest than details of one portion, and as noted, the ultimate heat transfer rate in the axial direction is limited by the sonic limit. Thus, the vapor flow during phase II may be approximated, without losing generality and accuracy, by evaluating the sonic limit properly. In order to evaluate the sonic limit, the total heat input to the vapor space, which can be obtained by applying Equation(2.12) to the element adjacent to the continuum flow region, is equated to the sonic limited transport from Equation(2.13) as follows:

$$\sum_{i=1}^{m_e} 2\epsilon \sqrt{\frac{M}{2\pi R_u}} \left[\frac{P_{f_i}}{\sqrt{T_{f_i}}} - \frac{P_g}{\sqrt{T_g}} \right] \triangle L_i W = \frac{\rho A_e \sqrt{\gamma R_u T_g}}{\sqrt{2(\gamma+1)M}}$$
(2.14)

where A_c is the cross-section area, $\triangle L_i$ is the length of the element, m_e is the number of elements at the interface in the evaporator, and W is the width of the vapor space. From Equation(2.14), the uniform vapor temperature can be computed by iteration. This vapor temperature may be lower than true vapor temperature at the beginning of the evaporator, but at this stage the variation of density with temperature and the density itself is very small, so that the variation of sonic limit with respect to temperature is also small, as shown in Figure 2.4. Thus, the heat flux at the liquid-vapor interface and the sonic limit can be obtained by solving Equations(2.12) and (2.13), respectively, with the vapor temperature obtained from Equation(2.14). This method may be used until the vapor flow state reaches phase III.

2.2.3.4 Vapor flow during phase III

In this stage, the entire working fluid is completely melted and continuum flow exists throughout the vapor space. However, the heat pipe has not reached the desired operating condition and the density of the vapor is still small, so that compressibility should be considered. The amount of energy stored in the vapor space is negligible. The Reynolds number in Figure 2.4 is the maximum value corresponding to a given temperature and the diameter of the vapor space. When the actual heat transfer required is below these limits, no limits are encountered. A model[30] test, in which a thermal history for space shuttle reentry heating was simulated, showed that the typical maximum heat pipe operating temperature is about 940 K. At this temperature, the maximum Reynolds number is 1200. A study of the effect of mass injection and suction, and/or chordwise pressure gradients on flow transition from laminar to turbulent flow in the vapor space of a heat pipe, was conducted by Bowman[22]. His results showed that mass injection and pressure

drops in the evaporator correspond to those for laminar flow for axial Reynolds number up to 10⁶. For the condenser, transition of flow is observed at a Reynolds number of 12,000. Even though the Reynolds number depends on the geometry of the heat pipe and the actual heat transfer rate, the results cited from the previous study show that the vapor flow may be assumed laminar. Also, it was observed that the vapor reaches the steady state quickly, while the thermal response of the heat pipe wall and wick progresses slowly. It was recommended that a steady state model can be employed for the vapor flow.

Thus, quasi-steady, compressible, one-dimensional laminar flow in the vapor space is considered. For purposes of formulating the mass, momentum, and energy equations in one-dimensional form, the velocity is taken to be the average velocity, which is approximated by the velocity distributions based on the similarity solutions of semiporous channels. In addition, friction at the liquid-vapor interface, variations of vapor quality, and momentum and energy factors are similarly calculated. The vapor is evaporated at the interface with mass injection rate per unit area, \dot{m}_o . It is assumed that this vapor flows inward with a normal component of velocity only, and joins the chordwise vapor flow.

Mass, momentum and energy balances in the chordwise direction, with the assumptions noted, yield:

$$D\frac{d}{dS}(\rho V) = \dot{m}_{\circ} \tag{2.15}$$

$$\frac{dP}{dS} + \frac{d}{dS}(M_f \rho V^2) = -\frac{F \rho V^2}{8D}$$
(2.16)

$$D\frac{d}{dS}\left[\rho V(h + \frac{E_f V^2}{2})\right] = \dot{m}_{\circ}(h_{\circ} + \frac{V_{\circ}^2}{2})$$
 (2.17)

where D is the height of the vapor space, h is the vapor enthalpy and h_{\circ} is the vapor enthalpy at the interface.

A friction factor F for the surface is written as

$$F = \frac{8\tau_g}{\rho V^2} \tag{2.18}$$

Momentum and energy factors, M_f and E_f , respectively, are expressed as

$$M_f = \frac{1}{DV^2} \int_{0}^{D} U^2 dy$$
 (2.19)

$$E_f = \frac{1}{DV^3} \int_0^D U^3 dy$$
 (2.20)

Normal velocity of the vapor at the interface is expressed in terms of the heat transfer rate and latent heat of vaporization as follows:

$$V_0 = \frac{\dot{Q}}{h_{fg}\rho_\circ A_\circ} \tag{2.21}$$

where \dot{Q} is the heat input rate at the interface, ρ_{\circ} is the density for the interface temperature and A_{\circ} is the interface area.

CHAPTER III

NUMERICAL MODEL DEVELOPMENT FOR PHASE CHANGE

3.1 Introduction

Transient and nonlinear heat transfer problems having phase change have been encountered in many engineering fields, and pose inherent difficulties for analytical and numerical solutions, because the interface between the new and old phase is moving with time, and properties such as conductivity, specific heat, and density are discontinuous at the phase change region.

The fundamental feature of these phase change problems was given attention and was solved analytically by Lame and Clapeyron in 1831, Stefan in 1891, and Newmann in 1912. Since then, many scientists have introduced analytical methods of solution of phase change problems to a number of idealized problems involving semi-infinite or infinite regions, subject to simple boundary and initial conditions. A brief discussion of these methods is presented by Ozisik[38]. A large number of numerical solutions of phase change problems were made possible by the availability of high speed digital computers. The finite element method has been used for nonstructural problems since the procedure was first proposed by Zienkiewicz and Cheung[39]. The solution process is now well established for linear situations, but relatively little work has been reported for nonlinear problems.

The Galerkin weighted residual method is used here to derive finite element formulations. Since the governing differential equations are highly nonlinear due to the temperature dependence of the thermophysical properties, a three time level difference scheme which was proposed by Dupont et al.[40] is utilized to allow a direct evaluation of the properties at an intermediate time level, thereby eliminating iterations within each time step. However, this scheme is not self-starting, so the implicit method with Newton-Raphson iteration is used for the first few time steps.

3.2 Mathematical model

For the system, having an arbitrary control volume \bar{V} and control surface area A, the general principle of conservation of energy implies that whatever energy enters the system must either leave the system across the boundary or cause a change in the energy within the system. With no work, mass transfer, nor energy generation sources, the net rate of change of the total energy within the system must equal to the net rate of energy entering the system due to heat transfer across the control surface area. This statement can be expressed in mathematical form as follows:

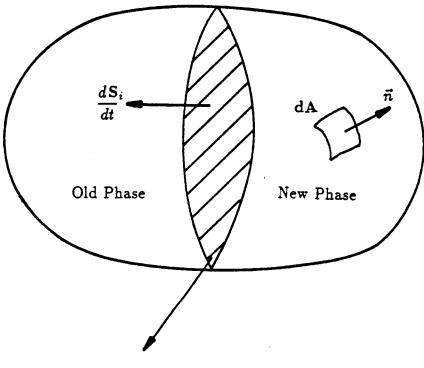
$$\frac{\partial}{\partial t} \int_{\bar{V}} \rho h d\bar{V} = \int_{A} K \nabla T \bullet \vec{n} dA \tag{3.1}$$

where ρ is the density, h is the specific enthalpy, K is the thermal conductivity, ∇T is the gradient of temperature and \vec{n} is the unit outward normal to the surface as shown in Figure 3.1.

For a single phase region, the fixed control volume is independent of time, and the divergence theorem is used to convert the surface integral to a volume integral. Therefore, Equation(3.1) can be written

$$\int_{\bar{V}} \frac{\partial}{\partial t} (\rho h) d\bar{V} = \int_{\bar{V}} \nabla \bullet (K \nabla T) d\bar{V}$$
(3.2)

The volume may be chosen so small as to remove the integral, and the specific enthalpy can be replaced by the expression for the specific heat and temperature. Equation(3.2) is then reduced for an arbitrary small volume \bar{V} as follows:



Solid-liquid Interface

Figure 3.1. Control volume \bar{V} .

$$\rho c_p \frac{\partial T}{\partial t} = \nabla \bullet (K \nabla T) \tag{3.3}$$

This equation can be applied to the solid and liquid regions when the motion of the liquid due to the change of the density is neglected. However, the properties of the material are discontinuous at the interface as shown in Figure 3.2, so that a single equation cannot describe the phase change phenomenon. Hence, a problem with the phase change of a substance is mathematically described as follows:

$$C_{21}\frac{\partial T_{21}}{\partial t} = \nabla \bullet (K_{21}\nabla T_{21}) \quad \text{for old phase}$$
(3.4)

$$C_{22}\frac{\partial T_{22}}{\partial t} = \nabla \bullet (K_{22}\nabla T_{22}) \quad \text{for new phase}$$
(3.5)

with initial condition

$$T_{21} = T_{\circ} \tag{3.6}$$

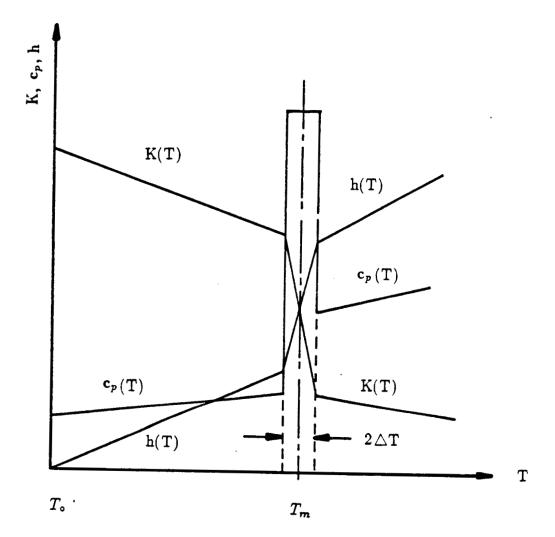
Boundary conditions are, for i = 1,2,

$$T_{2i} = T_s, \qquad \text{on } A_1 \tag{3.7}$$

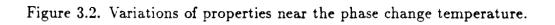
$$-K_{2i}\nabla T_{2i} = \tilde{Q} \qquad \text{on } A_2 \tag{3.8}$$

$$-K_{2i}\nabla T_{2i} = h_{cr}(T_{2i} - T_{cr}) \quad \text{on } A_3$$
(3.9)

$$-K_{2i}\nabla T_{2i} = \beta_r (T_{2i} - T_r) \quad \text{on } A_4 \tag{3.10}$$



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where $\beta_r = \sigma \varepsilon (T_{2i}^2 + T_r^2)(T_{2i} + T_r)$ and coupling conditions at the interface are

$$T_{21} = T_{22} = T_m \tag{3.11}$$

$$K_{21}\frac{\partial T_{21}}{\partial n} - K_{22}\frac{\partial T_{22}}{\partial n} = H_{ls}\frac{dS_i}{dt}$$
(3.12)

where h_{cr} is the heat transfer coefficient, H_{ls} is the latent heat of a phase change, S is the interface position, T_m is the temperature of the phase change, ε is the emissivity, and σ is the Stefan-Boltzmann constant.

3.3 Description of numerical formulations

3.3.1 Finite element formulation

The Galerkin weighted residual method is used to derive finite element formulations. Within each element, the unknown function T may be approximated at any time t by the relationship

$$T(x, y, t) = \sum_{i=1}^{k} N_i(x, y) \bullet T_i(t)$$
(3.13)

where k is the number of nodes assigned to the element, T_i are the discrete nodal values of T, and N_i are the shape functions.

To derive the element equations for differential Equation(3.3) and their boundary conditions, the solution domain R in two dimensions, as shown in Figure 3.3, is divided into m linear triangular elements of k nodes each. Application of the Galerkin method to Equation(3.3) yields

$$\int_{R^{(\epsilon)}} N_i \left[\frac{\partial}{\partial X} \left(K \frac{\partial T^{(\epsilon)}}{\partial X} \right) + \frac{\partial}{\partial Y} \left(K \frac{\partial T^{(\epsilon)}}{\partial Y} \right) - C \frac{\partial T^{(\epsilon)}}{\partial t} \right] dX \, dY = 0 \tag{3.14}$$

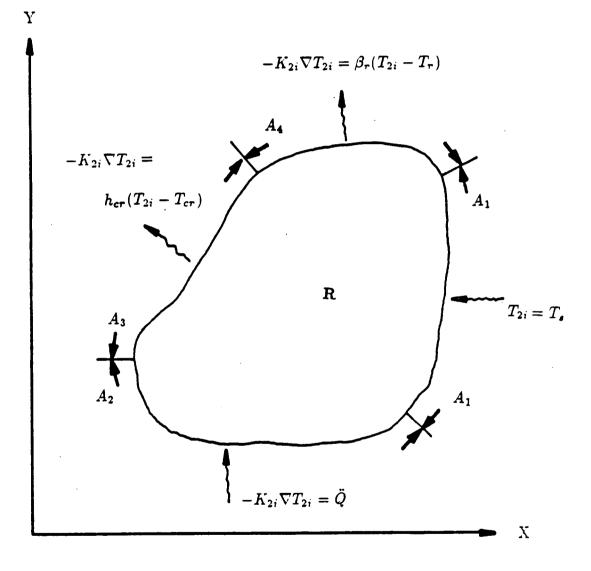


Figure 3.3. Two-dimensional solution domain.

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where N_i are the shape functions which are conveniently chosen as weighting functions in the Galerkin method.

To reduce the order of the derivatives in the equation above and to introduce the influence of the boundary conditions, the second order derivatives are integrated by parts

$$\begin{split} \int_{R^{(\epsilon)}} N_{i} \bigg[\frac{\partial}{\partial X} \bigg(K \frac{\partial T^{(e)}}{\partial X} \bigg) + \frac{\partial}{\partial Y} \bigg(K \frac{\partial T^{(e)}}{\partial Y} \bigg) \bigg] dX dY = \\ - \int_{R^{(\epsilon)}} \bigg[\frac{\partial N_{i}}{\partial X} \bigg(K \frac{\partial T^{(e)}}{\partial X} \bigg) + \frac{\partial N_{i}}{\partial Y} \bigg(K \frac{\partial T^{(e)}}{\partial Y} \bigg) \bigg] dX dY \\ + \int_{A^{(\epsilon)}} N_{i} \bigg[\bigg(K \frac{\partial T^{(e)}}{\partial X} \vec{i} + K \frac{\partial T^{(e)}}{\partial Y} \vec{j} \bigg) \bullet \vec{n} \bigg] dS \end{split}$$
(3.15)

where \vec{i} is the unit vector in the X direction, \vec{j} is the unit vector in the Y direction, and \vec{n} is the outward unit vector normal to the surface, which coincides with the boundary to the solution domain. For the surfaces(or sides) of the elements contained within the solution domain, the surface integrals cancel out by continuity of heat flux when the element equations are assembled into the global system of equations. Only those surfaces of elements which coincide with the boundary to the solution domain, and do not have a specified temperature at the boundary, contribute to the surface integral.

The surface integral can be expressed as the sum of integrals over the external surfaces A as follows:

$$\int_{A^{(\epsilon)}} N_i \left[\left(K \frac{\partial T^{(\epsilon)}}{\partial X} \vec{i} + K \frac{\partial T^{(\epsilon)}}{\partial Y} \vec{j} \right) \bullet \vec{n} \right] dS = \int_{A_2} \ddot{Q} N_i dS - \int_{A_3} h_{cr} (T^{(\epsilon)} - T_{cr}) N_i dS - \int_{A_4} \beta_r (T^{(\epsilon)} - T_r) N_i dS$$
(3.16)

Substitution of Equations(3.15) and (3.16) into Equation(3.14) results in the following expression

$$\int_{R^{(\epsilon)}} \left[\frac{\partial N_i}{\partial X} \left(K \frac{\partial T^{(\epsilon)}}{\partial X} \right) + \frac{\partial N_i}{\partial Y} \left(K \frac{\partial T^{(\epsilon)}}{\partial Y} \right) + N_i C \frac{\partial T^{(\epsilon)}}{\partial t} \right] dX dY = \int_{A_2} \ddot{Q} N_i dS - \int_{A_3} h_{cr} (T^{(\epsilon)} - T_{cr}) N_i dS - \int_{A_4} \beta_r (T^{(\epsilon)} - T_r) N_i dS$$
(3.17)

After substituting the expression for unknown function $T^{(e)}$ into Equation (3.17), the resulting element equation is expressed as

$$\int_{R(e)} K \left(\frac{\partial N_i}{\partial X} \frac{\partial N_j}{\partial X} + \frac{\partial N_i}{\partial Y} \frac{\partial N_j}{\partial Y} \right) T_j dX dY + \int_{R(e)} \left(CN_i N_j \dot{T}_j \right) dX dY + \int_{A_4} h_{cr} N_i N_j T_j dS + \int_{A_4} \beta_r N_i N_j T_j dS = \int_{A_2} \ddot{Q} N_i dS + \int_{A_5} h_{cr} N_i T_{cr} dS + \int_{A_4} \beta_r N_i T_r dS$$

$$(3.18)$$

Finally, the assembly of the nonlinear transient element equations can be expressed in matrix form as follows:

$$[C]\{\dot{T}\} + \left[[K_c] + [K_h] + [K_r]\right]\{T\} = \{F_q\} + \{F_h\} + \{F_r\}$$
(3.19)

where

$$[C] = \int_{R^{(\epsilon)}} CN_i N_j dX dY \tag{3.19.1}$$

$$[K_c] = \int_{R^{(\epsilon)}} K\left(\frac{\partial N_i}{\partial X}\frac{\partial N_j}{\partial X} + \frac{\partial N_i}{\partial Y}\frac{\partial N_j}{\partial Y}\right) dX dY$$
(3.19.2)

$$[K_h] = \int_{A_s} h_{cr} N_i N_j dS \tag{3.19.3}$$

$$[K_r] = \int_{A_4} \beta_r N_i N_j dS \tag{3.19.4}$$

$$[F_q] = \int_{A_2} \ddot{Q} N_i dS \tag{3.19.5}$$

$$[F_h] = \int_{A_s} h_{cr} N_i T_{cr} dS \tag{3.19.6}$$

$$[F_r] = \int_{A_4} \beta_r N_i T_r dS \tag{3.19.7}$$

3.3.2 Time stepping scheme

The finite element method is now firmly established to investigate transient field problems governed by parabolic equations. However, the time derivative has usually been approximated by the finite difference method. Thus, a finite element discretization in space is coupled with finite difference approximation in time.

3.3.2.1 Implicit method

Let t^r denote a typical time in the response so that $t^{r+1} = t^r + \Delta t$ where Δt is the time increment, and an intermediate time t_{θ} within each time step may be expressed as

$$t_{\theta} = t^{r} + \theta \Delta t, \qquad 0 \le \theta \le 1 \tag{3.20}$$

Then, Equation(3.19) at t_{θ} is given as

$$[C]\{\dot{T}\}_{\theta} + [K]\{T\}_{\theta} = \{F\}$$
(3.21)

A first-order Taylor expansion in time is used,

$$\{T\}^r = \{T\}_{\theta} - \frac{d}{dt}\{T\}_{\theta}(\theta \Delta t)$$
(3.22)

and the following approximation for $\{\dot{T}\}$ is introduced.

$$\frac{d}{dt}\{T\}_{\theta} = \left(\{T\}^{r+1} - \{T\}^r\right) / \Delta t \tag{3.23}$$

Substitution of Equation(3.23) into Equation(3.22) yields

$$\{T\}_{\theta} = (1-\theta)\{T\}^{r} + \theta\{T\}^{r+1}$$
(3.24)

Finally, substitution of the expressions for $\{T\}_{\theta}$ and $\{T\}_{\theta}$ into Equation(3.21) gives

$$\left(\frac{[C]}{\Delta t} + \theta[K]\right) \{T\}^{r+1} = \left(\frac{[C]}{\Delta t} - (1-\theta)[K]\right) \{T\}^r + \{F\}$$
(3.25)

Since the values of [C], [K], and $\{F\}$ depend on $\{T\}_{\theta}$, a choice from among the values $\theta = 0$, 1/2, 2/3, and 1, respectively, yields Euler forward-difference, Crank-Nicolson center-difference, Galerkin, and fully implicit backward-difference formulations. The fully implicit backward-difference scheme is unconditionally stable and predicts a smooth decay.

3.3.2.2 Explicit methods

The implicit method is much more stable than the explicit method, but requires an iteration within each time step. To avoid iteration, a three level scheme proposed by Lees[41] was used by Comini et al.[42-46] and Morgan et al.[47]. Oscillations have been observed in certain instances, so a slightly modified form was used to improve stability.

Another three level scheme is referred to as the Dupont three level scheme. Hogge[48] demonstrated its overall performance to be superior in accuracy and stability to other time stepping schemes in solving the one-dimensional homogeneous equation.

Thomas et al.[49] compared several time integration schemes such as the Lees scheme, the Dupont scheme, and the Crank-Nicolson method. He concluded that the Dupont three level scheme was clearly superior to that of Lees in both accuracy and stability, and temperature-dependent terms should be evaluated using $\{T\}^{r+1}$ instead of $\{T\}^{r+\frac{3}{2}}$. With the use of Dupont method, Equation(3.21) can be approximated as follows:

$$\left(\frac{3}{4}[K] + \frac{[C]}{\Delta t}\right) \{T\}^{r+2} = \frac{[C]}{\Delta t} \{T\}^{r+1} + \frac{[K]}{4} \{T\}^r + \{F\}$$
(3.26)

The Equation (3.26) allows the explicit evaluation of $\{T\}^{r+2}$ without iteration, provided that $\{T\}^{r+1}$ and $\{T\}^r$ are known. However, this scheme is not self-starting, so that $\{T\}^{r+1}$ at the first time step may be calculated by using the implicit method.

3.3.2.3 Latent heat evaluation schemes

The principal difficulties in the analysis of the phase change problem are that the variation of the heat capacity is very severe at the interface, as shown in Figure 3.2. The position of the moving interface is not known a priori and the shape may be multi-dimensional. Thus, physically realistic approximation techniques must be used to overcome these difficulties. It is convenient to divide them into two groups, based on the choice of grids.

In the first group, the moving mesh technique continuously tracks the location of the interface by deforming the grid system to maintain the finest mesh in the vicinity of the critical phase change region. This technique may be limited to very simple geometries. In the second group, a fixed grid technique can avoid tracking down the position of the moving interface, but the interface is generally at an unknown location between nodes. Many different types of methods are available with the fixed grid system. The first method uses the enthalpy as a dependent variable along with the temperature, and may be referred to as the enthalpy method[50]. Since two dependent variables are used, the system of algebaric equations are solved by iteration.

The second method treats the latent heat effect accompanying a change of phase in terms of a temperature-dependent specific heat, or with the use of an enthalpy function. These methods avoid the moving interface difficulty so that instead of continuously tracking down the position of the moving interface, the same numerical scheme for conduction heat transfer without phase change is equally applicable to the phase change region. Then, the position of the interface can be easily determined by linear interpolation of nodal temperatures.

When temperature approaches the phase change temperature, the heat capacity tends to the Dirac delta function, and cannot be satisfactorily represented across the peak by any smooth function. Frivik and Comini[42] proposed a technique based on the integral of the heat capacity with respect to temperature

$$H = \int_{T_{\infty}}^{T} C dT \tag{3.27}$$

This is a smooth function of temperature in the phase change zone. Therefore, the enthalpy rather than the heat capacity is interpolated in a element as follows:

$$H = \sum_{i=1}^{k} N_i(x, y) H_i(t)$$
 (3.28)

where H_i are the enthalpy values at nodal points.

From definition, the heat capacity can be expressed as

$$C = \frac{dH}{dT} \tag{3.29}$$

Thus, the values of the heat capacity can be approximated by evaluating the gradient of enthalpy with respect to temperature. Defining the direction n to be normal to the interface line, Equation(3.29) is expressed as

$$C = \left(\frac{\partial H}{\partial n} / \frac{\partial T}{\partial n}\right)$$

= $\left(\frac{\partial H}{\partial X} l_{nx} + \frac{\partial H}{\partial Y} l_{ny}\right) / \left(\frac{\partial T}{\partial n}\right)$ (3.30)

where

$$l_{nx} = \frac{\partial T}{\partial X} / \frac{\partial T}{\partial n}$$

$$l_{ny} = \frac{\partial T}{\partial Y} / \frac{\partial T}{\partial n}$$

$$\frac{\partial T}{\partial n} = \left[\left(\frac{\partial T}{\partial X} \right)^2 + \left(\frac{\partial T}{\partial Y} \right)^2 \right]^{\frac{1}{2}}$$

Hence, for the entire element, the final expression of the heat capacity proposed by Del-Giudice et al.[51] is given as

$$C = \left[\frac{\partial H}{\partial X}\frac{\partial T}{\partial X} + \frac{\partial H}{\partial Y}\frac{\partial T}{\partial Y}\right] / \left[\left(\frac{\partial T}{\partial X}\right)^2 + \left(\frac{\partial T}{\partial Y}\right)^2\right]$$
(3.31)

CHAPTER IV

VAPOR FLOW DYNAMICS IN HEAT PIPES

4.1 Introduction

Analysis of the hydrodynamics of vapor flow in heat pipes with metallic working fluids indicates considerable difficulties at low vapor pressure, due to the extremely small vapor densities. Even for relatively small heat transfer rates, vapor velocity in the chordwise direction can be very large, accelerated towards sonic velocity because viscous action causes pressure and density to decrease. Additional heat input causes choking at the condenser inlet. Such behavior makes it necessary to include vapor compressibility and viscous action in mathematical models. The vapor pressure drop due to friction cannot be recovered completely in the condenser section. Thus, the temperature distributions along the length of the heat pipe are not isothermal, and thermal resistance in the vapor region is significant. Studies of the distributions of temperature, pressure, and velocity in the vapor passage along the length of a heat pipe are essential for an evaluation of the maximum heat transfer rates and prediction of correct heat pipe performance.

Reviews of the literature on hydrodynamic processes in vapor flow of cylindrical heat pipes made by Tien[52] and Ivanovskii et al.[11] indicate that no completely detailed investigation has been presented thus far. Moreover, experimental measurements of pressure and velocity for metallic working fluids have not been reported.

An analysis of the steady, compressible, one-dimensional, laminar flow of sodium vapor is presented for the case of a flat plate-type heat pipe with asymmetrical boundary conditions. In addition, shear stress at the liquid-vapor interface, variations of vapor quality, and momentum and energy factors are considered. A similarity solution for a semiporous channel is used to provide the velocity profile at cross sections.

4.2 Similarity solution for a semiporous channel

4.2.1 Governing differential equations

A sketch of the geometry for a semiporous channel is given in Figure 4.1. The following assumptions are made: that the fluid flow is incompressible and laminar, and that the properties of the fluid are constant. The width of the channel is assumed much greater than the height. Therefore, two-dimensional flow is considered. Fully developed flow is assumed in the channels. A constant injection or suction velocity is used. With these assumptions, the Navier-Stokes equations for two-dimensional, steady state, incompressible, laminar flow are written as

$$U\frac{\partial U}{\partial X} + V^*\frac{\partial U}{\partial Y} = -\frac{1}{\rho}\frac{\partial P}{\partial X} + \nu \left[\frac{\partial^2 U}{\partial X^2} + \frac{\partial^2 U}{\partial Y^2}\right]$$
(4.1)

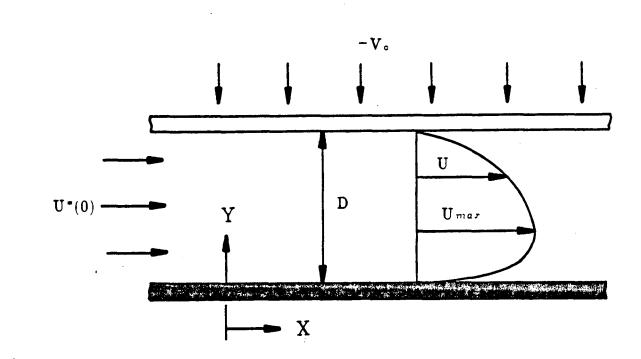
$$U\frac{\partial V^*}{\partial X} + V^*\frac{\partial V^*}{\partial Y} = -\frac{1}{\rho}\frac{\partial P}{\partial Y} + \nu \left[\frac{\partial^2 V^*}{\partial X^2} + \frac{\partial^2 V^*}{\partial Y^2}\right]$$
(4.2)

and the continuity equation is

$$\frac{\partial U}{\partial X} + \frac{\partial V^*}{\partial Y} = 0 \tag{4.3}$$

Boundary conditions used on the channel surfaces are

$$U = 0$$
, and $V^* = 0$ at $Y = 0$ (solid wall) (4.4)



 $-V_{\circ}$: Injection, depicted. V_{\circ} : Suction.

Figure 4.1. Schematic diagram of a semiporous channel.

$$U = 0$$
, and $V^* = V_o$ at $Y = D$ (porous wall) (4.5)

4.2.2 Similarity transformations

The governing equations can be transformed into total differential equations by the use of a dimensionless length coordinate, ω , and a dimensionless function, f, which automatically satisfies the continuity equation. The new variables[53] are defined as

$$\omega = \frac{Y}{D} \tag{4.6}$$

$$f(\omega) = \frac{\varphi}{DV} \tag{4.7}$$

where $V(X) = U^*(0) - \frac{V_{a}X}{D}$ and $U^*(0)$ is the average velocity at X = 0.

Then, the local velocity can be expressed by the new variables as follows:

$$U = \frac{\partial \varphi}{\partial Y} = V f' \tag{4.8}$$

$$V^* = -\frac{\partial\varphi}{\partial X} = V_{\circ}f \tag{4.9}$$

Use of Equations(4.1), (4.2), and (4.6) to (4.9) gives

$$-\frac{1}{\rho}\frac{\partial P}{\partial X} = V\left[\frac{V_{\circ}}{D}(ff'' - f')^2 - \frac{\nu}{D^2}f'''\right]$$
(4.10)

$$-\frac{1}{\rho}\frac{\partial P}{\partial\omega} = V_{\circ}\left[V_{\circ}ff' - \frac{\nu}{D}f''\right]$$
(4.11)

Since the right side of Equation(4.11) is a function of ω only, differentiating with respect to X yields

$$\frac{\partial^2 P}{\partial X \partial \omega} = 0 \tag{4.12}$$

On taking the derivative with respect to ω , applying Equation(4.12), and integrating, Equation(4.10) becomes

$$Re_{\circ}\left[(f')^{2} - ff''\right] + f''' = -A$$
 (4.13)

where $Re_{\circ} = \frac{V_{\circ}D}{\nu}$ and $A = -\frac{D^2}{\nu\rho}\frac{\partial P}{\partial X}$

The transformed boundary conditions are written as

$$f' = f = 0$$
 at $\omega = 0$ (solid wall) (4.14)

$$f' = 0, f = 1$$
 at $\omega = 1$ (porous wall) (4.15)

4.2.3 Solution of equation

Differential Equation(4.13) together with the associated boundary conditions, constitutes a nonlinear boundary value problem with the parameter Re_{\circ} . Since this governing equation is no longer partial differential equation, it can be solved numerically by the Runge-Kutta integration method. However, the number of boundary conditions is not enough to solve Equation(4.13). Therefore, for each specified Re_{\circ} , the value of A and f''(0) are guessed to solve a system of the first order differential equations. Then, at $\omega = 1$ (porous wall), the calculated values of f' and f are compared with the given boundary conditions. When both values are not acceptable, other values are used until the convergent tolerance is satisfied. When wall Reynolds numbers for suction are greater than 13, separation occurs on the solid wall. Similarity solutions are valid for wall Reynolds numbers up to 13. Hence, the equation is solved for wall Reynolds numbers ranging from - 30 to 13.

A comparison of the present results with those found in the literature [53,54], which use the perturbation method for small Reynolds numbers and a different numerical scheme, verifies the accuracy of this numerical solution.

The velocity profiles for the suction and injection sections are shown in Figures 4.2 and 4.3. Asymmetric boundary conditions cause the velocity profiles to be asymmetric. For injection, $\text{Re}_{\circ} < 0$, the location of the maximum velocity shifts from the center of the channel toward the solid wall. Thus, injection increases friction at the solid wall, and decreases friction at the porous wall. As wall Reynolds numbers increase, the degree of shifting is large, although the general shape is changed little. For suction, $\text{Re}_{\circ} > 0$, the location of the peak velocity shifts toward the porous wall. Hence, suction increases friction at the porous wall and decreases friction at the solid wall. Unlike injection, separation for suction appears around a wall Reynolds number of 13. The velocity profiles change considerably with wall Reynolds number. In general, friction for the semiporous channel is larger than that for the impermeable channel.

Results[19] from two-dimensional, incompressible, Navier-Stokes equations for a flat plate heat pipe show similar velocity profiles. In the evaporator, the velocity profiles retain similarity for a wall Reynolds number of 50, which is the highest value tested. However, back flow was observed near the end of the condenser for a wall Reynolds number of 10. For a wall Reynolds number of 50, back flow was observed in the entire condenser section.

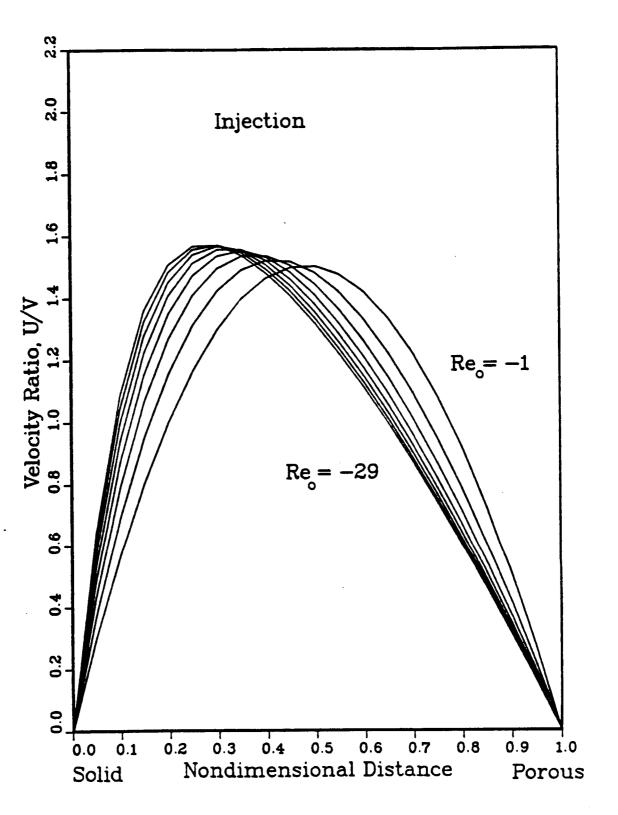


Figure 4.2. Velocity profiles for wall injection in a semiporous channel.

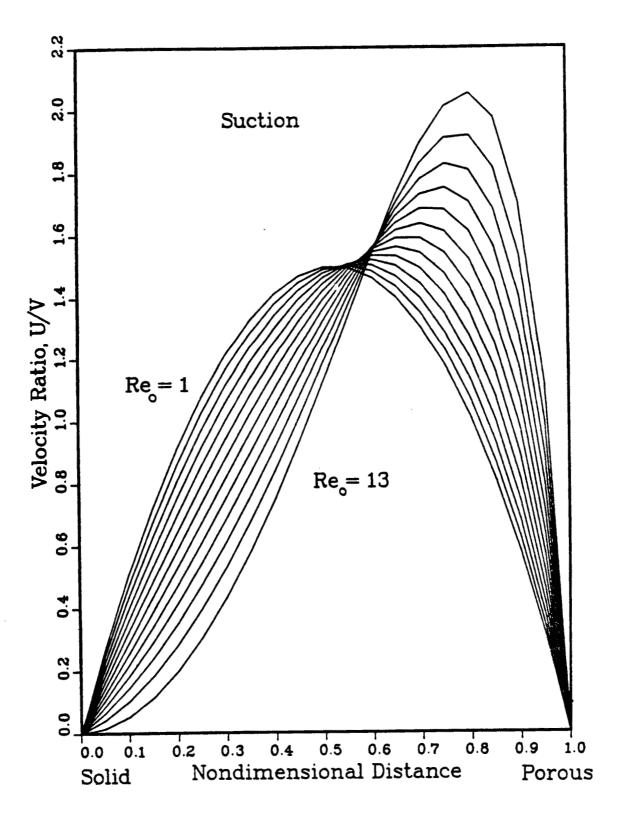


Figure 4.3. Velocity profiles for wall suction in a semiporous channel.

4.3 Compressible vapor flow analysis

Steady, compressible, one-dimensional, laminar flow in a heat pipe is considered. The principal governing equations for mass, momentum, and energy are formulated by using the average velocity as described in Chapter 2. This velocity is approximated from velocity distributions based on the similarity solution of semiporous channels. Shear stress at the interface, and the momentum and energy factors are similarly calculated and shown in Figure 4.4.

The fluid in the vapor passage of the heat pipe is assumed to be a mixture of liquid and monatomic vapor. Thus, the quality of the vapor is considered. The specific volume v and the enthalpy h are expressed as

$$v = v_f + X_q \times (v_g - v_f) \tag{4.16}$$

$$h = h_f + X_g \times h_{fg} \tag{4.17}$$

The specific volume of the saturated vapor can be approximated by

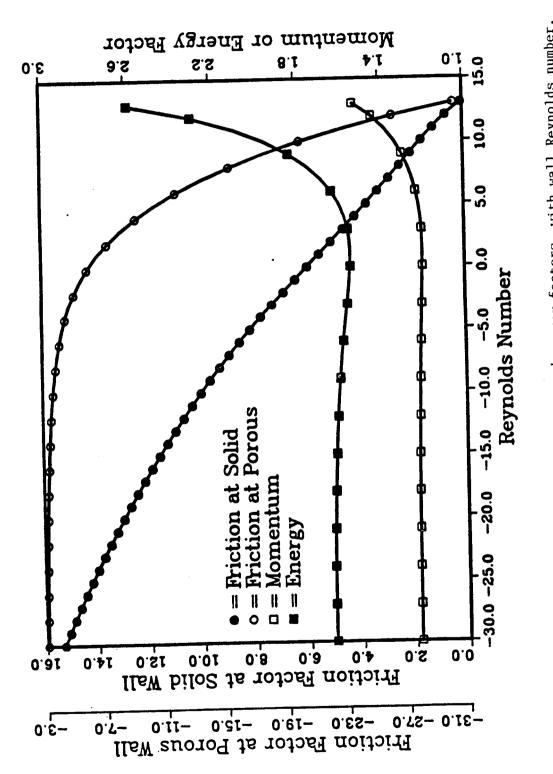
$$v_g = \frac{R_u T}{PM} \tag{4.18}$$

Also, the temperature and pressure are related by the Clausius-Clapyron equation:

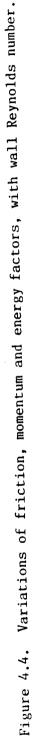
$$\frac{dP}{P} = \frac{h_{fg}M}{R_u}\frac{dT}{T^2} \tag{4.19}$$

where h_{fg} is the enthalpy of vaporization, v_f and v_g are the specific volume of saturated liquid and vapor, respectively, and X_q is the vapor quality.

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4.3.1 Formulation of differential equations

Bankston and Smith[17] showed that variation of the momentum and energy factors with axial distance and radial Reynolds number is very small except near the end of the heat pipe. Figure 4.4 shows that both M_f and E_f are nearly independent of the radial Reynolds number except near separation. These results are taken from the similarity solution for semiporous channels. Therefore, it is assumed that the derivatives of M_f and E_f with respect to chordwise distance are equal to zero. In addition, assuming v_f and h_{fg} are constant quantities, and combining Equations(2.15) through (2.21) and Equations(4.16) through (4.19) yields the chordwise gradients for the density, quality, velocity, pressure, and temperature.

4.3.1.1 Density

The differentiation of Equation(4.18) with respect to S gives

$$\frac{dv_g}{dS} = -\frac{v_g}{P}\frac{dP}{dS} + \frac{v_g}{T}\frac{dT}{dS}$$
(4.20)

Substitution of Equation(4.19) into the equation above yields

$$\frac{dv_g}{dS} = \frac{v_g}{P} \left[\frac{R_u T}{h_{fg} M} - 1 \right] \frac{dP}{dS}$$
(4.21)

The derivative of the mixture specific volume in the S-direction is written as

$$\frac{dv}{dS} = \frac{dv_f}{dS} + (v_g - v_f)\frac{dX_q}{dS} + X_q \left[\frac{dv_g}{dS} - \frac{dv_f}{dS}\right]$$
(4.22)

With the prescribed assumption for v_f , substitution of Equation(4.21) into Equation(4.22) results in

$$\frac{dv}{dS} = (v_g - v_f)\frac{dX_q}{dS} + \frac{v_g X_q}{P} \left[\frac{R_u T}{h_{fg}M} - 1\right]\frac{dP}{dS}$$
(4.23)

The derivative of specific volume and density are related as follows:

$$\frac{d\rho}{dS} = -\frac{1}{v^2} \frac{dv}{dS} \tag{4.24}$$

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From Equations(4.23) and (4.24), the expression for density in differential form can be written as

$$\frac{d\rho}{dS} = -\frac{1}{v^2} \left[(v_g - v_f) \frac{dX_q}{dS} + \frac{v_g X_q}{P} \left(\frac{R_u T}{h_{fg} M} - 1 \right) \frac{dP}{dS} \right]$$
(4.25)

4.3.1.2 Quality

From Equation (4.23), the quality gradient is expressed as

$$\frac{dX_q}{dS} = \frac{1}{(v_g - v_f)} \left[\frac{dv}{dS} + \frac{v_g X_q}{P} \left(1 - \frac{R_u T}{h_{fg} M} \right) \frac{dP}{dS} \right]$$
(4.26)

Substitution of Equation(4.24) and the equations for conservation of mass, Equation(2.15), and momentum, Equation(2.16), into Equation(4.26) yields

$$\frac{dX_q}{dS} = \frac{v^2}{(v_g - v_f)V^2} \left\{ \left[-\frac{1}{M_f} + \frac{V^2 X_q}{P} \frac{v_g}{v^2} \left(1 - \frac{R_u T}{h_{fg} M} \right) \right] \frac{dP}{dS} - \frac{FV^2}{8DvM_f} \right\} - \frac{v^2}{(v_g - v_f)} \frac{2\dot{m}_o}{DV}$$
(4.27)

4.3.1.3 Velocity

The equation for conservation of mass, Equation(2.15), can be expressed as follows:

$$\frac{dV}{dS} = \frac{v\dot{m}_{\circ}}{D} + \frac{V}{v}\frac{dv}{dS}$$
(4.28)

Substitution of Equation(4.23) into the expression above gives

$$\frac{dV}{dS} = \frac{v\dot{m}_{\circ}}{D} + \frac{V(v_g - v_f)}{v}\frac{dX_q}{dS} + \frac{VX_q}{P}\frac{v_g}{v}\left(\frac{R_uT}{h_{fg}M} - 1\right)\frac{dP}{dS}$$
(4.29)

4.3.1.4 Pressure

With the previously mentioned assumptions, substitution of the energy Equation (2.17) into the momentum Equation (2.16) yields

$$\frac{dP}{dS} - \frac{M_f \rho}{E_f} \frac{dh}{dS} - \frac{M_f \dot{m_o}}{E_f V D} \left(h - h_o - \frac{E_f V^2}{2} - \frac{V_o^2}{2} \right) = -\frac{F \rho V^2}{8D}$$
(4.30)

In order to obtain an expression for the derivative of the vapor enthalpy, differentiation of Equation(4.17) is taken with respect to S, and Equation(4.19) is substituted:

$$\frac{dh}{dS} = h_{fg}\frac{dX_g}{dS} + \frac{c_p R_u}{h_{fg}M}\frac{T^2}{P}\frac{dP}{dS}$$
(4.31)

After the expressions for the derivative of the enthalpy and quality are substituted into Equation (4.29), the pressure gradient can be expressed as follows:

$$\frac{dP}{dS} = \frac{-\frac{M_f \dot{m}_o}{E_f V D} \left[2h_{fg} + \frac{v_g - v_f}{v} \left(h_o - h + \frac{E_f V^2}{2} + \frac{V_o^2}{2} \right) \right] - \frac{1}{E_f} \frac{h_{fg}}{v} \frac{F}{8D} - \frac{v_g - v_f}{v^2} \frac{F V^2}{8D}}{\frac{v_g - v_f}{v} + \frac{1}{E_f} \frac{h_{fg}}{V^2} - \frac{M_f}{E_f} \frac{h_{fg} X_g}{v^2} \frac{v_g}{v^2} \left(1 - \frac{R_u T}{h_{fg} M} \right) - \frac{M_f}{E_f} \frac{v_g - v_f}{v^2} \frac{c_p R_u}{h_{fg} M} \frac{T^2}{P}}{(4.32)}$$

The temperature gradient is derived from the Clausius-Clapyron equation, Equation(4.19), as follows:

$$\frac{dT}{dS} = \frac{R_u T^2}{h_{fg} M P} \frac{dP}{dS}$$
(4.33)

CHAPTER V

COMPUTATIONAL PROCEDURES

5.1 Transient conduction equation with phase change

The algorithm proceeds similarly to most finite element method procedures. First, the element data are generated by a grid generation program. This data consists of the coordinates cf the nodal points of each element, by element, and the properities and boundary conditions for each element. Based on this data, the capacitance matrices, [C], and the conductance matrices, $[K_c]$, related to the time derivative of nodal temperatures and conduction, are calculated for each element. The conductance matrices, $[K_h]$ and $[K_r]$, and the vectors $\{F_q\}$, $\{F_h\}$, and $\{F_r\}$ for specified surface heating, convection, and radiation boundary conditions, are computed only for elements having the boundary conditions above. These boundary conditions may be time dependent, so these matrices and vectors must be evaluated based on the appropriate temperatures. For an implicit time step, the iteration scheme is such that temperatures are initially assumed, and the proper value of θ is chosen to obtain stable and accurate results. In this study, $\theta = \frac{1}{2}$ or 1 is used, so iterations are required within each time step. However, for an explicit time step, such as the Dupont scheme, the element temperatures for the previous step are involved in obtaining the matrices and vectors related to the boundary conditions. Then, these element matrices and vectors are assembled into the global matrices for the entire solution domain, and the full set of equations may be written in matrix form as

$$\left[\mathbf{A}\mathbf{M}\right]\{\mathbf{T}\} = \{\mathbf{R}\mathbf{M}\}\tag{5.1}$$

where $[\mathbf{AM}]$ represents the banded coefficient matrix, $\{\mathbf{T}\}$ denotes a column matrix of unknown temperatures, and $\{\mathbf{RM}\}$ is the column matrix of constants. If temperatures are specified on some boundary surfaces, these boundary conditions must be incorporated into the global matrices as described in reference[55].

Once the global matrices have been assembled, they are solved by using Choleski decomposition. Choleski's method[56] has the advantage of being simpler and easier to implement than other elimination methods. It may also be used to advantage for storage in the computer by overlaying the upper and lower triangular matrices in the same storage location([AM] matrix).

The system of Equations(3.25) for the implicit method or (3.26) for the explicit method is then marched forward in time. Among the various iteration schemes, the Newton-Raphson method is used for the implicit method because of its fast convergence. For the explicit method, iteration is not required, but it is not a selfstarting scheme, so the implicit method is employed for the first few time steps. When temperatures at two previous time steps are known, the explicit method can be marched forward. The algorithm flowchart is shown in Figure 5.1.a.

5.2 Compressible vapor flow

The five dependent variables: density, quality, velocity, pressure, and temperature, are coupled by differential Equations(4.25), (4.27), (4.29), (4.32), and (4.33), which are first order, nonlinear, ordinary differential equations. A computer code has been written to numerically solve these equations simultaneously using the Runge-Kutta integral method, which needs only proper boundary conditions for

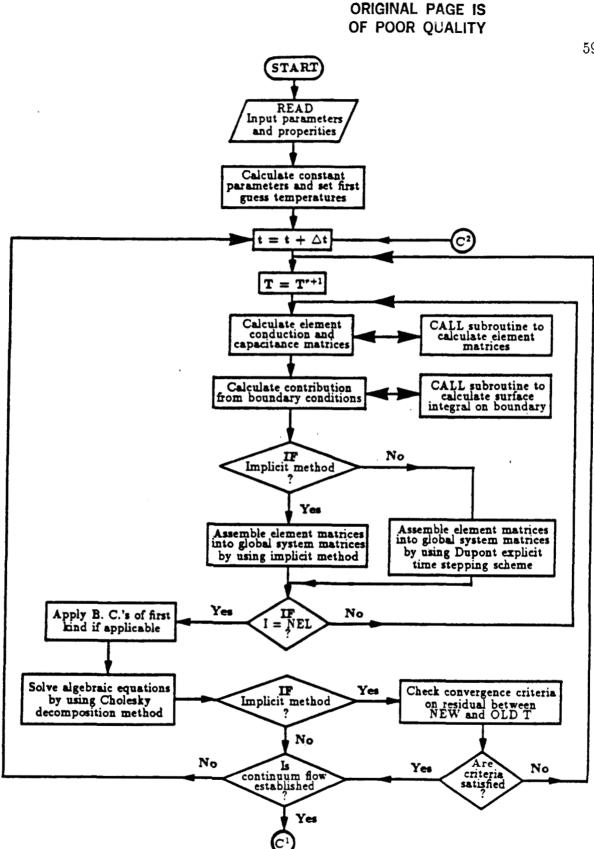


Figure 5.1.a Algorithm flowchart.

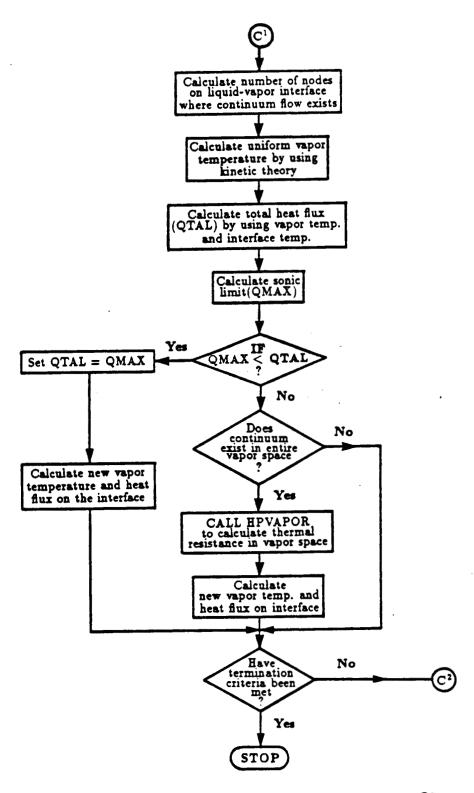


Figure 5.1.b Algorithm flowchart.

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the first step of integration.

Since the velocity term appears in the denominator of Equation(4.32), the physical boundary condition for velocity cannot be used directly. To avoid this problem, proper boundary conditions at the upstream end of the evaporator are determined for initiating all calculations as follows: a new boundary condition for the velocity is determined a short distance away from the beginning of the evaporator, assuming incompressible and saturated vapor flow at the temperature corresponding to the heat pipe operating temperature. Saturation pressure is used for the pressure. Since the velocity is small at this point close to the upstream end of the evaporator, boundary conditions determined this way are realistic. The differential equations are solved using these boundary conditions.

5.3 Coupling vapor flow effects

When the Mach number is less than about 0.2, compressibility is neglected, and friction effects at the interface may be negligible due to the low velocity of the vapor. Thus, most studies of heat pipe performance[5,23-25] assumed that the temperature is uniform throughout the vapor space. This approximation eliminates difficulties encountered in solving the vapor flow dynamics, and gives simple results for low operating temperatures with small heat fluxes. When the vapor temperature is uniform in the vapor space, no thermal resistance exists, so a maximum amount of energy can be transferred through the vapor space for a given operating condition.

The energy stored in the vapor space is negligible due to low density, so the energy entering the evaporator is equal to the that leaving the condenser. Equation(2.12), which describes evaporation and condensation, is applied to every element at the interface, and the energy balance in the vapor space is:

$$\sum_{i=1}^{m_{e}} \left[\frac{P_{f_{i}}}{\sqrt{T_{f_{i}}}} - \frac{P_{g}}{\sqrt{T_{g}}} \right] \bigtriangleup L_{i} = \sum_{i=1}^{m_{e}} \left[\frac{P_{f_{i}}}{\sqrt{T_{f_{i}}}} - \frac{P_{g}}{\sqrt{T_{g}}} \right] \bigtriangleup L_{i}$$
(5.2)

where m_e is the number of elements at the interface in the evaporator, m_c is the number of elements in the condenser, and ΔL_i is the side length of an element at the interface. Equation(5.2) can be solved by iteration to obtain the uniform vapor temperature, as long as the temperature at the interface is known. The heat flux at the interface is evaluated using Equation(2.12) with known temperatures.

However, when liquid metal is used as the working fluid, and the heat flux applied to the surface is large, the velocity of the vapor is large, so the temperature drop in the vapor space should be considered. The temperature drop in the vapor region implies that the thermal resistance allows less energy to be transferred from the evaporator to the condenser. Thus, the evaporator temperature is higher, and the condenser temperature is lower, than in the uniform vapor temperature case.

When vapor flow dynamics is coupled with the heat pipe shell and capillary structure at the interface, the governing equations are solved simultaneously with unknown boundary conditions at the interface. Iterations are required for every time step until both results match at the interface. This method may yield accurate results, but in general consumes much computational time, due to iteration. Also convergence may not be reached. Hence, an approximation method is employed to eliminate these difficulties.

Instead of simultaneously solving governing equations for both regions, governing equations for the vapor region are separately solved with a given heat flux, so that the temperature drop, ΔT_g , can be obtained. The thermal resistance, R_g , in the vapor space may then be evaluated from Equation(5.3):

$$Q = \frac{\triangle T_g}{R_g} \tag{5.3}$$

In order to obtain the thermal resistance, the total heat flow rate is needed. But without solving both governing equations, the heat flow rate is also unknown. Thus, the known heat flow rate at the previous time step is used, and the heat flow rate evaluated at the present time step is used at the next time step.

Coupling of the evaporator and condenser sections becomes very difficult when vapor temperature changes along the length of the vapor section. An approximate coupling method is used here which accounts for thermal resistance in the vapor region but which uses a constant vapor temperature. Since the total heat transfer rate through the vapor space, which is computed by using Equation(2.12), is the same as the heat input at the liquid-vapor interface in the evaporator or heat output at the interface in condenser, a certain fictitious layer, which has the same thermal resistance as that evaluated in the vapor space, may be placed at the liquid-vapor interface. Thus, the temperature at the new interface in the evaporator is lower than that at the true interface, due to the resistance in the fictitious layer, and vice-versa for the condenser. With this coupling technique the heat fluxes are correct throughout the pipe and vapor thermal resistance is taken into account.

In order to compute the uniform vapor temperature, the temperatures at the new interface are used for T_{f_i} in Equation(5.2), and the heat flux at the interface is calculated by using Equation(2.12) with the uniform vapor temperature and the temperatures at the new interfaces. This heat flux then serves as the boundary condition at the liquid-vapor interface when solving the governing equations for the heat pipe shell, capillary structure, and vapor flow at the next time step. By using this approximation scheme, iterations can be excluded, while vapor flow effects are

retained.

5.4 Overall computational procedures

Since the working fluid of the heat pipe is initially in the solid state and the wick structure is saturated, the transient conduction equation is applied to the heat pipe shell and wick structure. The variable heat flux and radiation boundary condition are considered on the outside surface of the heat pipe. The adiabatic boundary condition is used at the liquid-vapor interface, due to the vaccuum in the vapor space, until the nodal temperatures at this interface are greater than the transition temperature (700 K). The implicit method is used for the the first ten time steps, and then the explicit method is employed using a time step of 10 seconds.

When the temperatures of the first two nodes at the liquid-vapor interface are greater than 700 K, Equation(5.2) is solved for the vapor temperature by using the Newton-Raphson method. Then, the heat fluxes are calculated using Equation(2.12) with the known interface and vapor temperatures. These heat fluxes are to be used as boundary conditions at the interface for the next time step. However, the adiabatic boundary condition is still applicable for the rest of the interface. From then on, a small time step is used to obtain stable startup. These procedures continue until the heat transport in the chordwise direction is less than the sonic limit.

When the sonic limit is encountered, the total heat transport through the vapor space should equal the sonic limit, and Equation(2.14) is solved for the vapor temperature. The heat fluxes at the interface in the evaporator are calculated by using this vapor temperature and the nodal temperatures at the interface. Then the heat fluxes for the condenser are evaluated in proportion to nodal temperatures which are greater than 700 K. Again, these heat fluxes are used to solve the transient

conduction equation for the heat pipe shell and wick structure. This scheme is effective until the entire vapor space achieves continuum flow and the heat transport in the chordwise direction is less than the sonic limit.

When the sonic limit is not encountered, Equations(4.25), (4.29), (4.32), and (4.33), which are first order, nonlinear, ordinary differential equations for compressible vapor flow dynamics, are solved to evaluate the thermal resistance in the vapor space, as stated in section 5.3. This computational scheme is used until the desired operating temperature, or the steady state condition, is reached. Figures 5.1.a and 5.1.b schematically shown the computational procedures.

Since any implicit scheme is excluded, except the first few steps to provide initial conditions for the explicit method, time steps are gradually decreased from 0.5 seconds to the order of milli-seconds to maintain a stable condition at the liquidvapor interface. The computer code is successively tested against the given physical model by following these procedures.

CHAPTER VI

RESULTS AND DISCUSSION

6.1 Transient conduction and phase change

To verify the finite element formulation and algorithm, computed numerical solutions are compared with available solutions, such as analytical and other approximate solutions.

6.1.1 Temperature of a semi-infinite body

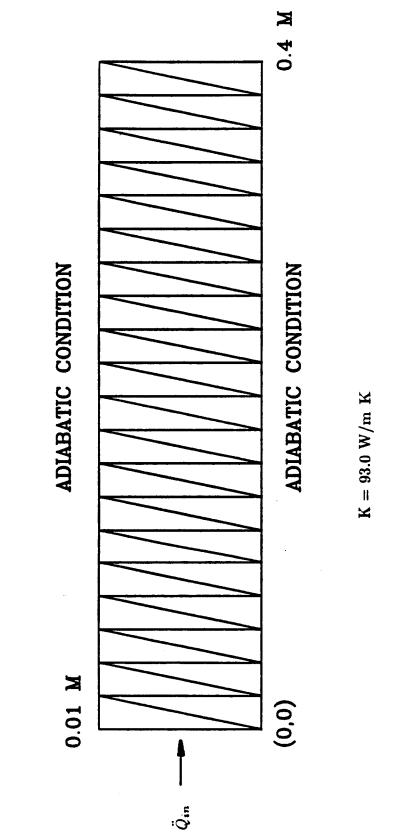
This case involves pure conduction of heat, without phase change, over a semiinfinite body. It is solved as a two-dimensional problem, shown in Figure 6.1. Adiabatic boundary conditions are assumed throughout, but at the surface (X = 0), the constant heat flux ($\ddot{Q} = 100 kW/m^2$) is imposed to heat the surface while the initial sodium temperature of 293 K is uniform. The conductivity and specific heat are assigned constant values for sodium.

The exact solution to this problem was given by Luikov[57] as

$$T(X,t) = \frac{2\ddot{Q}}{K}\sqrt{\alpha t} \left[\frac{1}{\sqrt{\pi}} \exp\left(\frac{-X^2}{4\alpha t}\right) - \frac{X}{2\sqrt{\alpha t}} \operatorname{erfc}\left(\frac{X}{2\sqrt{\alpha t}}\right)\right] + T_{\circ}$$
(6.1)

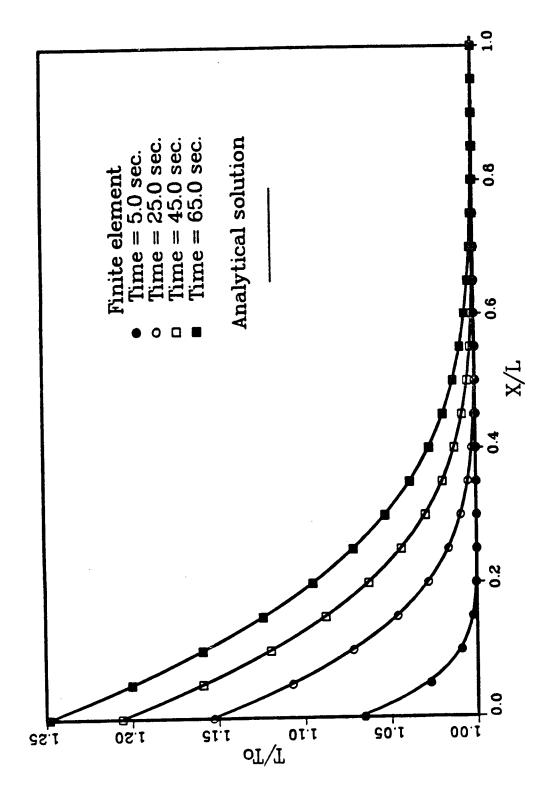
where $\alpha = \frac{K}{\rho c_p}$

For the numerical solution, an explicit time stepping scheme is used with an implicit method for starting. A time step of 5 seconds is used, and numerical calculations are terminated as the temperature of the last node starts to change from the initial temperature. Numerical results are compared to the analytical solution in Figure 6.2. The results yield excellent agreement.



 $C = 2.57 \times 10^6 \text{ J/m}^3 \text{ K}$

Figure 6.1. Finite element mesh for the transient conduction heat transfer problem.





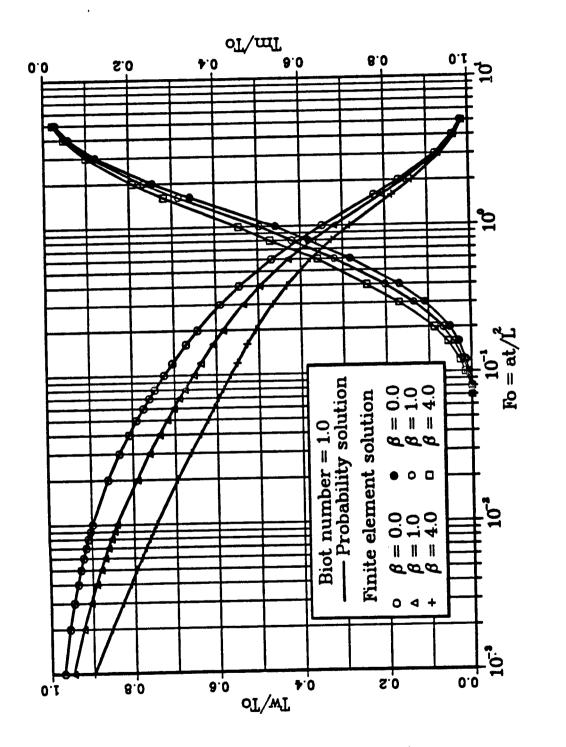
6.1.2 Convection and radiation boundary conditions

This example tests the ability of the numerical method to handle convection and radiation boundary conditions. The same grid system shown in Figure 6.1 is used, but the boundary condition on the surface at X = 0 is replaced. For a Biot number of 1.0, three different cases are examined. First, only a convection boundary condition ($\beta = 0.0$) is applied to the surface, and an initial temperature of 1650 K is used. Next, convection and radiation boundary conditions($\beta = 1.0$) are applied to the surface with the same initial temperature. Finally, an initial temperature of 2650 K, which is greater than the previous two cases, is used for $\beta = 4.0$. In these tests, phase change is not involved, and the properties of sodium are used for specific heat and conductivity.

An analytical solution for this case is not available except for one having only a convection boundary condition, so the numerical results are compared with probablity solutions which Sheikh and Sparrow[58] found for the same cases. As shown in Figure 6.3, temperatures at the boundary surface and opposite end are plotted versus time. The results show good agreement.

6.1.3 Phase change of sodium

In this example, sodium is used as the phase change material for two-dimensional region as shown in Figure 6.4. An initial temperature of 393 K is used. The ratio of diffusivities of solid and liquid phases is assumed to be one to compare with the existing solution. Boundary conditions($T_{\bullet} = 293$ K) of the first kind are imposed on the surfaces. Since specified temperature boundary conditions are suddenly imposed on the surface, the temperature gradient in this region is infinite, which causes unstable conditions. This difficulty may be eliminated by introducing



Comparison of convection and radiation boundary conditions. Figure 6.3.

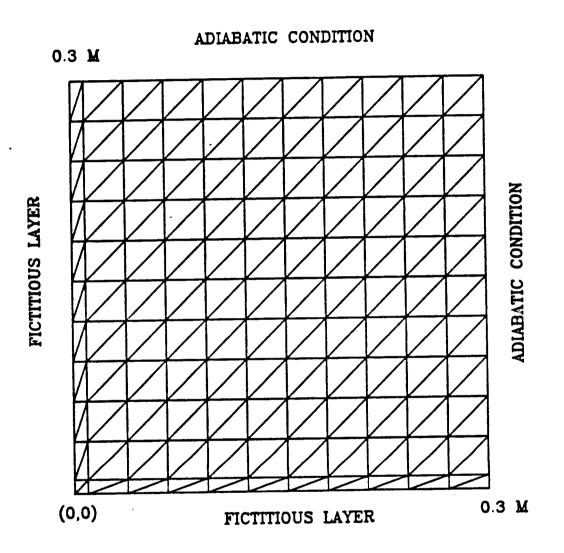


Figure 6.4. Two-dimensional mesh used to represent a corner region: 242 elements, 144 nodes.

a layer of fictitious elements with negligible thermal storage capacity and very high conductivity, such that the temperature gradient at this region artificially becomes finite. For this purpose, numerical values of the thermophysical properties of the ficititious layer are chosen as follows:

$$ho c_p = 1.26 \times 10^4 J/m^3 K$$
 $K = 4.19 \times 10^3 W/mK$

Two different time stepping schemes, the fully implicit method and the explicit method, are employed to compare the computational time and results. A time step of 5 seconds is used. For the two-dimensional case, the position of the interface is compared with an approximate solution given by Rathjen and Jiji [59]. This solution assumes that the ratio of diffusivities of solid and liquid is unity, and that the interface at points beyond three times of the one-dimensional interface in X and Y directions is the same as the one-dimensional interface position. Both numerical solutions for explicit and implicit methods are directly compared with the approximate solution, and good agreement is obtained for early time steps, as shown in Figure 6.5. As time passes, the position of the interface given by numerical results advances further than for the approximation, and the interface lines obtained from the approximate are not perpendicular to the boundary surface. According to assumptions made by Rathjen and Jiji, adiabatic boundary conditions for the approximate solution can be located beyond the present solution domain at certain time steps. However, the numerical calculations use adiabatic boundary conditions, so that all heat is used for phase change, while the approximate solution does not match the same boundary condition within the solution domain. This explains why the positions of the two interfaces are different.

Numerical results predicted by the explicit method using an implicit scheme for

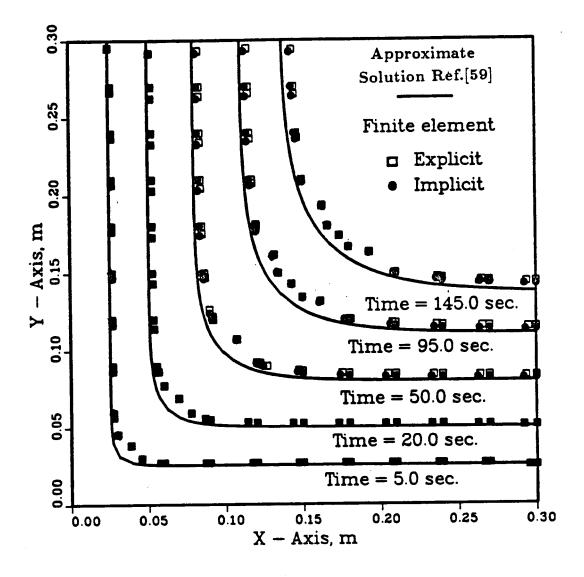


Figure 6.5. Solidification of sodium in a corner region: position of the interface at different times.

a few initial time steps are close to those of the fully implicit scheme and the explicit method consumes much less computational time, since iterations are eliminated.

Even though the numerical solutions do not exactly match the approximate solutions, because of different boundary conditions, general trends in the numerical results and the usefulness of the explicit time stepping scheme are verified.

6.2 Compressible vapor flow

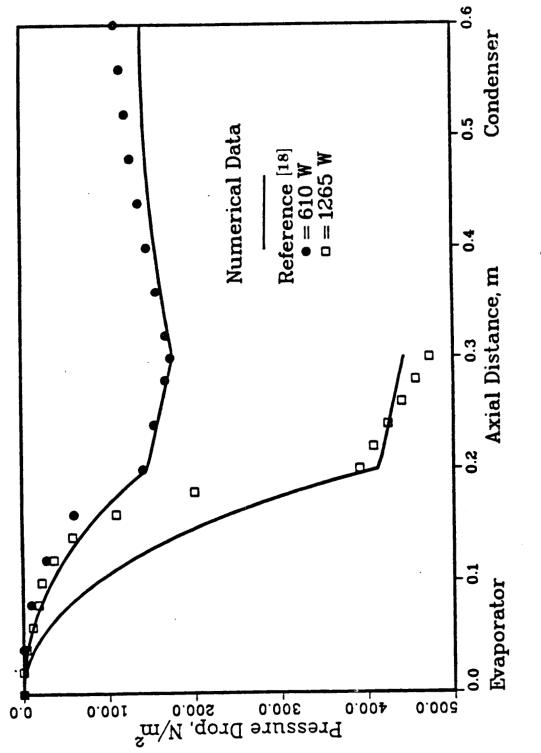
To test the differential formulations and algorithm for vapor flow, the numerical solutions are compared to other numerical results[18] for cylindrical heat pipes with sodium as the working fluid, since data for a flat plate heat pipe are not available. The two-dimensional mass, momentum, and energy conservation equations, which were transformed in terms of the stream function, vorticity and enthalpy, were solved numerically. The dimensions of this cylindrical heat pipe are: total length of 0.6 m, evaporator length of 0.2 m, condenser length of 0.3 m, and inside radius of 0.0086 m. Since variation of temperature and pressure in the axial direction for low heat input is small, two different operating conditions are selected. One has an operating temperature of 818 K with a uniformly distributed heat input of 610 watts. Another has an operating temperature of 841 K with a heat input of 1265 watts.

To match the results for the rectangular heat pipe to that for the cylindrical heat pipe, the rectangular cross-section of the vapor space is modeled such that the cross-section area is the same as for the cylinder, and the hydraulic radius is close to the radius of cylinder. Also, the same heat input is applied to yield the same velocity and a similar Reynolds number in the axial direction, and the same length for each section is used. The wall Reynolds number at the condenser must be less than 14 to use the results of the similarity solution. Therefore, two different cross

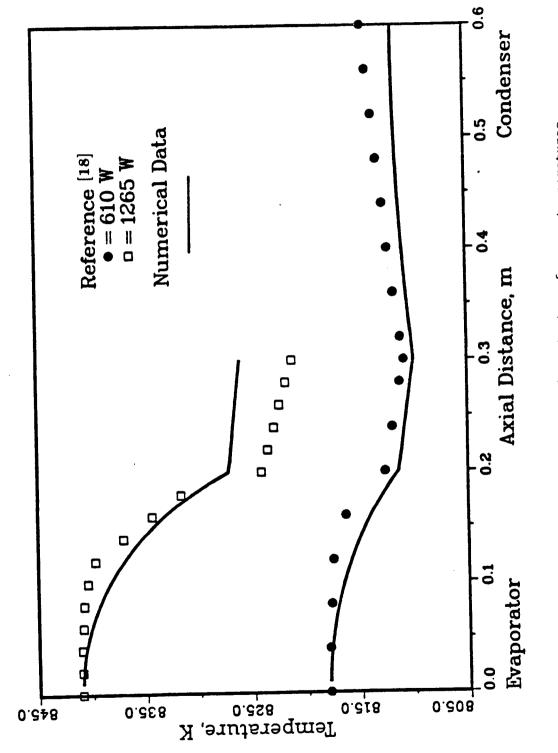
sections are chosen. For high heat flux, the wall Reynolds number cannot be less than 14 so that a square of 0.0152 m is used and comparison is made only for the evaporator and adiabatic sections. For low heat flux, the cross section is chosen such that the wall Reynolds number at the condenser is close to the allowable maximum value. Thus, the cross section is rectangular with a width of 2.11 cm and a height of 1.1 cm, resulting in a wall Reynolds number of 13.4 in the condenser. Even though the two models do not match exactly, the effect of vapor flow may be simulated using these models.

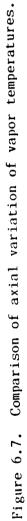
One-dimensional numerical results of the flat plate heat pipe are compared with published two-dimensional numerical data for cylindrical heat pipes as shown in Figures 6.6 and 6.7. Pressure and temperature drops for the one-dimensional case are a little greater than those for the two-dimensional case, but overall agreement is good. For high heat flux, pressure variation with axial position is somewhat different for the two cases, but the total pressure drops are nearly the same. Temperature profiles agree well. Thus, as shown in Figures 6.6 and 6.7, one-dimensional differential formulations yield valuable results. The difficulties of solving two-dimensional governing equations are avoided.

To investigate various vapor effects, two other heat pipes with sodium as the working fluid were selected for analysis. One has an adiabatic section, the other does not. Dimensions of the heat pipes are shown in Table 6.1. Different operating temperatures were chosen so that temperature effects could be evaluated. For each operating temperature, various heat fluxes were considered. Since the similarity solutions used are valid only while wall Reynolds numbers are less than 14, the maximum heat flux on the condenser is chosen to satisfy this condition.









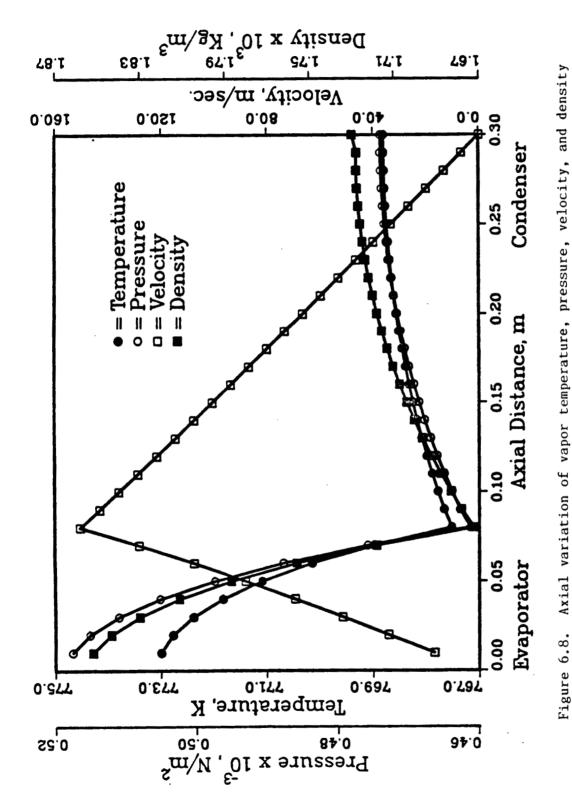
Dimension	773 K	808 K
L _e (cm)	8.0	20.0
La	0.0	10.0
L _c	22.0	30.0
מ י.	1.33	1.35
W	1.33	1.72
A _o (cm ²)	10.64	34.4

Table 6.1. Description of heat pipes

Figure 6.8 shows solutions for axial variation of vapor temperature, pressure, velocity, and density, as obtained from Equations(4.25), (4.27), (4.29), (4.32), and (4.33). An operating temperature of 773 K and a uniformly distributed heat transfer rate of 200 watts were used. Momentum equation(2.16) implies that variation of pressure in the axial direction depends on the relation between the contributions of inertia and friction. Thus, the pressure of the vapor in the evaporator falls sharply along the vapor passage due to friction and acceleration of the flow caused by the injection of mass. The corresponding temperature also drops sharply about 5.5 K. Since the density of sodium vapor is relatively low at low temperatures, the velocity is correspondingly large in order to transfer the required mass. Results show that the maximum Mach number reaches 0.3 at the exit of the evaporator.

In the condenser, extraction of mass tends to increase pressure because of decreasing velocity while friction tends to decrease pressure. Therefore, pressure cannot recover completely due to friction loss. Even though some temperature recovery is achieved in the condenser, the temperature at the end of the condenser is about 4.2 K less than that at the beginning of the evaporator. Figures 6.9, 6.10, and 6.11 show variations of temperature, pressure, and Mach number, respectively, corresponding to five different heat fluxes. At an operating temperature of 773 K, larger heat input leads to greater pressure and temperature drops, and to a higher Mach number. When the Mach number exceeds about 0.2, variation of the Mach number is large, due to expansion of the vapor. For heat inputs of 50 and 100 watts, the vapor can be assumed to be isothermal.

Figure 6.12 shows that heat transfer is limited to about 351 watts, because velocity at the end of the evaporator approaches the sonic velocity at this heat input.





at an operating temperature of 773 K.

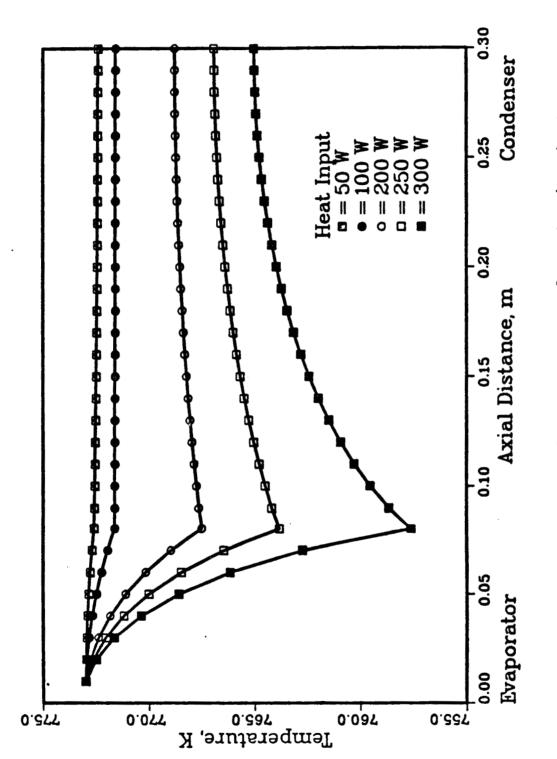
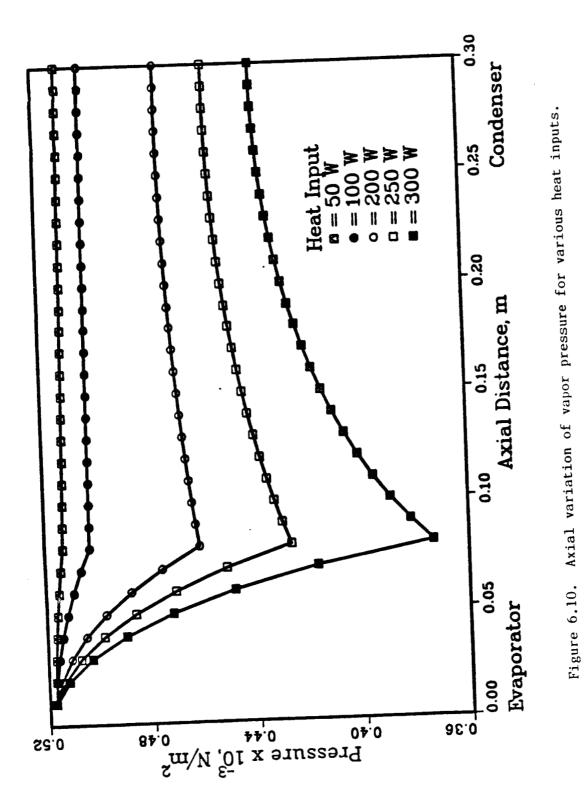


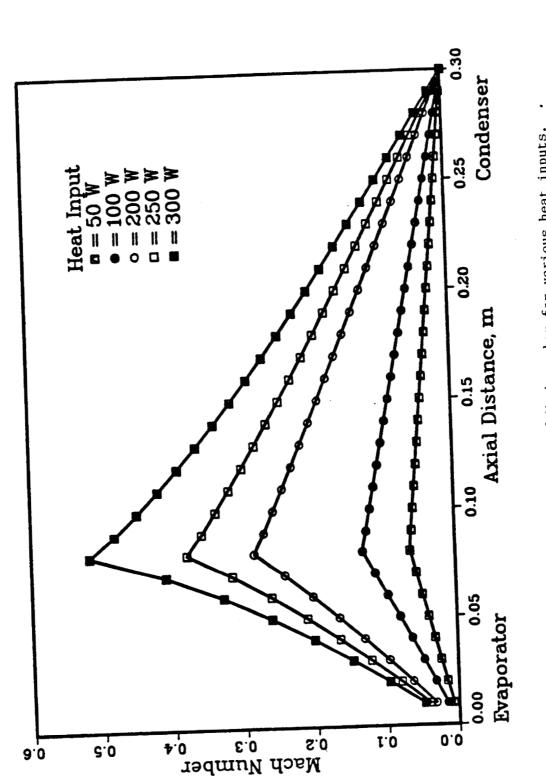
Figure 6.9. Axial variation of vapor temperature for various heat inputs.



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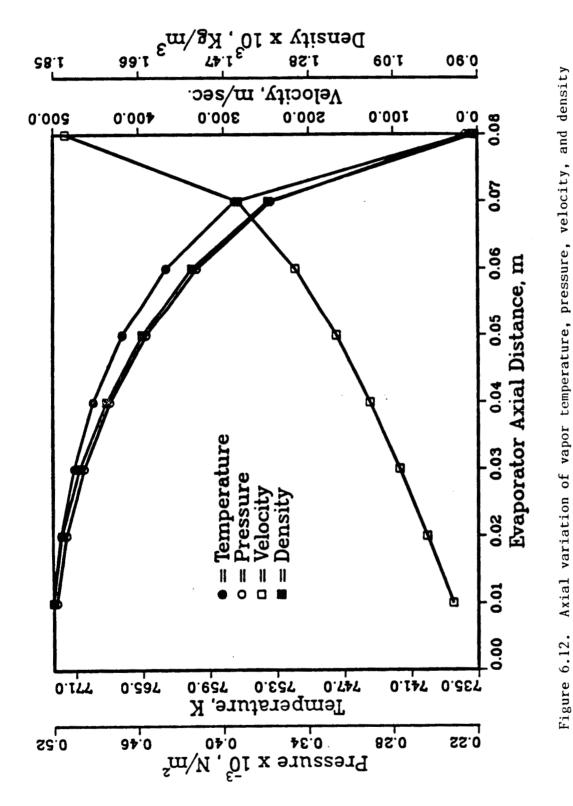
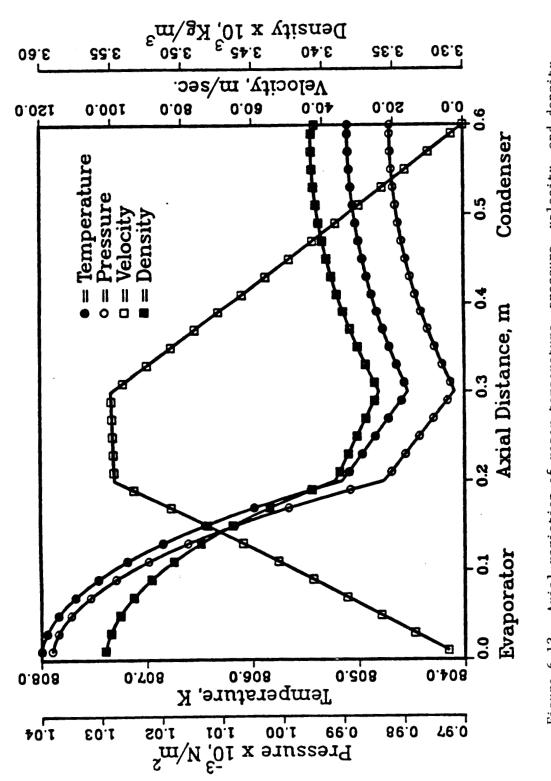




Figure 6.13 presents axial variation of vapor temperature, pressure, velocity, and density at an operating temperature of 808 K, with a uniformly distributed heat input rate of 350 watts. For this case, the operating temperature is 35 K higher, but the pressure and density are twice as high as for 773 K. Thus, velocities are small and the maximum Mach number is only about 0.2. This leads to a small pressure drop, with a corresponding temperature drop of about 2 K. Even though the heat input is twice as much as for 773 K, a comparison of temperature drops suggests that the pressure and temperature drops depend mainly on the operating temperature.

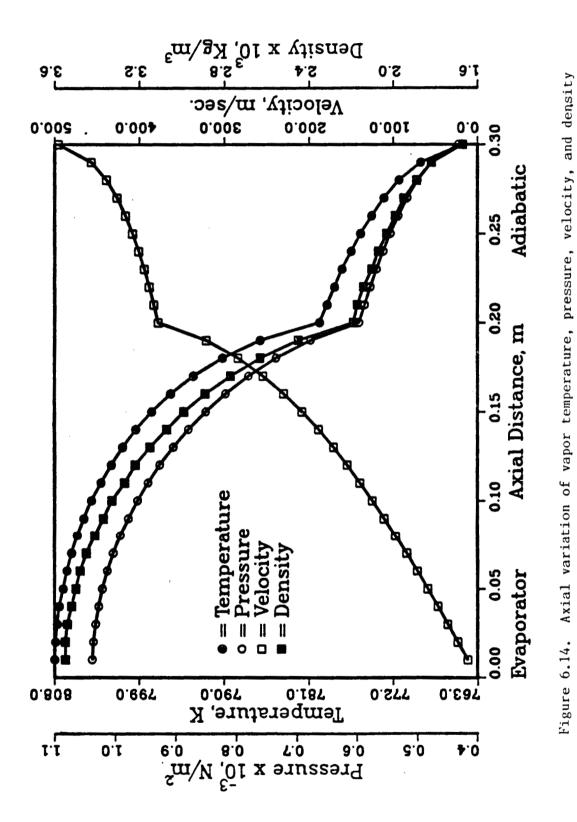
In the adiabatic section, there is no mass injection or extraction. Hence, pressure simply decreases due to friction, and the velocity increases very little. The contribution of the adiabatic section is the addition of pressure and temperature drops such that, for a high Mach number at the exit of the evaporator, maximum heat transfer rate is reduced considerably. Figure 6.14 shows this phenomenon. A heat input of 865 watts results in a Mach number of 0.7 at the exit of the evaporator. Then, the vapor is accelerated in the adiabatic section, so that velocity of the vapor approaches sonic velocity at the end of this section.

As expected, in the condenser section the pressure and temperature are partially recovered, but the degree of recovery is small due to the small vapor velocity and large friction loss in the longer condenser. Numerical results show that temperature recovery is only 0.6 K. Variations of temperature, pressure, and Mach number corresponding to six different heat fluxes at an operating temperature of 808 K are presented in Figures 6.15, 6.16, and 6.17, respectively. For heat input up to 200 watts, pressure recovery is not observed. This implies that the pressure drop due to friction in the condenser may exceed the value of the inertial contribution. However, total pressure drops are small, so that the vapor can be assumed isothermal.





at an operating temperature of 808 K.



Κ. at the sonic limit condition for an operating temperature of 808

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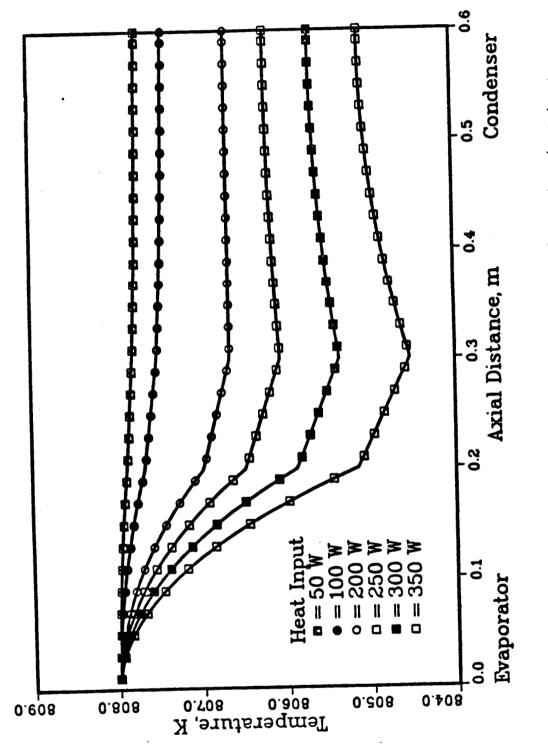


Figure 6.15. Axial variation of vapor temperature for various heat inputs.

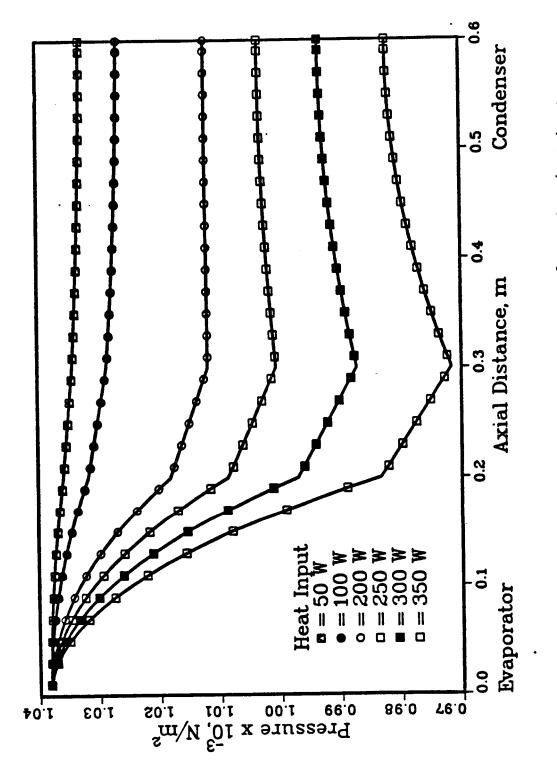
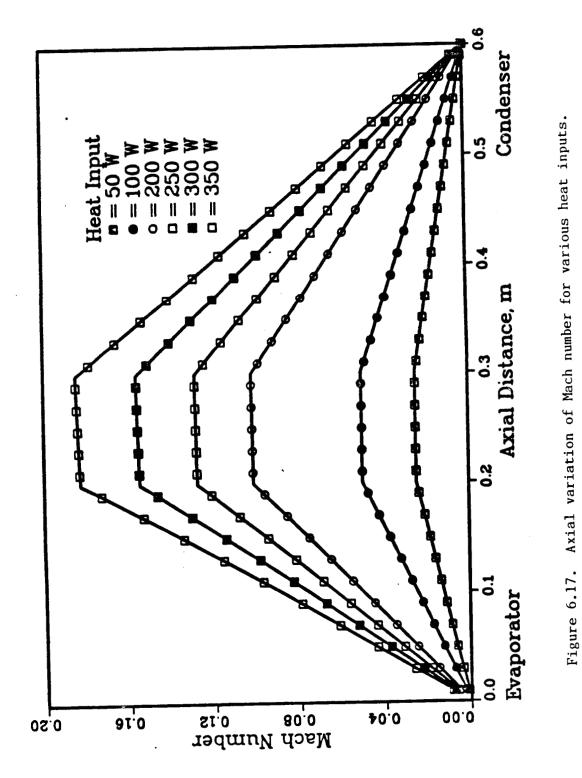


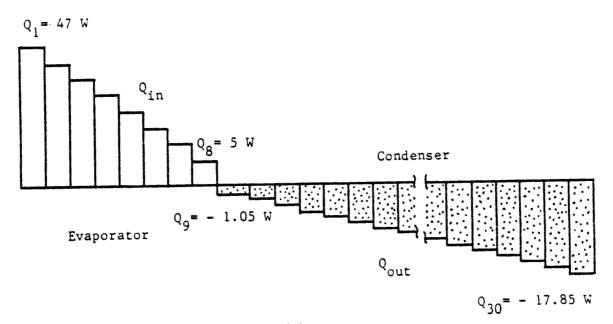
Figure 6.16. Axial variation of vapor pressure for various heat inputs.



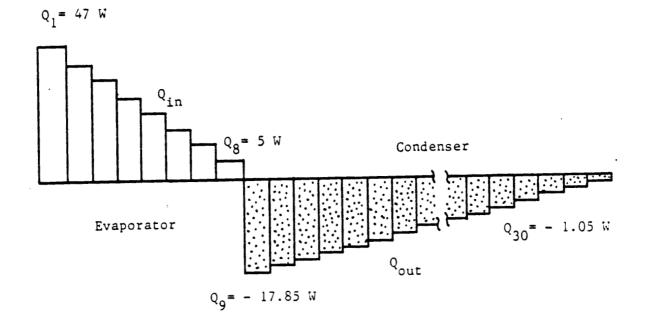
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Figure 6.18 shows the distribution of nonuniform heat flux on the evaporator length of 8 cm and condenser in another case studied numerically. Axial variations of vapor temperature, pressure, velocity and density corresponding to the distribution shown in Figure 6.18.a, are presented in Figure 6.19. At a short distance from the beginning of the condenser, the slight heat extraction causes that the axial variation of the vapor velocity is small. Thus, the friction effect in this region is dominant. The minimum temperature and pressure appear in the condenser, instead of at the exit of the evaporator. As heat extraction increases, the absolute value of axial variation of velocity increases and the vapor velocity decreases. The pressure is recovered gradually. In Figure 6.20, corresponding to the distribution shown in Figure 6.18.b, temperature and pressure are recovered immediately from the beginning of the condenser, due to large heat extraction. As expected, axial variations of temperature, pressure, velocity, and density depend on distribution of heat input.

In summary, the degree of pressure recovery depends mainly on the heat flux, operating temperature, and length of the condenser. The higher the heat flux, the lower the operating temperature and the shorter the condenser, the greater the pressure recovery. However, for this case, the pressure drop in the evaporator can be large enough so that the heat pipe is not entirely isothermal. Since experimental data is not available, quantitative comparison cannot be achieved. However, comparison of the general behavior of the present results with published data[15,18] gives qualitative agreement.

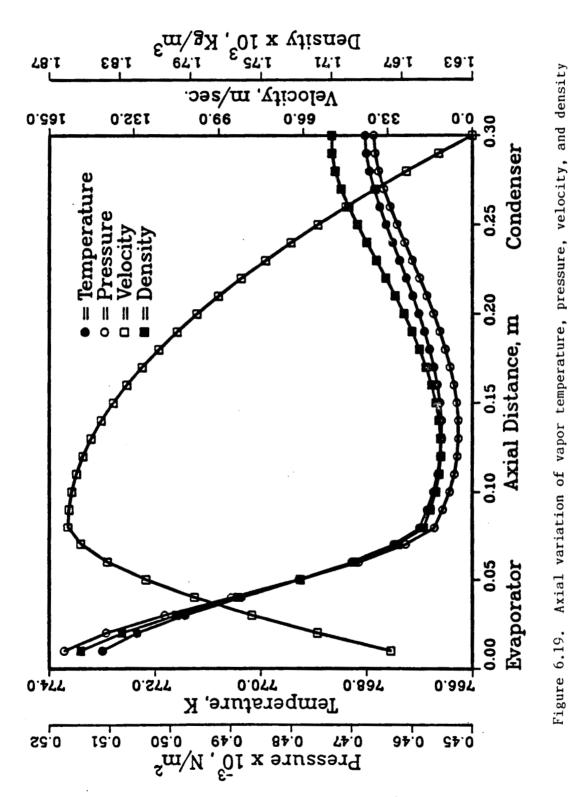


(a)



(b)

Figure 6.18. Distribution of heat input to the evaporator and condenser.



for nonuniform heat input shown in Figure 18.a.

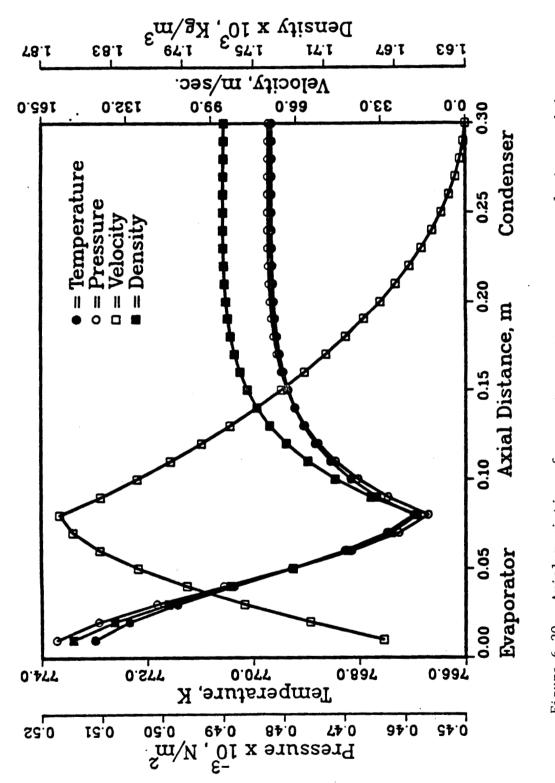


Figure 6.20. Axial variation of vapor temperature, pressure, velocity, and density

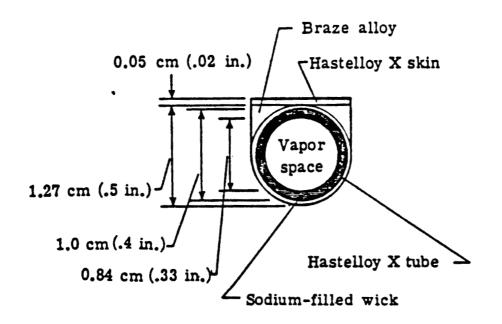
for nonuniform heat input shown in Figure 18.b.

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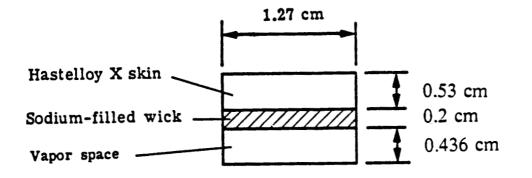
6.3 Heat pipe startup

To verify the model developed for heat pipe cooled leading edges, computed numerical results are compared to Camarda's experimental results[30]. The shape of the cross-section of Camarda's model is different from that of the model under consideration. However, the rectangular cross-section used in this research is modeled such that the cross-section areas occupied by the heat pipe shell, the capillary structure, and the vapor space are the same as for Camarda's experiment. A comparison of these two cross-sections is shown in Figure 6.21. The surface area where the heat flux is applied for the model is chosen to be identical to that of the experiment so that the width and length of the heat pipe are identical, but the thicknesses of the components of the two heat pipes are different. The thickness is much smaller than other dimensions, and the temperature drop at the cross-section is small compared to that in the axial direction, so the effects of the difference in thicknesses are minimal. Effects of energy storage and fusion of the working fluid in the heat pipe shell and the capillary structure are the same, and the effect of vapor flow dynamics may be simulated. Since the minimum dimension of the vapor space is different, due to the different thickness of the heat pipe, the transition temperature, which is evaluated based on the dimension of the vapor space, is not identical. However, this temperature determines the boundary condition at the liquid-vapor interface. Therefore, to simulate Camarda's case, the inner diameter of the circular heat pipe is used to calculate the transition temperature.

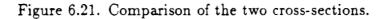
The material of each component used in the computation is the same as in the experiment, except that the braze alloy is assumed to be Hastelloy X to simplify computations in the heat pipe shell. Properties of the materials are varied with temperature during numerical calculation.



Camarda's heat pipe [30]



Computational model



Heat distribution on the heat pipe surface as used in the model is based on a normalized distribution[30] is shown in Figure 6.22 and heat input at the stagnation point is shown in Figure 6.23. Actual heat distribution due to aerodynamic heating is shown in Figure 6.24. In addition to aerodynamic heating, a radiation boundary condition is used to extract energy from the entire heat pipe surface, so that the net rate affects the heat pipe internal operation. The section which has a net positive rate is considered the evaporator, and the section with the net negative rate is the condenser.

Figure 6.25 shows the two-dimensional grid system, dimensions, boundary conditions, and materials used to represent a leading edge. It is assumed that the temperature of the heat pipe is initially the ambient temperature, which is below the melting point of the sodium working fluid. A temperature of 700 K is used for transition from free molecular to continuum flow.

An explicit method with a few implicit initial steps is used as the time stepping scheme. Until continuum flow is established in the vapor space, a constant time step of 10 seconds is used. This time is gradually decreased, due to the increasing heat input on the external surface.

Figure 6.26 shows a comparison of numerical and experimental results at various times. Since measured temperatures were not surface temperatures but the temperatures at intermediate points, numerical data at the interface between the heat pipe shell and capillary structure are used for comparison. Since most of the energy which is transferred by conduction through the heat pipe shell and capillary structure in the axial direction is added near the stagnation point, temperature at that point increases rapidly and a large temperature gradient is established in the heat pipe during startup. This implies that the heat pipe is not effective, due to the extremely small vapor density, for about the first 450 seconds. Temperatures in

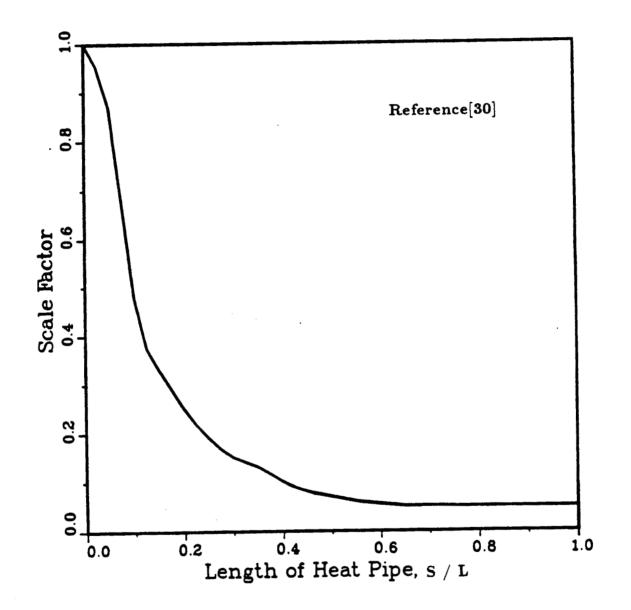
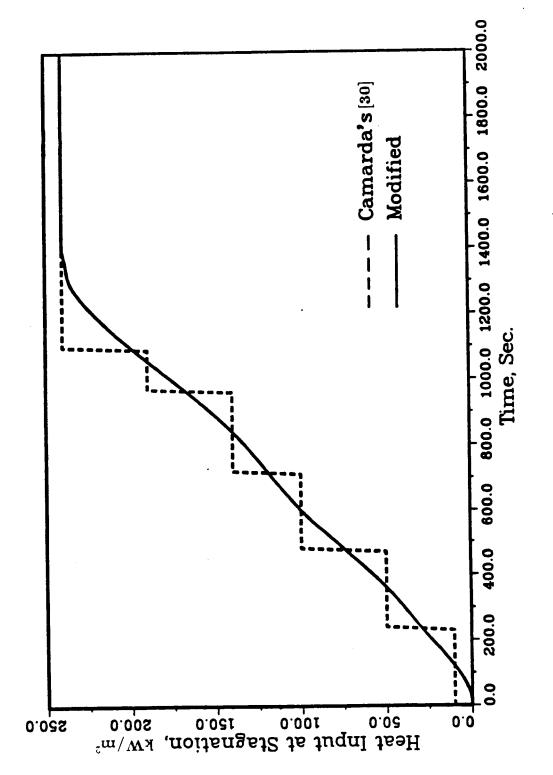
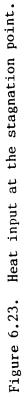


Figure 6.22. Normalized heating distribution.





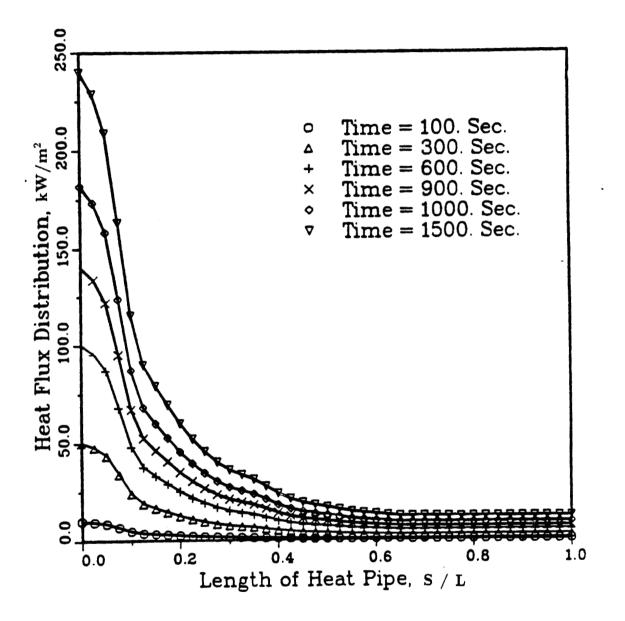
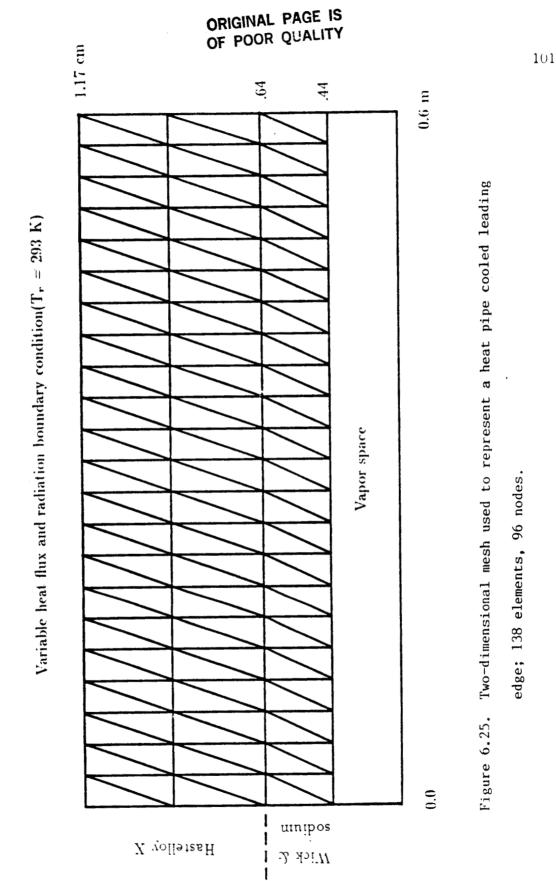
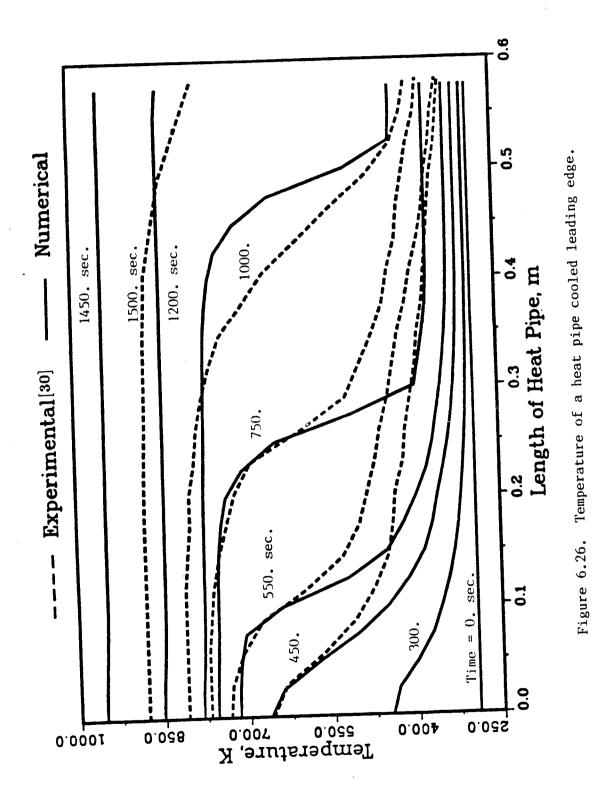


Figure 6.24. Heat flux distribution on a leading edge model.



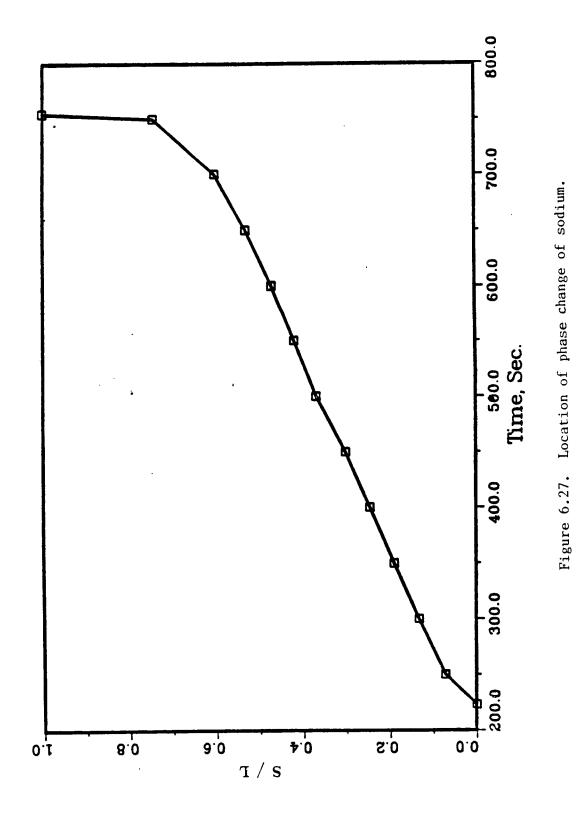
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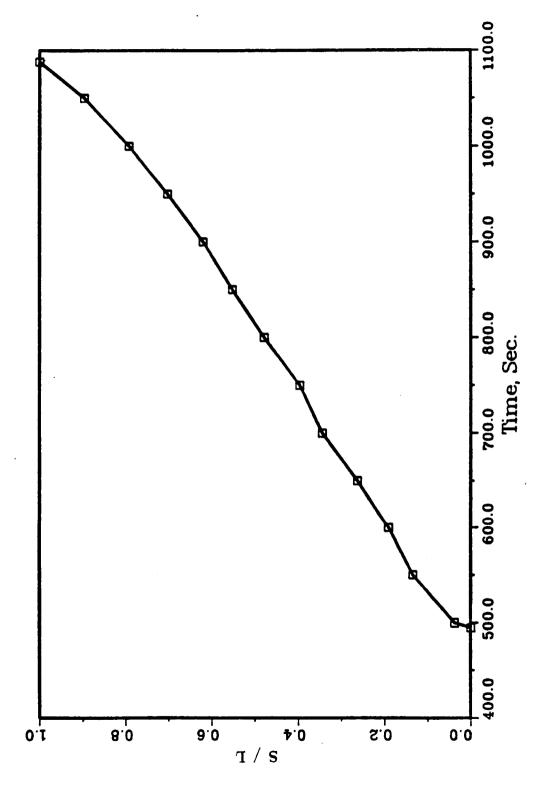
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the rest of the heat pipe are not much different from the initial condition. At 550 seconds, temperature at the stagnation point is greater than the transition temperature and the temperature gradient in the region adjacent to this point begins to decrease. This means that a continuum flow region is established in the vapor space, so that energy is mainly transported via latent heat transport. However, as shown in Figures 6.27 and 28, most of the working fluid is in the frozen state, and free molecule flow prevails in most of the vapor space. With time, the continuum flow region is expanded, so that at about 750 seconds, two-fifths of the device performs as a heat pipe. The rest of the heat pipe still behaves like a solid bar in which heat is transported only by conduction, even though the working fluid is melted over the entire length. Between the two flow regions, a large temperature gradient exists, where the continuum flow front is located. This front moves down toward the cool end of the heat pipe. At 1000 seconds, most of the heat pipe is active, except near the end of the condenser section. About 100 seconds later, continuum flow exists in the entire vapor space as shown in Figure 6.28. Until this moment, the sonic limit is encountered due to the large temperature gradient in the vapor space. Therefore, maximum heat transport in the vapor space is equal to the sonic limit. However, the expression used for the sonic limit excludes friction effects at the interface, so that the sonic limit is overestimated. Thus, at a time of 1000 seconds, temperature near the stagnation point is less than that found in experiments, and the continuum flow front is advanced further. After a time of 1200 seconds, the heat pipe becomes isothermal, but due to increasing heat input the temperature increases until the system reaches a steady state at a later time.

Figure 6.29 shows temperature history of the heat pipe at three different locations in the axial direction. When a part of the vapor space has free molecular flow, most of the heat input is used to heat up the condenser section, so that the temper-







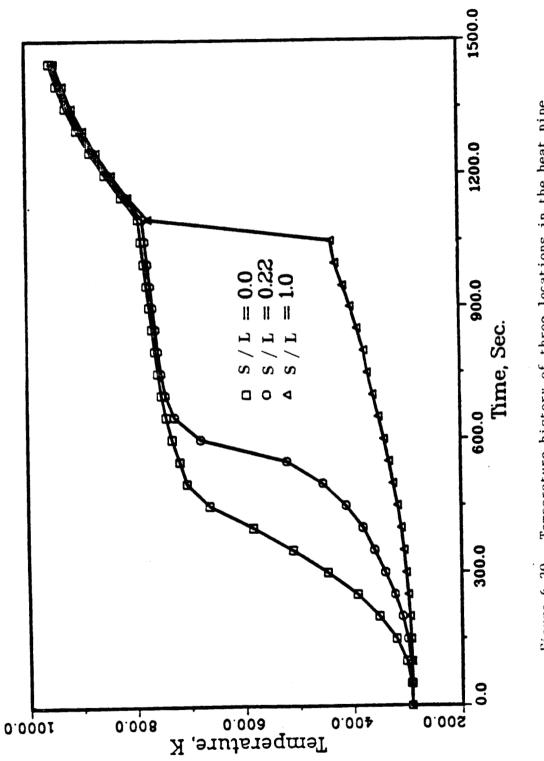
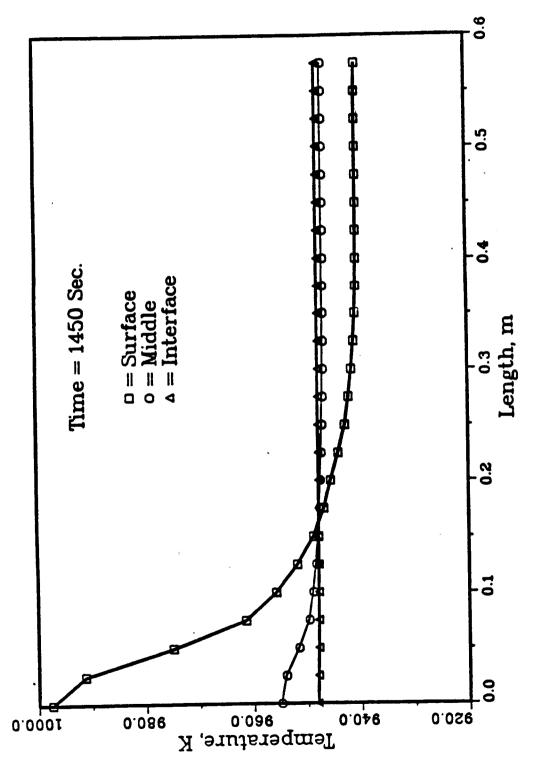


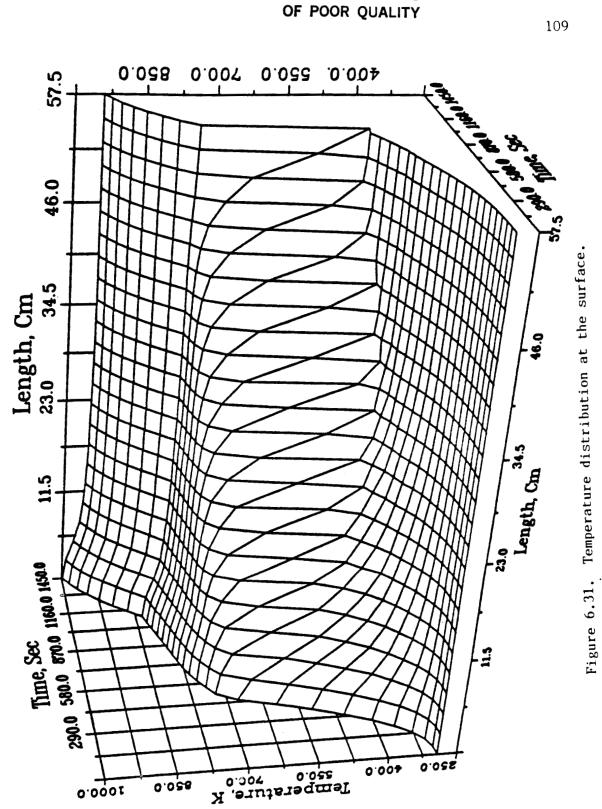
Figure 6.29. Temperature history of three locations in the heat pipe.

ature increases very slowly. As the continuum flow front approaches the end of the heat pipe, the remainder of the vapor space quickly reaches continuum flow. After the entire heat pipe is active, temperatures at all axial locations increase relatively fast, and then tend to change slowly as steady state is reached. Experimental results exhibited steady state at a time of 1500 seconds where the maximum temperature was 883 K. However, the numerical results yield a maximum temperature of 948 K at 1450 seconds. The temperature at 1500 seconds can be estimated to be 958 K. according to the slope of temperature with time. This temperature difference of 77 K may result from using a different emissivity for the heat pipe surface, neglecting natural convection in the numerical calculation, and additional heat loss from the inside surface and end of heat pipe through insulation. These effects increase with temperature. The leading edge test set was coated with a high emissivity ceramic paint to improve heat rejection by radiation, but the emissivity was not specified. For numerical calculations an emissivity of 0.8 is used. The heat loss due to convection is estimated by using the approximation of a horizontal heated plate facing upward. Estimation shows that the operating temperature drop of 35 K may be possible due to convection. Increasing emissivity from 0.8 to 0.9 would reduce the outside temperature about 30 K.

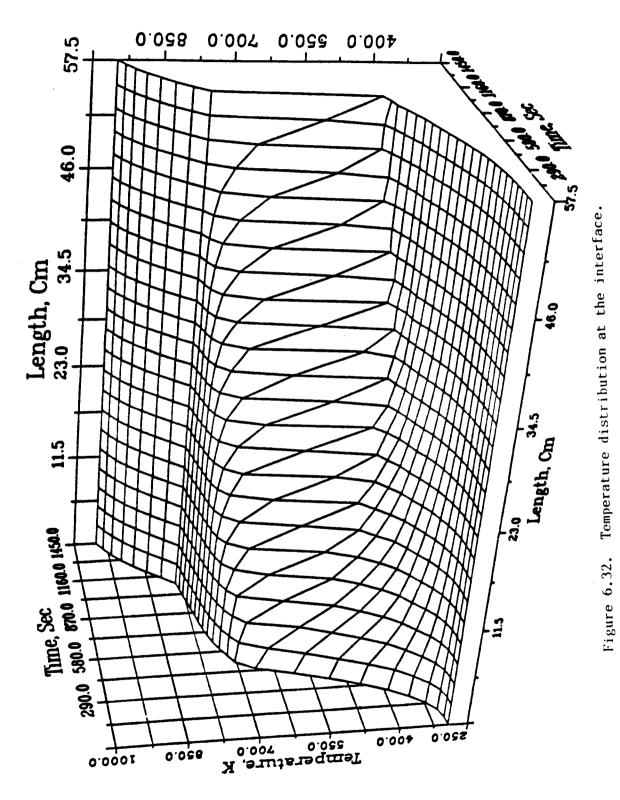
Figure 6.30 shows the temperature distributions at different wall locations. Near the stagnation point, a large temperature difference exists due to intensive heat input while for the rest of the heat pipe the difference is only about 15 K. The figure shows the length of the evaporator, which is not specified initially. Out to a length of about 15 cm, the temperature at the surface is greater than that of the interface, so that this region may be assumed to be the evaporator, and the rest of the length is the condenser section. Figures 6.31 and 32 show detailed temperature distributions obtained by numerical calculation, along the length at the external







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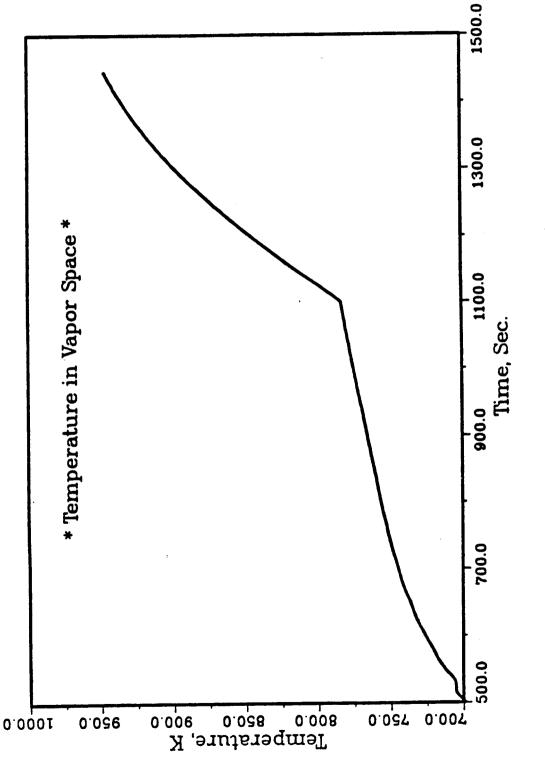
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surface and interface between shell and wick structure. respectively, for different times.

Figure 6.33 shows the variation of the average vapor temperature during startup. Vapor temperature increases corresponding to increasing heat flux. The vapor temperature increases very slowly because most of the heat added in the evaporator is extracted at the interface of the condenser to heat up the adjacent cold zone until the entire vapor space is in the continuum flow regime. Then the vapor temperature rises to approach steady state. Figure 6.34 shows the vapor flow dynamics at a time of 1140 seconds. Even though the sonic limit is not encountered, the velocity of the vapor is about 180 m/s. The temperature drop in the vapor space is about 60 K and pressure is not recovered due to the effect of friction at the interface, so that thermal resistance in the vapor space should be considered.

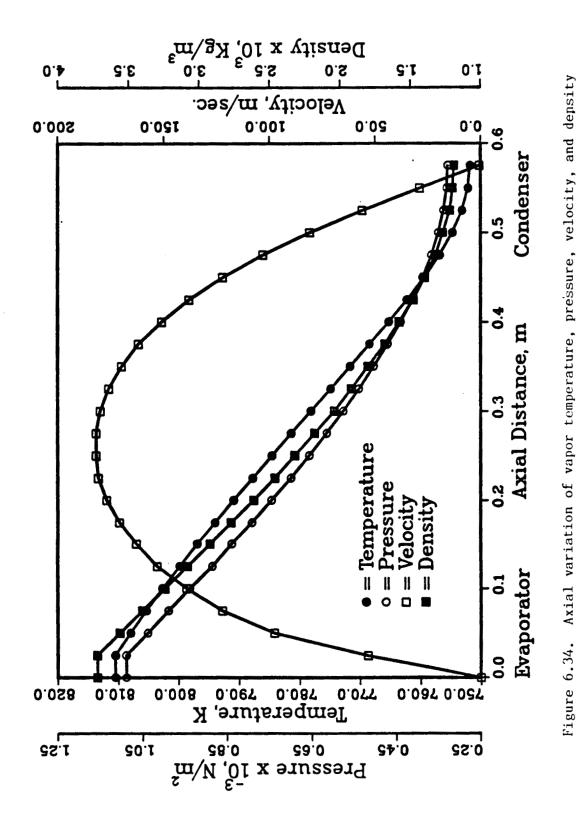
Even though numerical results do not exactly match experimental results, due to the difference in configuration, material properties and boundary conditions, it is clear that the model does approximately predict the correct startup time and temperature distribution. It is important to note that heat inputs for the model were based on aerodynamic heating computations, which were only approximated in the experiments.

To show the effectiveness of the heat pipe for cooling a leading edge, numerical calculations were executed for the same example problem, except that an adiabatic boundary condition is applied to the liquid-vapor interface during the entire startup. The development of large axial temperature gradients is similar for the cooled and uncooled leading edges, due to the free molecular condition in the entire vapor space during the initial transient heating. However, beyond this stage, peak temperatures are reduced, and temperature gradients disappear when the heat pipe is fully active. Figure 6.35 shows temperature distributions for both cases at a time of 1450 seconds.

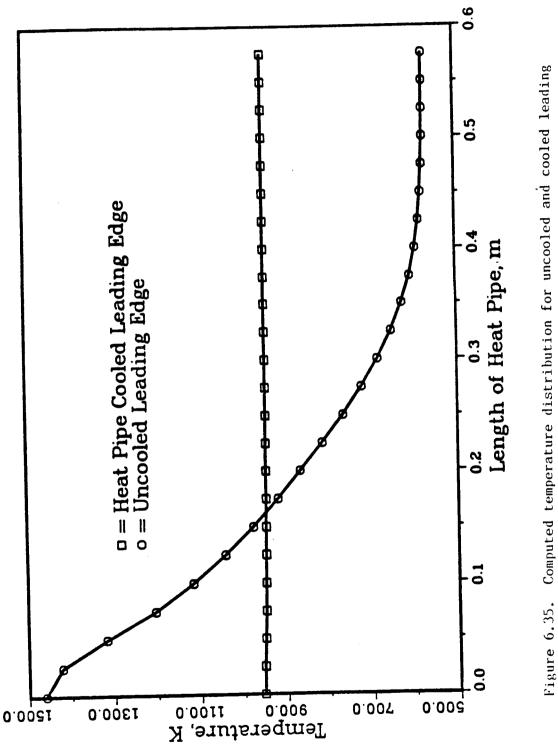


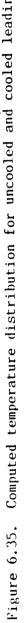


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at t = 1140 sec..





edge; t = 1450 sec..

It is clear that the heat pipe is very effective for reducing peak temperatures near the leading edge and eliminating axial temperature gradients.

6.4 Simulation of reentry heating environment

After the model components were checked against published data, a spacecraft reentry heating environment[30] was simulated to show capability of the present model. The same rectangular cross-section and material of each component were used. Heat input at the stagnation point is much greater than that for the previous test, as shown in Figure 6.36, so that the heating distribution on the heat pipe surface is also much greater as shown in Figure 6.37. Maximum heat flux at the stagnation point is 390 kW/m². A triangular element is used to fit the curved leading edge shape. Figure 6.38 shows the two-dimensional grid system used to represent the leading edge. In order to reduce computational time a relatively small number of elements and nodes was used. Heat input near the stagnation point is very large so that small size elements are used near the stagnation point and large size elements are employed for the rest of the heat pipe. The same numerical procedures as previously described were employed except that an initial time step of 5 seconds was used.

Figure 6.39 shows temperature distributions along the heat pipe from the initial condition to 700 seconds. General behavior is similar to previous results, but due to high heat fluxes the continuum flow region is established early in the vapor space at 230 seconds. Also, as shown in Figures 6.40 and 41, most of the working fluid which is initially in the frozen state is melted at about 350 seconds and the entire vapor space is occupied by continuum flow at 460 seconds. As expected, less time is consumed for the entire heat pipe to become active. At a time of 500 seconds, the heat pipe is nearly isothermal with position, but the temperature increases

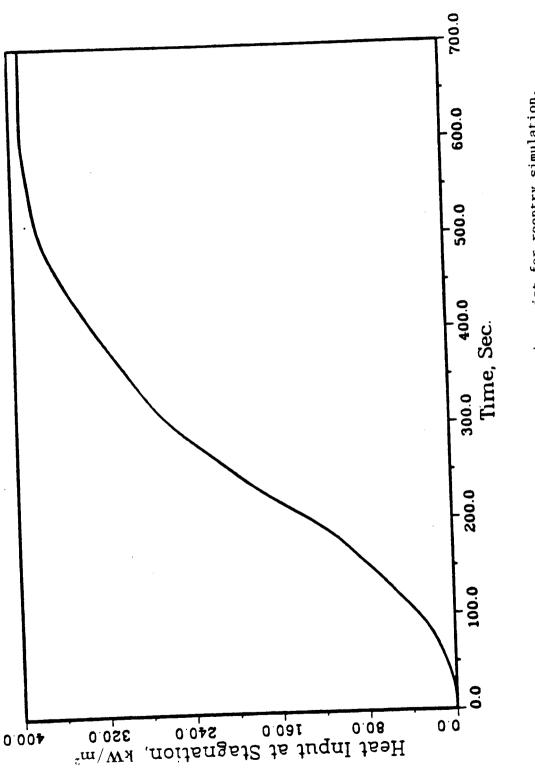


Figure 6.36. Heat input at the stagnation point for reentry simulation.

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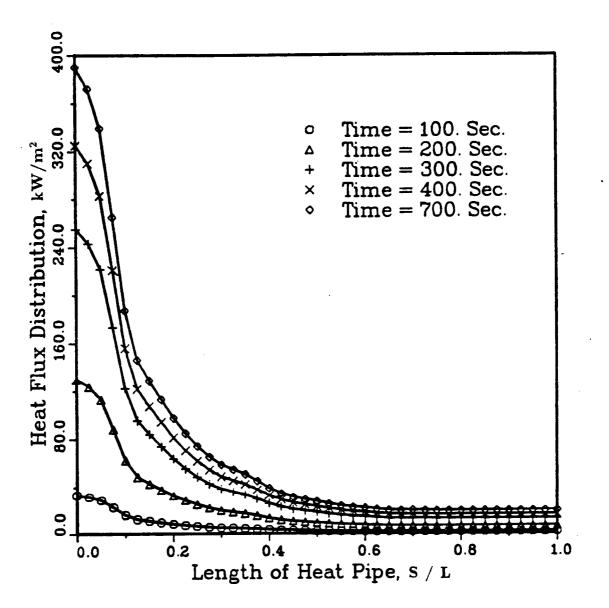
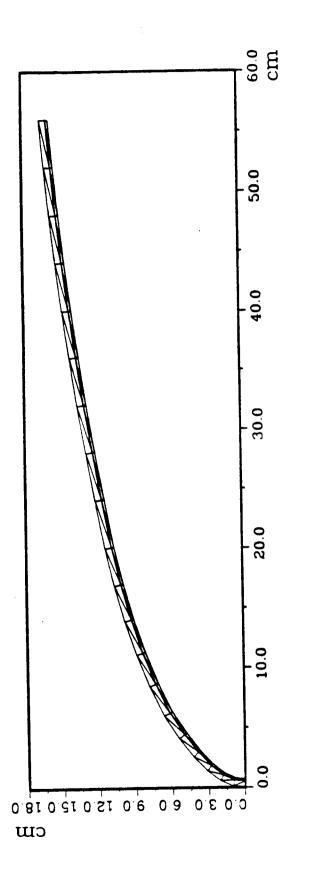
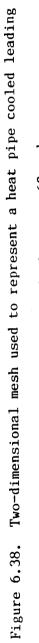


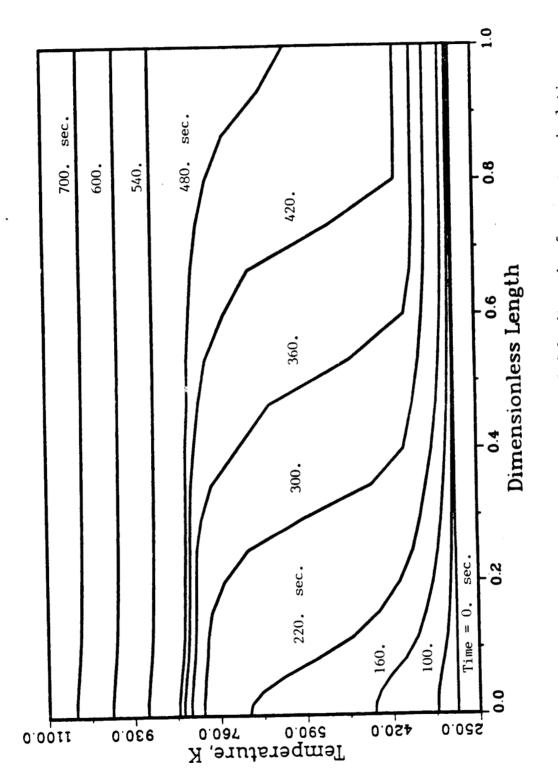
Figure 6.37. Heat flux distribution on a leading edge model for reentry simulation.



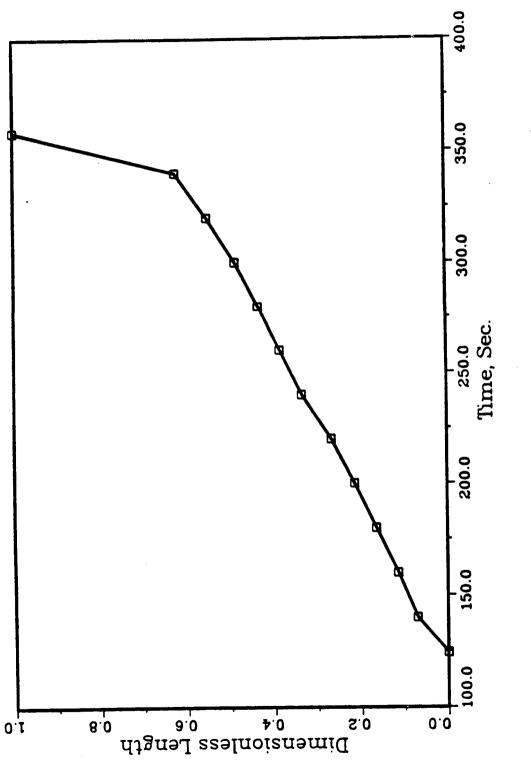


edge for reentry simulation; 80 elements, 63 nodes.

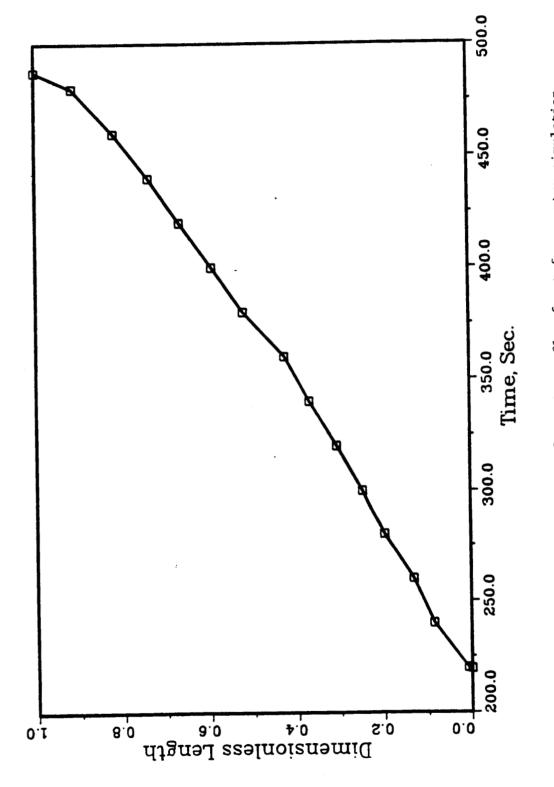
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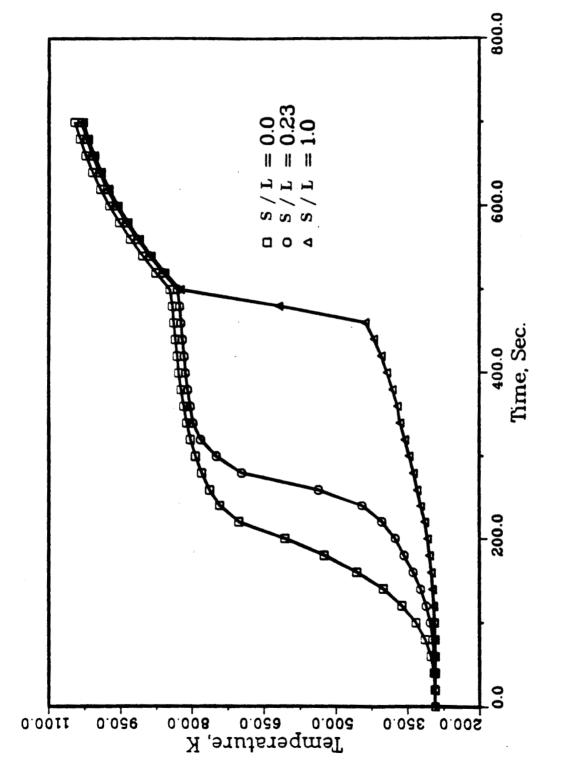




uniformly with time until a maximum temperature of 1040 K is achieved at a time of 700 seconds. Figure 6.42 shows the temperature histories of the heat pipe at the stagnation point, end of the heat pipe, and a short distance away from the stagnation point. After the continuum flow region is established, it takes about 280 seconds for the entire vapor space to reach continuum flow. Also Figures 6.43 and 44 show temperature distributions along the length at an interface between shell and wick and at the liquid-vapor interface respectively, from initial time to 700 seconds. Temperature distributions at these sections are shown on Figure 6.45. A maximum temperature difference of 90 K is observed owing to the large heat input at the stagnation point while small differences exist for the rest of the heat pipe.

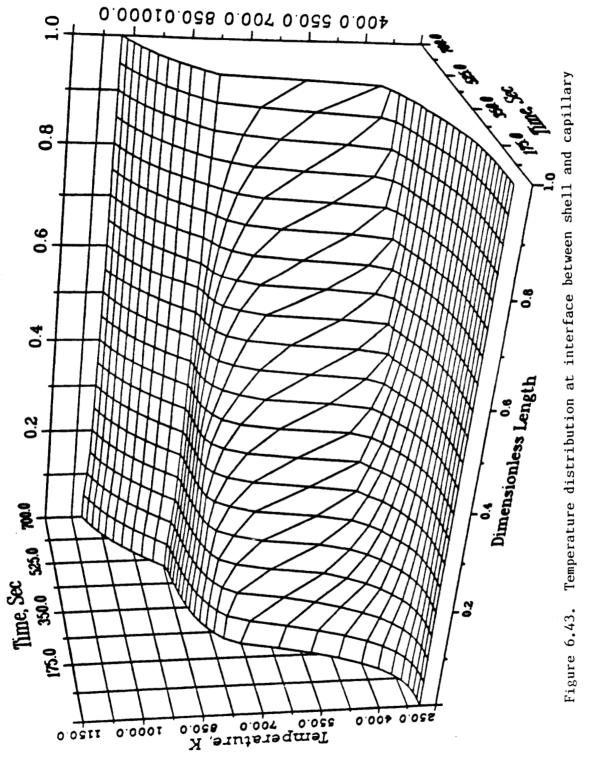
Variation of the average vapor temperature as shown in Figure 6.46 is similar to that for low heat input. When the entire vapor space reaches the continuum flow regime, vapor temperature increases relatively rapidly and then again slows down to approach steady state. Figure 6.47 shows behavior of the vapor flow at 503 seconds. A temperature drop of 50 K is observed along the length and pressure is not recovered. Since velocity is still large and heat extracted at the beginning of the condenser is small, the effect of friction at the interface is greater than that of inertia. Thus, a maximum velocity of the vapor does not occur at the exit of the evaporator but in the condenser.

As expected, behavior of the heat pipe is similar to the previous results presented except that a higher steady state temperature is achieved and startup is faster due to greater heat input. Figure 6.48 shows temperature distributions for a leading edge with heat pipe cooling and without cooling at 700 seconds into reentry. The heat pipe reduces peak temperature by the 600 K near the stagnation point and the leading edge becomes nearly isothermal. Again, it is obvious that the heat pipe is an effective device for cooling leading edges during reentry.



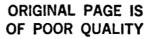
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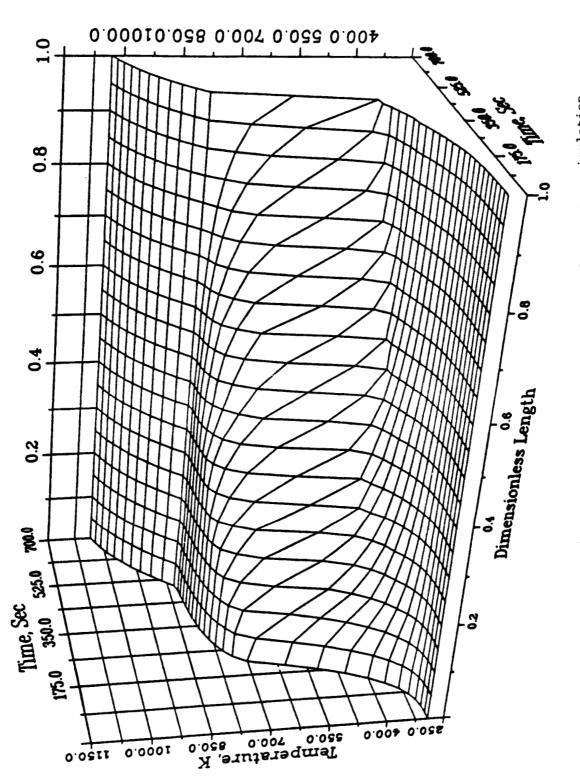
Figure 6.42. Temperature history of three locations in the heat pipe for reentry simulation.



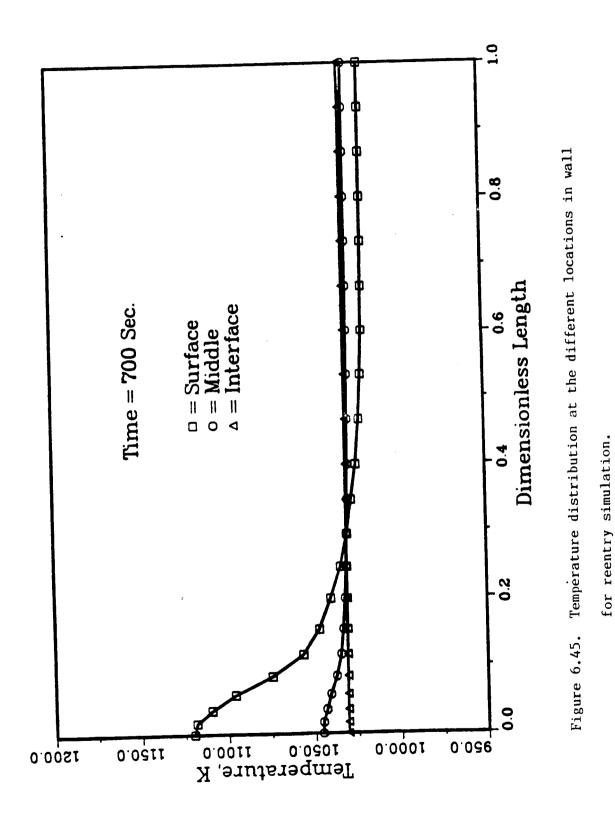


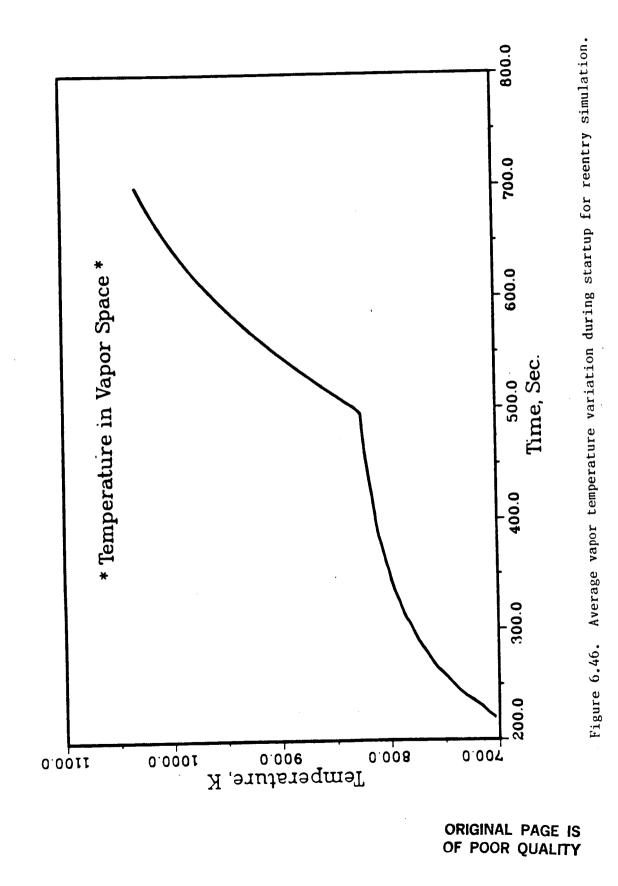
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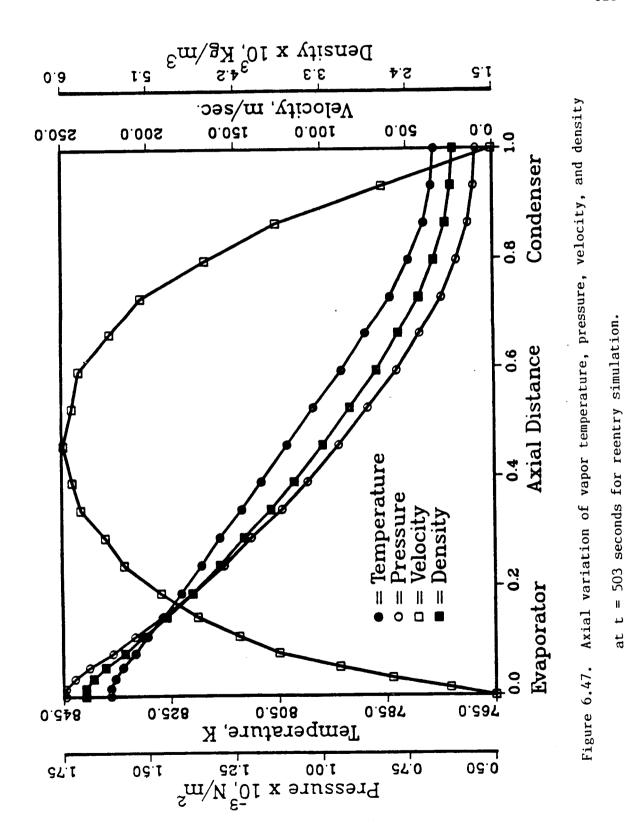


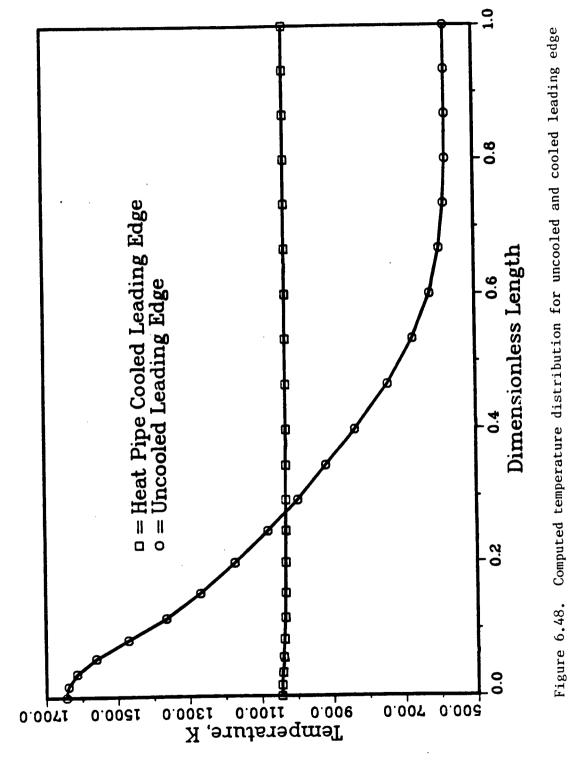


Temperature distribution at the interface for reentry simulation. Figure 6.44.











of reentry simulation; t = 700 seconds.

CHAPTER VII

CONCLUSIONS AND RECOMMENDATIONS

7.1 Conclusions

This study has been concerned with startup behavior of heat pipes from the frozen state. A mathematical model and associated finite element computational code were developed. Results were compared with published data and a reentry heating environment was simulated to show capability of the model developed. The model approximately predicts the correct startup time and temperature distribution for the reentry problem. Numerical results computed for heat pipe cooled and uncooled leading edges show development of the large chordwise temperature gradients during the initial heating for both cases. After a part of the heat pipe is active, the effectiveness of using the heat pipe is shown clearly. In addition, the following conclusions are derived from numerical results.

- 1. Temperature near the stagnation point increases rapidly and a large temperature gradient is observed due to the extremely small vapor density during the beginning of startup. Thus, critical design consideration should be given for this period.
- 2. During the second phase of startup, the sonic vapor limit is encountered due to the large temperature gradient in the vapor space, and temperature increases slowly.
- 3. When the sonic limit is not present, temperature first increases rapidly and then more slowly as steady state is approached.
- 4. A large temperature difference exists at all times in the wall and capillary

structure near the stagnation point due to large heat input at this point.

- 5. Heat pipe cooling of hypersonic wing structures greatly reduces temperature gradients on the skin.
- 6. Startup behavior of heat pipe cooled leading edges is similar for relatively large and relatively small heat inputs but large inputs cause startup to occur more quickly.

7.2 Recommendations

It is recommended that models and numerical techniques be improved so that more accurate predictions can be made and so that computer costs can be reduced.

- During startup, the working fluid is only partially melted so that some of the vapor may condense on the surface of the frozen working substance. Drying and rewetting might be incorporated into the model instead of assuming a saturated wick structure.
- 2. For a better prediction of the vapor flow dynamics, one-dimensional, transient and compressible equations might be developed to take into account supersonic flow of vapor.
- 3. A better numerical scheme is needed to couple the effect of vapor flow dynamics to governing equations for the heat pipe shell and wick structure.
- 4. To handle realistic operating conditions, the effects of gravity might be included in the mathematical model.
- 5. The model should be made fully three dimensional.

6. The computer program should be made user friendly.

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APPENDICES

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APPENDIX A

ELEMENT MATRICES

A.1 Interpolation function

The spatial domain is discretized into three-node, linear, triangular elements as shown in Figure A.1, since an assemblage of triangles can always represent a two-dimensional domain of any shape. The shape functions are derived by using natural coordinates which range between zero and unity within the element, and whose variation between nodes is linear. Use of these coordinates is advantageous in evaluating the integrals in the element equations[55].

If L_1 , L_2 , and L_3 are selected as the natural coordinates, the location of the point P_o within the element may be expressed by the following equations

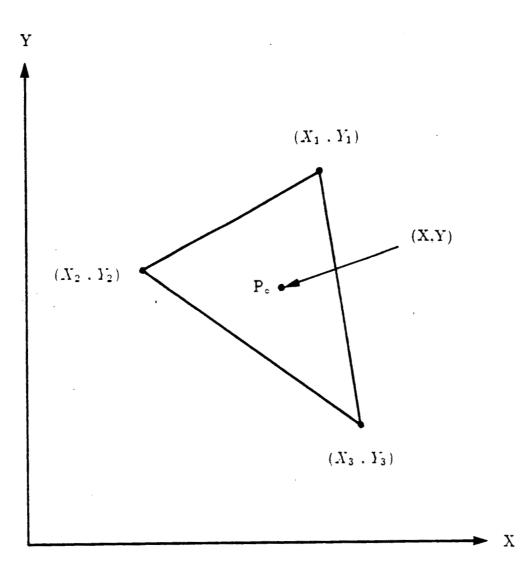
$$X = L_1 X_1 + L_2 X_2 + L_3 X_3 \tag{A.1}$$

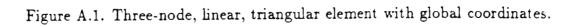
$$Y = L_1 Y_1 + L_2 Y_2 + L_3 Y_3 \tag{A.2}$$

$$1 = L_1 + L_2 + L_3 \tag{A.3}$$

From the equations above, natural coordinates are written in terms of cartesian coordinates.

$$L_1 = \frac{1}{2\triangle^{(e)}} (a_1 + b_1 X + c_1 Y) \tag{A.4}$$





$$L_2 = \frac{1}{2\Delta^{(e)}} (a_2 + b_2 X + c_2 Y) \tag{A.5}$$

$$L_{3} = \frac{1}{2\triangle^{(e)}} (a_{3} + b_{3}X + c_{3}Y)$$
 (A.6)

where

 $a_{1} = X_{2}Y_{3} - Y_{3}Y_{2}, \quad b_{1} = Y_{2} - Y_{3}, \quad c_{1} = X_{3} - X_{2}$ $a_{2} = X_{3}Y_{1} - Y_{1}Y_{3}, \quad b_{2} = Y_{3} - Y_{1}, \quad c_{2} = X_{1} - X_{3}$ $a_{3} = X_{1}Y_{2} - Y_{1}Y_{2}, \quad b_{3} = Y_{1} - Y_{2}, \quad c_{3} = X_{2} - X_{1}$ $2\triangle^{(e)} = \begin{vmatrix} 1 & X_{1} & Y_{1} \\ 1 & X_{2} & Y_{2} \\ 1 & X_{3} & Y_{3} \end{vmatrix}$

These natural coordinates L_1 , L_2 , and L_3 are the linear interpolation functions for a triangle, that is, $N_i = L_i$ for the linear triangle. The interpolation functions are expressed as follows:

$$N_{i} = \frac{1}{2\triangle^{(e)}} (a_{i} + b_{i}X + c_{i}Y) \qquad i = 1, 2, 3 \qquad (A.7)$$

$$\frac{\partial N_i}{\partial X} = \frac{b_i}{2\triangle^{(e)}} \tag{A.8}$$

$$\frac{\partial N_i}{\partial Y} = \frac{c_i}{2\triangle^{(e)}} \tag{A.9}$$

A.2 Two-dimensional element matrices

Thermal conductivity and specific heat are assumed to be constant within an element and are evaluated by using the average temperature. The $[K_c]$ matrices are then expressed by

$$[K_{c}] = \int_{R^{(\epsilon)}} K\left(\frac{\partial N_{i}}{\partial X}\frac{\partial N_{j}}{\partial Y} + \frac{\partial N_{i}}{\partial Y}\frac{\partial N_{j}}{\partial Y}\right) dX dY$$

$$= K\left(\frac{b_{i}}{2\triangle^{(\epsilon)}}\frac{b_{j}}{2\triangle^{(\epsilon)}} + \frac{c_{i}}{2\triangle^{(\epsilon)}}\frac{c_{j}}{2\triangle^{(\epsilon)}}\right)$$

$$= \frac{K}{4(\triangle^{(\epsilon)})^{2}}(b_{i}b_{j} + c_{i}c_{j})$$

(A.10)

where

$$b_i b_j + c_i c_j = \begin{pmatrix} b_1^2 + c_1^2 & b_1 b_2 + c_1 c_2 & b_1 b_3 + c_1 c_3 \\ b_2 b_1 + c_1 c_2 & b_2^2 + c_2^2 & b_2 b_3 + c_2 c_3 \\ b_3 b_1 + c_3 c_1 & b_3 b_2 + c_3 c_2 & b_3^2 + c_3^2 \end{pmatrix}$$

For the element which is not involved in phase change, the [C] matrices are given by

$$\begin{split} [C] &= \int_{R^{(\epsilon)}} CN_i N_j dX dY \\ &= C \int_{R^{(\epsilon)}} \begin{pmatrix} N_1^2 & N_1 N_2 & N_1 N_3 \\ N_2 N_1 & N_2^2 & N_2 N_3 \\ N_3 N_1 & N_2 N_3 & N_3^2 \end{pmatrix} \qquad (a.11) \\ &= C \triangle^{(\epsilon)} \begin{pmatrix} 1/6 & 1/12 & 1/12 \\ 1/12 & 1/6 & 1/12 \\ 1/12 & 1/12 & 1/6 \end{pmatrix} \end{split}$$

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For the matrix contributions of an element having sides coincident with the external boundary of the solution domain, it is assumed that the convective heat transfer coefficient, h_{cr} , heat flux, \ddot{Q} , and radiation coefficient, β_r , are constant along the side of an element. The shape functions for the boundary segment have the same expression of Equation(A.7). For the side of the element shown in Figure A.1 between nodes 1 and 2, coincident with external boundary of the solution domain, the matrix contributions are written as follows:

$$\begin{split} [K_h] &= \int_{A_3} h_{cr} N_i N_j dS \\ &= h_{cr} \int_{A_3} \begin{pmatrix} N_1^2 & N_1 N_2 & 0 \\ N_2 N_1 & N_2^2 & 0 \\ 0 & 0 & 0 \end{pmatrix} \\ &= \frac{h_{cr} \ell_{12}}{6} \begin{pmatrix} 2 & 1 & 0 \\ 1 & 2 & 0 \\ 0 & 0 & 0 \end{pmatrix} \end{split}$$
(A.12)

$$[K_r] = \int_{A_4} \beta_r N_i N_j dS$$

= $\frac{\beta_r \ell_{12}}{6} \begin{pmatrix} 2 & 1 & 0 \\ 1 & 2 & 0 \\ 0 & 0 & 0 \end{pmatrix}$ (A.13)

where ℓ_{12} is the length of the side between nodes 1 nad 2 of the element. Also, the column vectors contributions from surface integrals are

$$\begin{split} [F_q] &= \int_{A_2} \ddot{Q} N_i dS \\ &= \ddot{Q} \int_{A_2} \begin{pmatrix} N_1 \\ N_2 \\ 0 \end{pmatrix} dS \\ &= \frac{\ddot{Q} \ell_{12}}{2} \begin{pmatrix} 1 \\ 1 \\ 0 \end{pmatrix} \end{split} \tag{A.14}$$

$$[F_{h}] = \int_{A_{s}} h_{cr} N_{i} T_{cr} dS$$

$$= h_{cr} T_{cr} \int_{A_{s}} \begin{pmatrix} N_{1} \\ N_{2} \\ 0 \end{pmatrix} dS$$

$$= \frac{h_{cr} T_{cr} \ell_{12}}{2} \begin{pmatrix} 1 \\ 1 \\ 0 \end{pmatrix}$$
 (A.15)

$$[F_r] = \int_{A_4} \beta_r N_i T_r dS$$

= $\beta_r T_r \int_{A_4} \begin{pmatrix} N_1 \\ N_2 \\ 0 \end{pmatrix} dS$
= $\frac{\beta_r T_r \ell_{12}}{2} \begin{pmatrix} 1 \\ 1 \\ 0 \end{pmatrix}$ (A.16)

APPENDIX B

LISTING OF THE COMPUTER PROGRAM

```
PROGRAM HPMAIN(INPUT,OUTPUT,TAPE3=INPUT,TAPE4=OUTPUT,HPDAT,
&TAPE5=HPDAT,JANG,TAPE6=JANG,DATA,TAPE7=DATA,RESTA,TAPE8=RESTA,
&DATAV,TAPE2=DATAV)
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C * This program solves the startup and transient performance of heat
C * pipe with metallic working fluids by using a finite element method. *
                                                                        *
С*
     The temperature is predicted from two-dimensional and transient
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 * heat conduction equation, which incorporates the effects of the
                                                                       *
 * phase change process in an expression for the volumetric heat cap-
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                                                                       *
C * pacity by using the enthalpy method. The Galerkin weighted residual
C * method is used to drive finite element formulations.
                                                                        *
C *
     The flow dynamics of the vapor are described by one-D, compress-
                                                                        Ϋ́¢
С
 * ible and laminar momentum and energy equations. In one-D model,
 * the variation of velocity at cross section, friction at the liquid- st
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                                                                        de.
C * vapor interface, and quality of vapor are considered.
                                                                        *
С*
      Five one-D governing differential equations for vapor are solved
                                                                        *
C * by subroutine DVERK which uses Runge-Kutta method. The specified
                                                                        *
C * temperature, heat flux, convective, and radiation boundary
                                                                        Ŕ
C * conditions are applicable. This program can be used to solve pure
                                                                        te
C * conduction or phase change problem alone.
                                                                        *
С *
      Implicit or explicit time stepping schemes are used. Since
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  * for first few time steps. For this purpose, set proper number for
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  * variable NTS.
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      Grid system can be generated by program HPGRNW. Input data file
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 * for program HPMAIN consists of output data file of HPGRNW and
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    general data which specifies some general conditions.
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      To obtain, compile and run program HPMAIN :
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         C, DATAV (Vapor temperature for every time step)
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С
                            ; Dec. 9, 1985 by Jong Hoon Jang
                Created
  **
                Last update ; Dec. 05, 1987 by Jong Hoon Jang
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С
```

FORMAT ('HOW OFTEN DO YOU WANT TO PRINT, EX = 1,3..?') 14 READ(3,*) NFREQ CREAD GENERAL DATA..... READ(5,*) TEMPI, TMEL, TSTAR, DETP, HRSL, DIST, WIDTH TEMPI = INITIAL TEMPERATURE (TEMP.) [K] С TMEL = MELTING TEMP[K]. С TSTAR= TRANSIENT TEMP. OF VAPOR [K] С DETP = TEMP. DIFFERENCE FROM TMEL[K] С HRSL = LATENT HEAT OF MELTING (ALWAYS POSITIVE) [J/KG] С DIST = HEIGHT OF VAPOR SPACE[M] С WIDTH = ELEMENT THICKNESS[M] С TLENG = TOTAL LENGTH OF HEAT PIPE[M] С READ(5,*) BETA, DELT1, DELTP, MM, NLEM, NTS, NFLUX, NRAD BETA = 1 FOR FULLY IMPLICIT, .5 FOR CRANK-NIHOLSON С DELT1 = TIME DIFFERENCE FOR FIRST TIME STEP[SEC.] C DELT - TIME DIFFERENCE BETWEEN EACH TIME STEP[SEC.] С TOTAL NUMBER OF ITERATION FOR EACH TIME STEP С MM = TOTAL NUMBER OF TIME STEP С MN NLEM = 1 FOR LEMMON METHOD OF ENTHALPY С 2 FOR DEL GUIDICE METHOD OF ENTHALPY C NFLUX = 1. HEAT FLUX DEPEND ON TIME AND CALL FLUXD С NRAD = 1 RADIATION BOUNDARY CONDITION APPLIED. С = NUMBER OF STEPS OF IMPLICIT NTS С CREAD ELEMENT DATA PROVIDED FROM GRID2D..... READ(5,*) IOPT, LBW, NEL, NP, ICORD, IPROP, INRG, NDIM, IFIN IOPT = 0 FOR STEADY STATE, 1 FOR TRANSIENT С = BANDWIDTH QUANTITY С LBW = NUMBER OF ELEMENTS C NEL С NP = NUMBER OF NODES ICORD = 0 FOR RECTANGULAR COORDINATES С 1 FOR CYLINDRICAL COORDINATES С IPROP = 0 FOR UNIFORM PROPERTIES THROUGHOUT C 1 FOR NON-UNIFORM PROPERTIES С INRG = NUMBER OF REGION С NDIM = 1 FOR ONE DIMENSIONAL PROBLEM С 2 FOR TWO DIMENSIONAL PROBLEM С IFIN = 0, NOT A FIN PROBLEM С 1. A FIN PROBLEM С READ(5,*) (IRGN(I), NROW(I), NCOL(I), I=1, INRG) NCOL = NUMBER OF COLUMNS С ORIGINAL PAGE IS NROW = NUMBER OF ROW С OF POOR QUALITY I = 1INRG = INRG/2NCOLT = 0

C....DECLARATION..... COMMON/MATG/ AMC(140,151), RM(140), THETA(140), FLD(140), AM(140,140), BM(140), CIJ(3,3), KIJ(3,3) 3 /TEPS/ TEMPR, TEMPI, TMEL, DETP, DELTD, TEMPG1(140), THETAG(140), å THETAF (140), THETAO (140), THETTO (140), THETAB (70), TEMPD 8 å /PROC/ HRSL, ALPAR, DIST, BI, KREF, ROUR, SPECR, EMIS, HTC (140, 3), & BOLT, VOLSPR, WIDTH, QE (140, 3), NRESIS, RESIS, IX å /ELMT/ NEL, NP, GND(140, 3), B(140, 3), C(140, 3), EAREA(140), NPP1, & IES(140,2),ESL(140,3),BETA,XC(140,3),YC(140,3),DEFO, 8 NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70)& /INOUT/TEMPS(70), TEMPV(70), TEMPVS(70), QEI(70), VX(70), ۶ GNDI (70), VY1 (70), VY2 (70), VY3 (70), ELSI (30), VY4(70), VY5(70), VY6(70), HFG, TEMPF(70) å /SPLIN/TIME(3), TIMER(20), QSTAG(20), XP1(25), CP1(4,25), ND1, å XP2(60), CP2(4,60), ND2, XP3(25), CP3(4,25), ND3, TS, å δ XP4(25), CP4(4,25), ND4, XP5(15), CP5(4,15), ND5, XP6(15), & CP6(4,15), XP7(15), CP7(4,15), ND7, XP8(15), CP8(4,15), å ND6, ND8, XP9(15), CP9(4, 15), ND9, XP0(15), CP0(4, 15), ND0, å ELSS(30), TESL(30) Ł /OUTPT/MO, IDAY, IYEAR, TITLE, CASE, NUMBER, NO, TEMPCC, HTCC, IOUT, TIMEN, DELT, DELT1, DELTP ٤ DIMENSION X(3), Y(3), RS(70), DUMG(140), DUMC(140), DUMQE(140, 3),IRGN (15), NCOL (15), NROW (15), DUMK (140), TEST (140), \$ TEMP(3), TEMPG(3), TEMPB(70), THETAX(140), TA(3,96),8 AREA(30), OT(70), QEIN(70), DTEMPS(70), TEMPC(140,3)۰£ INTEGER TS, TSM1, TSM2, P, GND, GNDB, GNDI, IOUT, FIRTS, FM1, FP1, PNOD REAL KIJ, KLP, KSN, KFN, KLN, KREF, HRSL, HTC, KEE, MACH, INTVL, MASW, MASWN, ٤ JCOB. JCOBI C.....READ IN DATA TO CREATE COVER PAGE..... WRITE(4.5)FORMAT('INPUT CASE NUMBER?') 5 READ(3,*) NO WRITE(4.6)6 FORMAT('INPUT DATE AS 12 20 1987') 7 FORMAT(13,13,15) READ(3,7) MO, IDAY, IYEAR WRITE(4.8)FORMAT ('INPUT TITLE WITHIN 27 CHARACTERS') 8 9 FORMAT(3A9) READ(3,9) TITLE, CASE, NUMBER 10 FORMAT(A1) WRITE(4,11) FORMAT ("RESTART FROM LAST RUN ? (Y/N)") 11 READ(3,10) YESNO WRITE(4, 12)12 FORMAT('TIME INTERVAL(SEC.)?') READ(3,*) DELT WRITE(4,13)FORMAT ('HOW MANY TIME STEP DO YOU WANT TO RUN?') 13 READ(3,*) MN WRITE(4,14)

NROWT = NROW(1) + NROW(INRG+1) - 130 NCOLT = NCOLT + NCOL(I)IF (I .LT. INRG) THEN I = I + 1GO TO 30 END IF NCOLT = NCOLT - INRG + 1DO 100 I = 1, NELREAD(5,*) NE(I), (GND(I,L), L=1,3), (XC(I,L), YC(I,L), L=1,3) NE = NUMBER OF ELEMENT С С GND = GLOBLE NUMBER OF NODES XC = X-COORDINATE OF NODES[M] С YC = Y-COORDINATE OF NODES[M] С READ(5,*) DUMK(I), DUMG(I), DUMC(I), (IES(I,L), HTC(I, IES(I,L)), TEMPC(I, IES(I,L)), L=1,2), & (IES(I,L),QE(I,IES(I,L)),L=1,2) & DUMK = THERMAL CONDUCTIVITY [W/(M*K)] С DUMG = HEAT GENERATION PER UNIT VOLUME С DUMC = SPECIFIC HEAT/DENSITY PRODUCT С = HEAT TRANSFER COEFFICIENT [W/(M**2*K)] С HTC = NUMBER OF SIDE IN EACH ELEMENT С IES = HEAT FLUX ON BOUNDARY SURFACES [W/M**2] С 0E TEMPC = REFERENCE TEMP. FOR CONVECTIVE HEAT[K] С 100 CONTINUE IST = 1IFN = 640 READ(5,*) (GNDB(I), I = IST, IFN), (TEMPB(I), I=IST, IFN) GNDI = GLOBLE NUMBER OF NODE WHERE IS LOCATED ON С THE LIQUID-VAPOR INTERFACE. С GNDB = GLOBLE NODE NUMBER OF NODE WHERE IS ON BOUNDARY С JFNT = TOTAL NUMBER OF GNDI С TEMPB = SPECIFIED BOUNDARY TEMP. С IF (GNDB (IFN) .GT. 0) THEN IST = IST + 6IFN = IFN + 6GO TO 40 END IF C.....READ GLOBAL NODE NUMBER ON LIQUID-VAPOR INTERFACE..... JST = 1JFN = 6READ(5,*) (GNDI(I), I = JST, JFN) .50 IF (GNDI (JFN) .GT. 0) THEN JST = JST + 6JFN = JFN + 6GO TO 50 END IF JFNT = 0

DO 60 I = 1, JFNIF (GNDI (I) .GT. 0) THEN JFNT = JFNT + 1END IF 60 CONTINUE C.....READ DATA FOR RADIATION BOUNDARY CONTITIONS..... IF (NRAD .EQ. 1) THEN READ(5,*) TEMPR.EMIS END IF С TEMPR = REFERENCE TEMP. FOR RADIATION [K] С EMIS = EMISSIVITY C.....READ SCALE FACTOR AND HEAT FLUX AT STAGNATION..... 15 FORMAT (A20) IF (NFLUX .EQ. 1) THEN READ(5,15) INPUT1 READ(5,*) ND1, (XP1(1), CP1(1,1), I=1, ND1) READ(5,*) CP1(2,1),CP1(2,ND1) CALL SPLINE (ND1-1, XP1, CP1) CALL CALCF(ND1-1,XP1,CP1) READ(5,15) INPUT2 READ(5, *) ND2, (XP2(I), CP2(1, I), I=1, ND2)READ(5,*) CP2(2,1),CP2(2,ND2) . CALL SPLINE (ND2-1, XP2, CP2) CALL CALCF (ND2-1, XP2, CP2) END IF C.....READ CONDUCTIVITY AND SPECIFIC HEAT OF STAINLESS STEEL..... READ(5,15) INPUT3 READ(5,*) ND3, (XP3(I), CP3(1, I), I=1, ND3) READ(5,*) CP3(2,1),CP3(2,ND3) CALL SPLINE (ND3-1, XP3, CP3) CALL CALCF(ND3-1,XP3,CP3) READ(5,15) INPUT4 READ(5, *) ND4, (XP4(I), CP4(1, I), I=1, ND4) READ(5,*) CP4(2,1),CP4(2,ND4) CALL SPLINE (ND4-1, XP4, CP4) CALL CALCF(ND4-1,XP4,CP4) ND1,2,3 = NUMBER OF DATA POINTS С С XP1,2,3 = LOCATION IN X - AXISС CP1,2,3 = COEFFICIENT OF INTERPOLATION EQUATION C.....CONDUCTIVITY ,DENSITY AND SPECIFIC HEAT OF SOLID SODIUM..... READ(5, 15) INPUT5 READ(5,*) ND5, (XP5(I), CP5(1, I), I=1, ND5) READ(5,*) CP5(2,1),CP5(2,ND5) CALL SPLINE (ND5-1, XP5, CP5)

CALL CALCF (ND5-1, XP5, CP5) READ (5,15) INPUT6 READ (5,*) ND6, (XP6(I), CP6(1,I), I=1, ND6) READ (5,*) CP6(2,1), CP6(2, ND6) CALL SPLINE (ND6-1, XP6, CP6) CALL CALCF (ND6-1, XP6, CP6) READ (5,15) INPUT7 READ (5,*) ND7, (XP7(I), CP7(1,I), I=1, ND7) READ (5,*) CP7(2,1), CP7(2, ND7) CALL SPLINE (ND7-1, XP7, CP7) CALL CALCF (ND7-1, XP7, CP7)

C.....CONDUCTIVITY , DENSITY AND SPECIFIC HEAT OF LIQUID SODIUM......

READ (5,15) INPUT8 READ (5,*) ND8, (XP8(I), CP8(1,I), I=1, ND8) READ (5,*) CP8(2,1), CP8(2,ND8) CALL SPLINE (ND8-1, XP8, CP8) CALL CALCF (ND8-1, XP8, CP8) READ (5,15) INPUT9 READ (5,*) ND9, (XP9(I), CP9(1, I), I=1, ND9) READ (5,*) CP9(2,1), CP9(2, ND9) CALL SPLINE (ND9-1, XP9, CP9) CALL SPLINE (ND9-1, XP9, CP9) READ (5,*) ND0, (XP0(I), CP0(1, I), I=1, ND0) READ (5,*) CP0(2,1), CP0(2, ND0) CALL SPLINE (ND0-1, XP0, CP0) CALL SPLINE (ND0-1, XP0, CP0) CALL CALCF (ND0-1, XP0, CP0)

C.....READ NODAL POINT NUMBER TO USE PRINTING TEMP.....

READ(5,*) ((PNOD(I,J),J=1,NCOLT),I=1,NROWT)

C.....PRINT OUT DATA FOR PLOT.....

IF(YESNO .EQ. "N") THEN
WRITE(7,*) ((GND(I,L),L=1,3),I=1,NEL)
WRITE(7,*) ((XC(I,L),YC(I,L),L=1,3),I=1,NEL)
END IF

C.....SET FIRST GUESS

DO 110 I= IST, IFN IF(GNDB(I) .GT. -1) THEN TEMPG1(GNDB(I)) = TEMPB(I) END IF 110 CONTINUE DO 120 I = 1,NP DO 125 J = IST, IFN IF(I .NE. GNDB(J)) THEN TEMPG1(I) = TEMPI ENDIF 125 CONTINUE

120 CONTINUE

CSOME CONSTANT PARAMETER..... С NUMBER OF NODES ON INTERFACE FOR PRESENT TIME STEP. JNT -С TS NUMBER OF TIME STEPS -BOLT = 5.67E-8FM1 = 1FIRTS = 1FP1 = 1KLP = 72.3KREF = 141.VOLSPR = 1.109E6ALPAR = KREF/(VOLSPR)DEFO = ALPAR*DELT1/DIST**2 IOUT = 1JK = 1JNT = 1IX = 1NPP1 = NP + 1NRESIS = 1TIMEN = DELT1 TIME(1) = DELT1TS = 0TEMPV(2) = 0.C.....CALCULATE BASIC ELEMENT GEOMETRIC MATRIX..... DO 200 M = 1, NELDO 220 I = 1,3X(I) = 0.Y(I) = 0.X(I) = X(I) + XC(M, I)/DISTY(I) = Y(I) + YC(M, I)/DIST220 CONTINUE CALL ELMDM(X, Y, M)200 CONTINUE C.....CALCULATE LENGTH OF SIDE OF ELEMENT AT INTERFACE..... K = 2KM1 = 1 226 DO 225 M = 1,NEL IF (GND(M, 1) . EQ. GNDI(KM1) . AND. GND(M, 2) . EQ. GNDI(K)) THEN ELSI(KM1) = SQRT((XC(M, 1) - XC(M, 2))**2 + $(YC(M,1) - YC(M,2))^{**2}$ ۶ K = K + 1KM1 = K - 1IF(K .LE. JFNT-1) THEN GO TO 226 END IF END IF 225 CONTINUE K = 2

```
KM1 = 1
     TLENG = 0.0
   DO 227 M = 1,NEL
228
       IF (GND (M, 3) .EQ. PNOD (1, KM1) .AND. GND (M, 2) .EQ.
         PNOD(1,K)) THEN
    8
         ELSS(KM1) = SQRT((XC(M,2) - XC(M,3))**2 +
                     (YC(M, 2) - YC(M, 3))^{**2}
    $
         TLENG = TLENG + ELSS(KM1)
         IF (KM1 .EQ. 1) THEN
           TESL(1) = ELSS(1)
         ELSE
           TESL(KM1) = TESL(KM1 - 1) + ELSS(KM1)
         END IF
         K = K + 1
         KM1 = K - 1
         IF(K .LE. JFNT-1) THEN
           GO TO 228
         END IF
       END IF
227 CONTINUE
     WRITE(7,*) TLENG, (ELSS(I), I=1, JFNT-1)
     WRITE(7,*) (TESL(I), I=1, JFNT-1)
     WRITE(7,*) (ELSI(I), I=1, JFNT-1)
      IF (YESNO .EQ. "Y") THEN
       GO TO 545
      END IF
C **********************
   TO EVALUATE TEMPERATURE AT FIRST FEW TIME STEPS
С
    BY USING IMPLICIT METHOD(BETA = 1.,.5)
С
 *********************
C
C.....SET DIMENSIONLESS BOUNDARY TEMP.....
      DO 230 I = 1, IFN
        THETAB(I) = (\text{TEMPB}(I) - \text{TMEL})/(\text{TMEL} - \text{TEMPI})
 230 CONTINUE
C.....SET DIMENSIONLESS GUESS TEMP.....
      DO 250 I = 1, NP
        THETAG(I) = (TEMPG1(I) - TMEL)/(TMEL - TEMPI)
 250 - CONTINUE
 450 \text{ TS} = \text{TS} + 1
      IF(TS .EQ. 2) THEN
        TIME(2) = TIME(1) + DELT
      ELSE IF (TS .EQ. 3) THEN
        TIME(3) = TIME(2) + DELT
      ELSE IF (TS .GT. 3) THEN
        TIME(1) = TIME(2)
        TIME(2) = TIME(3)
        TIME(3) = TIME(3) + DELT
      END IF
       DO 260 I = 1.NP
        TEMPG1(I) = THETAG(I)*(TMEL - TEMPI) + TMEL
```

```
260 CONTINUE
430 P = 0
400 P = P + 1
C .....SET ARRAYS ZERO.....
      DO 310 I = 1, NP
        THETA(I) = 0.
 310 CONTINUE
      DO 320 I = 1, NP
        FLD(I) = 0.
        BM(I) = 0.
        RM(I) = 0.
        DO 325 J = 1, NP
          AM(I,J) = 0.
 325
        CONTINUE
 320 CONTINUE
      DO 330 I = 1, NP
        DO 335 J = 1,NPP1
          AMC(I,J) = 0.
 335
        CONTINUE
 330 CONTINUE
      DO 340 M = 1.NEL
        DO 345 I = 1,3
           TEMPG(I) = THETAG(GND(M, I))*(TMEL - TEMPI) + TMEL
C..... IMPLICIT TIME STEPPING SCHEME.....
           IF (BETA .EQ. 1.) THEN
            TEMP(I) = TEMPG(I)
           ELSE
             \text{TEMP}(I) = (\text{TEMPG}(I) + \text{TEMPG1}(I)) * \text{BETA}
           END IF
 345
        CONTINUE
C....TO ASSUMBLE ELEMENT MATRIX INTO GLOBAL SYSTEM MATRIX [AMC] ....
        CALL GLOBMAX (TEMP, TEMPC, M, DUMK, NLEX, NFLUX, NRAD, NTS, P, IFN)
 340 CONTINUE
C.....APPLY B. C.'S OF FIRST KIND IF APPLICABLE.....
      CALL FIRSTBC(IFN)
C....TO EVALUATE RESIDUAL AND THETAG(I) FOR NEXT ITERATION.....
       DO 350 I = 1, NP
          THETA(I) = THETAG(I)
          THETAG(I) = 0.
 350
       CONTINUE
       CALL RESIDUL (RMAX)
       CALL CHLSKY (TS, NTS, THETAX)
       DO 355 I = 1.NP
          THETAG(I) = THETAX(I) + THETA(I)
 355
       CONTINUE
```

```
C *****************
C *CHECK CONVERGENCE CRITERIOR ON DIFFERENCE BETWEEN NEW THETA AND *
C *OLD THETA AT EVERY NODES. IF ONE OF DIFFERENCES IS GREATER THAN *
 *TOLERANCE, THEN ITERATED BY NEWTON-RAPHSON METHOD. IF CRITERION *
С
                                                           si:
C *IS MET, THETA(I) ARE SUBSTITUTED INTO EQUATION TO OBTAIN
                                                            ÷
C *THETA(I) AT THE NEXT TIME STEP.
 *****
C
     IF (RMAX .LT. .001 .OR. P .GT. MM) THEN
       DO 370 I = 1.NP
         IF(TS .EQ. 1) THEN
          TA(1, I) = THETAG(I)*(TMEL - TEMPI) + TMEL
         ELSE IF (TS .EQ. 2) THEN
          TA(2, I) = THETAG(I)*(TMEL - TEMPI) + TMEL
         ELSE IF (TS .EQ. 3) THEN
          TA(3,I) = THETAG(I)*(TMEL - TEMPI) + TMEL
         ELSE
          TA(1,I) = TA(2,I)
          TA(2,I) = TA(3,I)
           TA(3,I) = THETAG(I) * (TMEL - TEMPI) + TMEL
         END IF
 370
       CONTINUE
       NPRINT = JK * NFREQ
       IF (TS .EQ. NPRINT) THEN
         CALL MAINOUT (TA, TSTAR, NTS, MN, NCOLT, NROWT)
         JK = JK + 1
       END IF
       DEFO = (ALPAR/DIST**2)*DELT
       IF (TS .LT. NTS) THEN
         GO TO 450
       ELSE
         IF (NTS .EQ. MN) THEN
           GO TO 540
         ELSE
           GO TO 550
         END IF
       END IF
     ELSE
       GO TO 400
      END IF
 540 CONTINUE
      GO TO 2
C ***********************
   TO EVALUATE TEMPERATURE BY USING EXPLICIT METHOD
С
   (DUPONT) WITH TEMPERATURES FOR TWO PREVIOUS TIME STEPS
С
545 IF (YESNO .EQ. "Y") THEN
       CALL DATAIN (TA, JK, JNT, TIMEN, FIRTS, TVU, QT, TEMPD)
       FM1 = FIRTS - 1
       FP1 = FIRTS
      END IF
```

```
C.....SET ARRAYS ZERO.....
 550 TS = TS + 1
      IF(TS .EQ. 2) THEN
        TIME(2) = TIME(1) + DELT
      ELSE IF (TS .EQ. 3) THEN
        TIME(3) = TIME(2) + DELT
      ELSE IF (TS .GT. 3) THEN
        TIME(1) = TIME(2)
        TIME(2) = TIME(3)
        TIME(3) = TIME(3) + DELT
      END IF
 530 DO 500 I = 1,NP
        FLD(I) = 0.
        BM(I) = 0.
        DO 510 J=1,NPP1
          AMC(I,J) = 0.0
 510
        CONTINUE
 500 CONTINUE
C.....SET INITIAL TEMPERATURE FROM TWO PREVIOUS TIME STEPS.....
      DO 520 I = 1, NP
        IF(TS .GT. 3) THEN
          THETTO(I) = (TA(2, I) - TMEL)/(TMEL - TEMPI)
          THETAO(I) = (TA(3, I) - TMEL)/(TMEL - TEMPI)
        ELSE
          THETTO(I) = (TA(1, I) - TMEL)/(TMEL - TEMPI)
          THETAO(I) = (TA(2, I) - TMEL)/(TMEL - TEMPI)
        END IF
        DO 525 J = 1, NP
          AM(I,J) = 0.
 525
        CONTINUE
 520 CONTINUE
      DO 600 M = 1, NEL
        DO 610 I = 1,3
           TEMP(I) = THETAO(GND(M, I))*(TMEL - TEMPI) + TMEL
 610
        CONTINUE
C....TO ASSUMBLE ELEMENT MATRIX INTO GLOBAL SYSTEM MATRIX[AMC]....
        CALL GLOBMAX (TEMP, TEMPC, M, DUMK, NLEM, NFLUX, NRAD, NTS, P, IFN)
 600 CONTINUE
 C....APPLY B.C.'S OF FIRST KIND IF APPLICABLE.....
      CALL FIRSTBC(IFN)
 C.....SOLVE MATRIX BY USING CHOLESKY'S DECOMPOSITION.....
       CALL CHLSKY (TS, NTS, THETAX)
       DO 646 I = 1, NP
        THETA(I) = THETAX(I)
  646 CONTINUE
```

```
C.....CHECK TEMPERATURES ON LIQUID-VAPOR INTERFACE.....
                = GLOBAL NODE NUMBER AT FIRST NODE ON INTERFACE
      GNDI(1)
С
      GNDI(JNT) = LAST GLOBAL NODE NUMBER WHOSE TEMPERATURE IS
С
                  GREATER THAN TSTAR
С
                = LIQUID TEMP. AT LIQUID-VAPOR INTERFACE
С
      TEMPS
                = TEMP. IN VAPOR SPACE
      TEMPV
С
                = VAPOR TEMP. AT LIQUID-VAPOR INTERFACE
      TEMPVS
С
      DO 660 I = 1, NP
        IF(TS .GT. 3) THEN
          TA(1,I) = TA(2,I)
          TA(2,I) = TA(3,I)
          TA(3,I) = THETA(I) * (TMEL - TEMPI) + TMEL
        ELSE
          TA(1,I) = TA(1,I)
          TA(2,I) = TA(2,I)
          TA(3,I) = THETA(I)*(TMEL - TEMPI) + TMEL
        END IF
 660 CONTINUE
      NPRINT = JK * NFREQ
      IF (TS .EQ. NPRINT) THEN
        CALL MAINOUT (TA, TSTAR, NTS, MN, NCOLT, NROWT)
        JK = JK + 1
      END IF
      DO 665 I = 1, JFNT
        TEMPS(I) = 0.
      CONTINUE
 665
      DO 680 I = 1, 2
         JJ = GNDI(I)
         TEMPS(I) = THETA(JJ)*(TMEL - TEMPI) + TMEL
 680 CONTINUE
C.....ADIABATIC BOUNDARY CONDITION AT LIQUID-VAPOR INTERFACE.....
       IF (TEMPS(2) .LT. TSTAR) THEN
         DEFO = (ALPAR/DIST**2)*DELT
         IF(TS .GE. MN) THEN
           GO TO 2000
         ELSE
           DO 910 J = 1, JFNT
             DO 911 I = 1, NEL
               IF(GNDI(J) .EQ. GND(I,1) .AND. GNDI(J+1) .EQ. GND(I,2))
      ۶
               THEN
                 IES(I,1) = 1
                 QE(I, IES(I, 1)) = 0.
               END IF
             CONTINUE
  911
  910
           CONTINUE
           IF (TEMPS (JFNT) .GT. TSTAR) THEN
             GO TO 2000
           ELSE
             GO TO 550
           END IF
                                                            ORIGINAL PAGE IS
         END IF
                                                            OF POOR QUALITY
```

```
ELSE IF (TEMPS(1) .GT. TSTAR .AND. TEMPS(2) .GT. TSTAR) THEN
C.....NO LONGER ADIABATIC CONDITION AT LIQUID-VAPOR INTERFACE.....
C.....HOW MANY NODES ON INTERFACE HAVE GREATER TEMP. THAN TSTAR.....
        DO 915 I = 1, JFNT
          TEMPS(I) = 0.
 915
        CONTINUE
        J = 1
 920
        JG = GNDI(J)
        TEMPS(J) = THETA(JG)*(TMEL - TEMPI) + TMEL
        IF (TEMPS (J) .GT. TSTAR) THEN
          \mathbf{J} = \mathbf{J} + \mathbf{1}
          IF(J .LT.JFNT) THEN
            GO TO 920
          ELSE '
            JNT = JFNT - 1
          END IF
        ELSE
          JNT = J
          TEMPSN = TEMPS(J)
        END IF
C.....CALCULATE UNIFORM TEMP. FOR VAPOR SPACE.....
        TEMPS(JFNT) = THETA(GNDI(JFNT))*(TMEL-TEMPI)+TMEL
        DO 922 J = 1, JFNT
          DO 923 I = 1.NEL
            IF(GNDI(J) . EQ. GND(I,1) .AND. GNDI(J+1) . EQ. GND(I,2))
     δ
            THEN
               IES(I,1) = 1
               QE(I, IES(I, 1)) = 0.
            END IF
 923
          CONTINUE
 922
        CONTINUE
        IF (NRESIS .EQ. 2) THEN
          CALL COUPLE (JNT, QT, TVU, JFNT)
          GO TO 2500
        END IF
        IF(FIRTS .EQ. 1) THEN
          TVU = (TEMPS(1) + TSTAR)/2.
 2100
          RESD = 0.
          TELSI = 0.
          RESDC = 4.5E6*1.4*.021*2.29E11
          DO 924 I = 1, JNT
            RESDI = ELSI(I)*10.**(-5567./TEMPS(I))/TEMPS(I)
            RESDV = ELSI(I)*10.**(-5567./TVU)/TVU
            RESD = RESD + RESDC*(RESDI - RESDV)
             TELSI = TELSI + ELSI(I)
 924
          CONTINUE
           JCOB = (1 - 12818.5/TVU) * TELSI
           JCOB = JCOB * 10.**(-5567./TVU)
           JCOB = RESDC*JCOB/(TVU**2)
           TVO = TVU
           TVU = TVO - RESD/JCOB
```

IF (ABS (RESD) .LT. .001) THEN CALL INTFLUX (JFNT, JNT, TVU, TEMPV, TEMPS, QEI) ELSE GO TO 2100 END IF ELSE 2200 RESD = 0.TELSI = 0. RESDC = 4.5E6*1.4*.021*2.29E11 DO 928 I = 1, JNTRESDI = ELSI(I)*10.**(-5567./TEMPS(I))/TEMPS(I) RESDV = ELSI(I) *10.**(-5567./TVU)/TVU RESD = RESD + RESDC*(RESDI - RESDV)TELSI = TELSI + ELSI(I)928 CONTINUE JCOB = (1 - 12818.5/TVU) *TELSI JCOB = JCOB * 10.**(-5567./TVU)JCOB = RESDC*JCOB/(TVU**2)TVO = TVUTVU = TVO - RESD/JCOBIF (ABS (RESD) .LT. .001) THEN C.....TO ESTIMATE THE SONIC LIMIT..... CALL INTFLUX (JFNT, JNT, TVU, TEMPV, TEMPS, QEI) VMAX = SQRT(1.4*8314.*TVU/23.)PSATT = (2.29E11/SQRT(TVU))*10.**(-5567/TVU) DENS = 2.766E-3*PSATT/TVUHFGS = 182.*(25474.93 - .9935*TVU)QMAX = VMAX*HFGS*DENS*DIST*WIDTH/2.2 OTAL = 0.DO 930 I = 1, JNTAREA(I) = 0.IF (QEI (I) .GT. 0.) THEN QTAL = QTAL + QEI(I)*ELSI(I)*WIDTH END IF 930 CONTINUE QMAXT = QMAX*.50C..... IF AMOUNT OF HEAT TRANSFER ON EVAPORATOR IS GREATER..... C.....THAN THE SONIC LIMIT, IT IS ASSUMED THAT THE SONIC..... C.....LIMIT IS ACTUAL HEAT TRANSFER. CALCULATE NEW VAPOR..... C.....TEMPERATURE BASE ON SONIC LIMIT..... IF (QMAX .LE. QTAL .AND. JNT .GE. 4) THEN 2300 RESD = 0JCOB = 0.DO 931 I = 2, JNTIF (TEMPS(I) .GT. TVU) THEN JNTL = IELSE IF (TEMPS(I) .LT. TVU .AND. TEMPS(I-1) .GT. TVU) THEN Ł XII = (TEMPS(JNTL) - TVU) * ELSI(I-1)XII = XII / (TEMPS(JNTL) - TEMPS(I))

END IF

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.

•

931	CONTINUE
	RSC1 = 2.29E11*1.5*.021*4.5E6
	RSC2 = 6.34E8*4.5E6*10.26*DIST
	IC = 0
	DO 932 I = 1, JNTL
	IF (QEI (I) .GT. 0.) THEN
	RSC12 = RSC1*ELSI(I)
	IF(I .NE. JNTL) THEN
	RESDI = 10.**(-5567/TEMPS(I))/TEMPS(I)*ELSI(I)*RSC1
	RESDV = 10.**(-5567/TVU)/TVU*RSC12
	$JCOBI = RSC1 \times ELSI(I)$
	ELSE
	RESDI = 10.**(-5567/TEMPS(I))/TEMPS(I)*XII*RSC1
	RESDV = 10.**(-5567/TVU)/TVU*(RSC1*XII+RSC2)
	JCOBI = RSC1*XII
	END IF
	RESD = RESD + RESDI - RESDV
	JCOB = JCOB + JCOBI
	ELSE
	IC = IC + 1
	END IF
932	CONTINUE
	JLM1 = JNTL - IC
	JCOB = (JCOB+RSC2) * (1-12818.5/TVU)
	JCOB = JCOB*10.**(-5567./TVU)/(TVU**2)
	TVO = TVU
	TVU = TVO - RESD/JCOB
	IF (ABS (RESD) .LT1) THEN
	IF (ABS (RESD) . LI I) IHEN
~	
·····	CALCULATE HEAT FLUX DISTRIBUTION ON CONDENSER SECTION
	AREAT = 0.
	DO 933 I = 2, JNT
	IF(TEMPS(I) .LT. TVU .AND. TEMPS(I-1) .GT. TVU)
۵.	THEN
-	JNTM = I
	AREA(I) = TEMPS(I) - TVU
	AREA(I) = AREA(I) + (TEMPS(I) - TEMPS(I+1))/2.
	AREA(I) = AREA(I) * ELSI(I)
	ELSE IF (TEMPS(I) .LT. TVU) THEN
	AREA(I) = TEMPS(I) - TVU
	AREA(I) = AREA(I) + (TEMPS(I) - TEMPS(I+1))/2.
	AREA(I) = AREA(I) * ELSI(I)
	END IF
	AREAT = AREAT + AREA(I)
933	
733	
	CONTINUE
	CONTINUE JNTL = JNTM - 1
	CONTINUE JNTL = JNTM - 1 CALL INTFLUX(JFNT,JNTL,TVU,TEMPV,TEMPS,QEI)
	CONTINUE JNTL = JNTM - 1 CALL INTFLUX(JFNT,JNTL,TVU,TEMPV,TEMPS,QEI) VMAX = SQRT(1.4*8314.*TVU/23.)
	CONTINUE JNTL = JNTM - 1 CALL INTFLUX(JFNT,JNTL,TVU,TEMPV,TEMPS,QEI)
	CONTINUE JNTL = JNTM - 1 CALL INTFLUX(JFNT,JNTL,TVU,TEMPV,TEMPS,QEI) VMAX = SQRT(1.4*8314.*TVU/23.)
	CONTINUE JNTL = JNTM - 1 CALL INTFLUX(JFNT,JNTL,TVU,TEMPV,TEMPS,QEI) VMAX = SQRT(1.4*8314.*TVU/23.) PSATT = (2.29E11/SQRT(TVU))*10.**(-5567/TVU) DENS = 2.766E-3*PSATT/TVU
	CONTINUE JNTL = JNTM - 1 CALL INTFLUX(JFNT, JNTL, TVU, TEMPV, TEMPS, QEI) VMAX = SQRT(1.4*8314.*TVU/23.) PSATT = (2.29E11/SQRT(TVU))*10.**(-5567/TVU) DENS = 2.766E-3*PSATT/TVU HFGS = 182.*(25474.939935*TVU)
	CONTINUE JNTL = JNTM - 1 CALL INTFLUX(JFNT,JNTL,TVU,TEMPV,TEMPS,QEI) VMAX = SQRT(1.4*8314.*TVU/23.) PSATT = (2.29E11/SQRT(TVU))*10.**(-5567/TVU) DENS = 2.766E-3*PSATT/TVU HFGS = 182.*(25474.939935*TVU) QMAX = VMAX*HFGS*DENS*DIST*WIDTH/2.2
	CONTINUE JNTL = JNTM - 1 CALL INTFLUX(JFNT, JNTL, TVU, TEMPV, TEMPS, QEI) VMAX = SQRT(1.4*8314.*TVU/23.) PSATT = (2.29E11/SQRT(TVU))*10.**(-5567/TVU) DENS = 2.766E-3*PSATT/TVU HFGS = 182.*(25474.939935*TVU)

IF (QEI (I) .GT. 0.) THEN IF(I .LT. JNTL) THEN QTAL = QTAL + QEI(I)*ELSI(I)*WIDTH ELSE XII = (TEMPS(JNTL) - TVU)*ELSI(I) XII = XII/(TEMPS(JNTL)-TEMPS(JNTM)) QTAL = QTAL + QEI(I) *XII*WIDTHEND IF END IF 935 CONTINUE DO 936 I = JNTM, JNTIF(I .EQ. JNTM) THEN QEI(I) = - AREA(I) * QMAX/AREAT/ELSI(I)/WIDTH IF(TS .GT. 7000) THEN END IF ELSE QEI(I) = - AREA(I)*QMAX/AREAT/ELSI(I)/WIDTH END IF 936 CONTINUE NRESIS = 1ELSE GO TO 2300 END IF ELSE IF (QTAL .LE. QMAXT .AND. JNT .GE. JFNT-1) THEN C.....ARTIFICIAL THERMAL RESISTANCE, WHICH CALCULATED FROM..... C.....VAPOR FLOW, IS IMPOSED AT LIQUID-VAPOR INTERFACE..... CALL COUPLE(JNT,QT,TVU,JFNT) NRESIS = 2END IF ELSE GO TO 2200 END IF END IF 2500 IF (TS .EQ. NPRINT) THEN WRITE(6,790) TVU WRITE(2,775) TVU END IF DO 945 J = 1, JNT DO 946 I = 1, NELIF(GNDI(J) .EQ. GND(I,1) .AND. GNDI(J+1) .EQ. GND(I,2))) THEN \$ IES(I,1) = 1QE(I, IES(I, 1)) = QE(I, IES(I, 1)) - QEI(J)END IF 946 CONTINUE 945 CONTINUE FIRTS = FIRTS + 1DEFO = (ALPAR/DIST**2)*DELT IF (TS .GE. MN) THEN **ORIGINAL PAGE IS** GO TO 2000 **OF POOR QUALITY** ELSE GO TO 550 END IF

```
ELSE
       DEFO = (ALPAR/DIST^{**}2)^*DELT
       IF (TS .GE. MN) THEN
         GO TO 2000
       ELSE
         GO TO 550
       END IF
     END IF
C.....PRINT UNIFORM VAPOR TEMPERATURE.....
 2000 CONTINUE
 2
     FIRTS1 = FIRTS - 1.
 775 FORMAT(F8.2)
 790 FORMAT (/2X, 'TEMPV = ', F8.3, 2X, '[K] ')
C.....PRINT DATA FOR RESTARTING FROM LAST RUN.....
     CALL DATAOUT (TA, JK, JNT, TIMEN, FIRTS, TVU, QT, TEMPD)
     STOP
     END
                SUBROUTINE ELMDM(X,Y,M)
C ***********************
C * THIS SUBROUTINE CALCULATES ELEMENT DATA SUCH
                                                     *
C * AS AREA, B(I)B(J) + C(I)C(J), B(I)C(J) - B(J)C(I)
```

```
XY = X(2) * Y(3) - Y(2) * X(3)

YX = X(1) * (Y(2) - Y(3)) + Y(1) * (X(3) - X(2))

XPY = XY + YX

EAREA(M) = .5 * ABS(XPY)

B(M,1) = Y(2) - Y(3)

B(M,2) = Y(3) - Y(1)

B(M,3) = Y(1) - Y(2)

C(M,1) = X(3) - X(2)

C(M,2) = X(1) - X(3)

C(M,3) = X(2) - X(1)

ESL(M,1) = SQRT(B(M,3) **2+C(M,3) **2)

ESL(M,2) = SQRT(B(M,1) **2+C(M,1) **2)

ESL(M,3) = SQRT(B(M,2) **2+C(M,2) **2)

RETURN
```

END

SUBROUTINE CONCP(X,Y,TEMP,M,DUMK,NLEM)

************************* С * THIS IS MAIN SUBTROUTINE TO EVALUATE CONDUCTION * С * AND CAPACITANCE MATRIX FOR EACH ELEMENT C ******* C COMMON/MATG/ AMC(140,151), RM(140), THETA(140), FLD(140), AM(140,140), BM(140), CIJ(3,3), KIJ(3,3) \$ /TEPS/ TEMPR, TEMPI, TMEL, DETP, DELTD, TEMPG1(140), THETAG(140), & THETAF (140), THETAO (140), THETTO (140), THETAB (70), TEMPD Ł /PROC/ HRSL, ALPAR, DIST, BI, KREF, ROUR, SPECR, EMIS, HTC (140, 3), £ BOLT, VOLSPR, WIDTH, QE (140, 3), NRESIS, RESIS, IX £ /ELMT/ NEL, NP, GND(140, 3), B(140, 3), C(140, 3), EAREA(140), NPP1, 8 IES(140,2),ESL(140,3),BETA,XC(140,3),YC(140,3),DEFO, Ł NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70) 2 DIMENSION X(3), Y(3), TEMP (3), KN(3), DUMK (140) REAL KN C TO CALCULATE ELEMENT CONDUCTION [K] AND CAPACITANCE [C] C MATRIX ON ELEMENT BY ELEMENT BASIS C....TO PROVIDE COMMON MATRIX DATA..... IF (DUMK (M) .EQ. 4.) THEN CALL FICLAY (TEMP, M) ELSE C....CALCULATE NODAL CONDUCTIVITY AND VOLUMETRIC SPECIFIC HEAT.... CALL PROPTY (TEMP, CEE, KN, NLEM, M) C....CALCULATE CONDUCTION [KIJ] AND CAPACITANCE [CIJ] MATRIES.... CALL CKAN (CEE, KN, TEMP, M) END IF RETURN END SUBROUTINE FICLAY (TEMP, M) * THIS SUBROUTINE EVALUATES CONDUCTION AND CAPACITANCE С * MATRIX IN FICTITIOUS-LAYER WHICH HAS BEEN ARTIFICIALLY * С * CREATED TO SMOOTH OUT THE EFFECT OF THE ABRUPT CHANGE * C * OF TEMPERATURE AT THE BOUNDARY OR FOR HEAT PIPE SHELL. * С ********************************* C IMPLICIT REAL (K)

	COMMON/	'MATG/	AMC(140, 151), RM(140), THETA(140), FLD(140),
8	¥		AM(140,140),BM(140),CIJ(3,3),KIJ(3,3)
8	S /	PROC/	HRSL, ALPAR, DIST, BI, KREF, ROUR, SPECR, EMIS, HTC(140, 3),
ł	v		BOLT, VOLSPR, WIDTH, QE(140, 3), NRESIS, RESIS, IX

```
/ELMT/ NEL, NP, GND(140, 3), B(140, 3), C(140, 3), EAREA(140), NPP1,
    $
                  IES(140,2), ESL(140,3), BETA, XC(140,3), YC(140,3), DEFO,
    3
    ۶
                  NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70)
     DIMENSION TEMP(3)
     CALL PROSHEL (TEMP, KFIC, CFIC)
     DO 100 I = 1,3
       DO 110 J = 1,3
         EBC(I,J) = (B(M,I)*B(M,J) + C(M,I)*C(M,J))/EAREA(M)
         IF(I .EQ. J) THEN
            CM(I,J) = EAREA(M)/6.
         ELSE
            CM(I,J) = EAREA(M)/12.
         END IF
         KIJ(I,J) = KFIC * EBC(I,J)/4./KREF
          CIJ(I,J) = CFIC * CM(I,J)/VOLSPR
 110
        CONTINUE
 100 CONTINUE
     RETURN
      END
        SUBROUTINE PROSHEL (TEMP, KFIC, CFIC)
C * SUBROUTINE CALCULATES CONDUCTIVITY AND SPECIFIC HEAT FOR *
C * HEAT PIPE SELL BASED ON AVERAGE TEMPERATURE.
IMPLICIT REAL (K)
      DIMENSION TEMP(3)
C.....CONDUCTIVITY AND SPECIFIC HEAT FOR HASTELLAY X.....
      DATA TK1, TK2, TK3, TK4/373., 573., 773., 973./
     å
           K1 ,K2 ,K3 ,K4 /11.1,14.7,20.6,22.8/
     å
           CP1, CP2, CP3/498., 582., 699./
           TC1, TC2, TC3/588., 923., 1143/
     &
      ROU = 8220.
      TAVG = (TEMP(1) + TEMP(2) + TEMP(3))/3.
      IF (TAVG .LT. TK1) THEN
        KFIC = K1
      ELSE IF (TAVG .GE. TK1 .AND. TAVG .LT. TK2) THEN
        KFIC = K1 + (K2 - K1) * (TAVG - TK1) / (TK2 - TK1)
      ELSE IF (TAVG .GE. TK2 .AND. TAVG .LT. TK3) THEN
        KFIC = K2 + (K3 - K2) * (TAVG - TK2) / (TK3 - TK2)
      ELSE IF (TAVG .GE. TK3 .AND. TAVG .LT. TK4) THEN
        KFIC = K3 + (K4 - K3) * (TAVG - TK3) / (TK4 - TK3)
      ELSE
        KFIC = K4
      END IF
      IF (TAVG .LT. TC1) THEN
        CFIC = ROU * CP1
      ELSE IF (TAVG .GE. TC1 .AND. TAVG .LT. TC2) THEN
        CFIC = ROU * (CP1+(CP2-CP1)*(TAVG-TC1)/(TC2-TC1))
      ELSE IF (TAVG .GE. TC2 .AND. TAVG .LT. TC3) THEN
```

CFIC = ROU *(CP2+(CP3-CP2)*(TAVG-TC2)/(TC3-TC2)) ELSE CFIC = ROU * CP3 END IF RETURN END

SUBROUTINE PROPTY (TEMP, CEE, KN, NLEM, M)

```
С
 * THIS SUBROUTINE CALCULATES CONDUCTIVITY AND *
С
  * VOLUMETRIC SPECIFIC HEAT AT NODE IN ELEMENT *
С
 * WHICH HAS PHASE CHANGE
C
 IMPLICIT REAL (K)
      COMMON/TEPS/ TEMPR, TEMPI, TMEL, DETP, DELTD, TEMPG1 (140), THETAG (140),
                   THETAF (140), THETAO (140), THETTO (140), THETAB (70), TEMPD
     $
            /PROC/ HRSL, ALPAR, DIST, BI, KREF, ROUR, SPECR, EMIS, HTC(140, 3),
     ٤
                   BOLT, VOLSPR, WIDTH, QE (140, 3), NRESIS, RESIS, IX
     8
            /ELMT/ NEL.NP,GND(140,3),B(140,3),C(140,3),EAREA(140),NPP1,
     å
                   IES(140,2), ESL(140,3), BETA, XC(140,3), YC(140,3), DEFO,
     å
                   NE(140), TLENG, PNOD(5,30), EBC(3,3), CM(3,3), GNDB(70)
     ٤
            /SPLIN/TIME(3),TIMER(20),QSTAG(20),XP1(25),CP1(4,25),ND1,
     Ł
                   XP2(60), CP2(4,60), ND2, XP3(25), CP3(4,25), ND3, TS,
                   XP4(25), CP4(4,25), ND4, XP5(15), CP5(4,15), ND5, XP6(15),
                    CP6(4,15), XP7(15), CP7(4,15), ND7, XP8(15), CP8(4,15),
     8
                    ND6, ND8, XP9(15), CP9(4, 15), ND9, XP0(15), CP0(4, 15), ND0,
     ۰
                    ELSS(30), TESL(30)
     å
      DIMENSION TEMP (3), KN (3), KFN (3), KLN (3), KSN (3), ENTP (3)
      TMEP = TMEL + DETP
      TMES = TMEL - DETP
      DO 50 I = 1.3
        KFN(I) = 0.
        KLN(I) = 0.
        KSN(I) = 0.
 50
      CONTINUE
      DO 100 I = 1,3
        IF (TEMP(I) .LT. TMES) THEN
           TEMPS=TEMP(I)
           KSN(I) = PCUBIC(TEMPS, ND5, XP5, CP5)/KREF
           CSN = PCUBIC(TEMPS,ND7,XP7,CP7)
           ROUSN = PCUBIC (TEMPS, ND6, XP6, CP6)
           ENTP(I) = CSN * ROUSN * TEMP(I)
        ELSE IF (TEMP(I) .GT. TMEP) THEN
           TEMPL=TEMP(I)
           KLN(I) = PCUBIC(TEMPL,ND8,XP8,CP8)/KREF
           CLN = PCUBIC(TEMPL, NDO, XPO, CPO)
           ROULN = PCUBIC(TEMPL, ND9, XP9, CP9)
           CSN = PCUBIC(TMES, ND7, XP7, CP7)
           ROUSN = PCUBIC(TMES, ND6, XP6, CP6)
           ENTP(I) = CSN*ROUSN*TMES+HRSL+CLN*ROULN*(TEMP(I) +TMEP)
         ELSE
           KSS = PCUBIC(TMES, ND5, XP5, CP5)
           CSN = PCUBIC(TMES, ND7, XP7, CP7)
```

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```
ROUSN = PCUBIC(TMES.ND6, XP6, CP6)
         KLP = PCUBIC(TMEP, ND8, XP8, CP8)
         KFN(I) = (KSS + (KLP - KSS)*(TEMP(I) - TMES)/(2.*DETP))/KREF
         ENTP(I) =CSN*ROUSN*TMES + HRSL*(TEMP(I) - TMES)/(2.*DETP)
       END IF
100 CONTINUE
     DETX = 0.
     DETY = 0.
     DO 200 I = 1.3
       DETX = DETX + (B(M, I) * TEMP(I)) / (2.* EAREA(M))
       DETY = DETY + (C(M, I) * TEMP(I)) / (2.*EAREA(M))
200
     CONTINUE
      IF (DETX .NE. 0. .AND. DETY .NE. 0.) THEN
       ENTPX = 0.
        ENTPY = 0.
       DO 300 I = 1.3
          ENTPX = ENTPX + (B(M, I) * ENTP(I)) / (2.* EAREA(M))
          ENTPY = ENTPY + (C(M, I) * ENTP(I)) / (2.* EAREA(M))
300
        CONTINUE
        IF (NLEM .EQ. 1) THEN
          CEE = ((ENTPX^{**2} + ENTPY^{**2})/(DETX^{**2} + DETY^{**2}))/VOLSPR
        ELSE
          CEE = ((ENTPX*DETX + ENTPY*DETY)/(DETX**2 + DETY**2))/VOLSPR
       END IF
      ELSE
        IF (TEMP(1) .LT. TMES) THEN
          CEE = CSN*ROUSN/VOLSPR
        ELSE IF (TEMP(1) .GT. TMEP) THEN
          CEE = CLN*ROULN/VOLSPR
        END IF
      END IF
      DO 400 I = 1.3
        KN(I) = KFN(I) + KLN(I) + KSN(I)
 400
     CONTINUE
      RETURN
      END
         SUBROUTINE CKAN (CEE, KN, TEMP, M)
C * THIS SUBROUTINE CALCULATES CONDUCTION *
                                           ×
 * AND CAPACITANCE MATRICES FOR ELEMENT
С
                                           ÷
C * WHICH HAS PHASE CHANGE.
IMPLICIT REAL (K)
      COMMON/MATG/ AMC(140,151), RM(140), THETA(140), FLD(140),
     Ł
                   AM(140,140), BM(140), CIJ(3,3), KIJ(3,3)
     &
            /PROC/ HRSL, ALPAR, DIST, BI, KREF, ROUR, SPECR, EMIS, HTC (140.3),
     &
                   BOLT, VOLSPR, WIDTH, QE(140, 3), NRESIS, RESIS, IX
     Ł
            /ELMT/ NEL, NP, GND(140, 3), B(140, 3), C(140, 3), EAREA(140), NPP1,
                    IES(140,2), ESL(140,3), BETA, XC(140,3), YC(140,3), DEFO,
     8
     &
                   NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70)
            /SPLIN/TIME(3), TIMER(20), QSTAG(20), XP1(25), CP1(4,25), ND1,
     å
                   XP2(60), CP2(4,60), ND2, XP3(25), CP3(4,25), ND3, TS,
     8
```

```
XP4(25), CP4(4,25), ND4, XP5(15), CP5(4,15), ND5, XP6(15),
    3
                   CP6(4,15), XP7(15), CP7(4,15), ND7, XP8(15), CP8(4,15),
    £
                   ND6, ND8, XP9(15), CP9(4, 15), ND9, XP0(15), CP0(4, 15), ND0,
    S.
                   ELSS(30), TESL(30)
    å
     DIMENSION KN(3), TEMP(3)
     TAVG = (TEMP(1) + TEMP(2) + TEMP(3))/3.
     VOIDF = .684
     KSW = PCUBIC(TAVG,ND3,XP3,CP3)
     KSW = KSW/KREF
     CPSW = PCUBIC(TAVG, ND4, XP4, CP4)
     DENSW = 8027.
     CPSW = CPSW*DENSW/VOLSPR
     KEE = 0.
     DO 100 I = 1,3
       KEE = KEE + KN(I)
100 CONTINUE
     KEE = KEE/3.
     KEE = KEE*((KEE+KSW) - (1-VOIDF)*(KEE-KSW))/
            ((KEE+KSW)+(1-VOIDF)*(KEE-KSW))
     CEE = (VOIDF*CEE) + (1-VOIDF) *CPSW
     DO 200 I = 1.3
       DO 210 J = 1.3
          EBC(I, J) = (B(M, I) * B(M, J) + C(M, I) * C(M, J)) / EAREA(M)
          IF(I .EQ. J) THEN
            CM(I,J) = EAREA(M)/6.
          ELSE
            CM(I,J) = EAREA(M)/12.
          END IF
          CIJ(I,J) = CEE*CM(I,J)
          KIJ(I,J) = KEE \pm EBC(I,J)/4.
 210
        CONTINUE
 200 CONTINUE
      RETURN
      END
             SUBROUTINE THIRDB (THETAC, L, CONF, M)
C * THIS SUBROUTINE CALCULATES ELEMENT MATRICES DUE TO SURFACE *
C * INTEGRALS FOR CONVECTIVE BOUNDARY CONDITIONS
C **********************
       IMPLICIT REAL (K)
      COMMON/MATG/ AMC(140,151), RM(140), THETA(140), FLD(140),
                   AM(140,140), BM(140), CIJ(3,3), KIJ(3,3)
     &
            /TEPS/ TEMPR, TEMPI, TMEL, DETP, DELTD, TEMPG1(140), THETAG(140),
     8
                    THETAF (140), THETAO (140), THETTO (140), THETAB (70), TEMPD
     8
            /PROC/ HRSL, ALPAR, DIST, BI, KREF, ROUR, SPECR, EMIS, HTC(140, 3),
     ٤
                    BOLT, VOLSPR, WIDTH, QE (140, 3), NRESIS, RESIS, IX
     ٤
            /ELMT/ NEL, NP, GND(140, 3), B(140, 3), C(140, 3), EAREA(140), NPP1,
     8
                    IES(140,2),ESL(140,3),BETA,XC(140,3),YC(140,3),DEFO,
     ٤
                    NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70)
     8
      DIMENSION CONF(2,3), CONK(3,3), IE(2)
      BI = (DIST/KREF) * HTC(M, IES(M, L))
      IF(IES(M,L) .EQ. 1) THEN
```

```
IE(L) = 3
     ELSE
       IE(L) = IES(M,L) - 1.
     END IF
     DO 100 I = 1,3
       IF(I .EQ. IE(L)) THEN
         CONF(L,I) = 0.
       ELSE
         CONF(L,I) = BI * ESL(M, IES(M,L)) * THETAC/2.
       END IF
       DO 110 J = 1,3
         IF (I .EQ. IE (L) .OR. J .EQ. IE (L)) THEN
           CONK(I,J) = 0.
         ELSE IF(I .EQ. J) THEN
           CONK(I, J) = BI*ESL(M, IES(M, L))/3.
         ELSE
           CONK(I,J) = BI*ESL(M, IES(M,L))/6.
         END IF
110
       CONTINUE
 100 CONTINUE
     DO 200 I = 1,3
       DO 210 J = 1,3
         KIJ(I,J) = KIJ(I,J) + CONK(I,J)
 210
       CONTINUE
 200
     CONTINUE
     RETURN
     END
               SUBROUTINE SECNDB(L,QEF,M,NFLUX)
C * THIS SUBROUTINE CALCULATES ELEMENT MATRICES DUE TO SURFACE *
                                                             *
C * INTEGRALS FOR B.C.'S OF SECOND KIND, AND HEAT FLUX(QE) IS
C * CONSTANT BETWEEN NODES
IMPLICIT REAL (K)
     COMMON/TEPS/ TEMPR, TEMPI, TMEL, DETP, DELTD, TEMPG1(140), THETAG(140),
                  THETAF (140), THETAO (140), THETTO (140), THETAB (70), TEMPD
     Ł
           /PROC/ HRSL, ALPAR, DIST, BI, KREF, ROUR, SPECR, EMIS, HTC(140, 3),
     Ł
                  BOLT, VOLSPR, WIDTH, QE (140, 3), NRESIS, RESIS, IX
     Ł
           /ELMT/ NEL, NP, GND(140, 3), B(140, 3), C(140, 3), EAREA(140), NPP1,
     ۶
                  IES(140,2), ESL(140,3), BETA, XC(140,3), YC(140,3), DEFO,
     &
                  NE(140); TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70)
     ۶
     DIMENSION IE(2), QEF(2,3)
      INTEGER GND
      IF(IES(M,L) .EQ. 1) THEN
        IE(L) = 3
      ELSE
        IE(L) = IES(M,L) - 1
      END IF
C.....CONSTANT HEAT FLUX.....
С
      ESL = LENGTH OF SIDE
```

DLQE = DIMENSIONLESS CONSTANT HEAT FLUX ON SIDE OF ELEMENT

С

C

```
IF (NFLUX .EQ. 1) THEN
       IF (IES (M,L) .EQ. 1) THEN
         QES = QE(M, IES(M, L))
       ELSE
         QS = QE(M, IES(M, L))
         CALL FLUXD(M,QES)
       END IF
     ELSE
       QES = QE(M, IES(M, L))
     END IF
     DLQE = QES*DIST/(KREF*(TMEL - TEMPI))
     IF(IES(M,L) . EQ. 1) THEN
       QEF(L,1) = (ESL(M, IES(M,L))/2.) * DLQE
       QEF(L,2) = QEF(L,1)
       QEF(L,3) = 0.
     ELSE IF(IES(M,L) .EQ. 2) THEN
        QEF(L, 1) = 0.
        QEF(L,2) = (ESL(M, IES(M,L))/2.)*DLQE
        QEF(L,3) = QEF(L,2)
     ELSE
       QEF(L, 1) = (ESL(M, IES(M, L))/2.) * DLQE
        QEF(L, 2) = 0.
        OEF(L,3) = OEF(L,1)
     END IF
     RETURN
     END
            SUBROUTINE RADB(L, TS, NTS, RADF, M, RADK)
* THIS SUBROUTINE CALCULATES ELEMENT MATRICES DUE TO SURFACE
 * INTEGRALS FOR B.C.'S OF RADIATION.
C
IMPLICIT REAL (K)
      COMMON/MATG/ AMC(140,151), RM(140), THETA(140), FLD(140),
                   AM(140, 140), BM(140), CIJ(3, 3), KIJ(3, 3)
     8
     ٤
            /TEPS/ TEMPR, TEMPI, TMEL, DETP, DELTD, TEMPG1(140), THETAG(140),
     ٤
                   THETAF (140), THETAO(140), THETTO(140), THETAB(70), TEMPD
            /PROC/ HRSL, ALPAR, DIST, BI, KREF, ROUR, SPECR, EMIS, HTC (140, 3),
     δε
                   BOLT, VOLSPR, WIDTH, QE (140, 3), NRESIS, RESIS, IX
     8
            /ELMT/ NEL, NP, GND(140, 3), B(140, 3), C(140, 3), EAREA(140), NPP1,
     ۶
                   IES(140,2), ESL(140,3), BETA, XC(140,3), YC(140,3), DEFO,
     2
                   NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70)
      DIMENSION IE(2), RADF(2,3), RADK(3,3)
      INTEGER GNDN, GND1, GND2, GND, TS
      RADC = (DIST/KREF)*EMIS*BOLT
      DELTT = TMEL - TEMPI
      IF(IES(M,L) .EQ. 1) THEN
        IE(L) = 3
      ELSE
        IE(L) = IES(M,L) - 1
                                                         ORIGINAL PAGE IS
                                                         OF POOR QUALITY
```

END IF THETAR = (TEMPR - TMEL) / (TMEL - TEMPI)C.....CONSTANT BETA..... ETC = ESL(M, IES(M, L)) * THETARIF(IES(M,L) .EQ. 1) THEN GND1 = GND(M, 1)GND2 = GND(M, 2)ELSE IF (IES (M, L) .EQ. 2) THEN GND1 = GND(M, 2)GND2 = GND(M, 3)ELSE GND1 = GND(M, 1)GND2 = GND(M,3)END IF IF(TS .LE. NTS) THEN DTHETA = DELTT * (THETAG(GND1) + THETAG(GND2))/2. ELSE DTHETA = DELTT * (THETAO(GND1) + THETAO(GND2))/2. END IF RBETAC = RADC * ((DTHETA+TMEL)**2 + TEMPR**2)*(DTHETA+TMEL+TEMPR) DO 100 I = 1,3IF(I .EQ. IE(L)) THEN RADF(L, I) = 0.ELSE RADF(L,I) = ETC * RBETAC /2.END IF DO 110 J = 1,3IF(I .EQ. IE(L) .OR. J .EQ. IE(L)) THEN RADK(I,J) = 0.ELSE IF(I .EQ. J) THEN RADK(I,J) = RBETAC*ESL(M, IES(M,L))/3.ELSE RADK(I, J) = RBETAC*ESL(M, IES(M, L))/6.END IF 110 CONTINUE 100 CONTINUE DO 200 I = 1,3DO 250 J = 1,3KIJ(I,J) = KIJ(I,J) + RADK(I,J)250 CONTINUE 200 CONTINUE RETURN END SUBROUTINE FLUXD(M,QES) C * WHEN HEAT FLUX DEPEND ON TIME, CALCULATE HEAT FLUX ON BOUNDARY * ×. C * SURFACE BY LINEAR INTERPPLATION.

COMMON/ELMT/ NEL, NP, GND(140, 3), B(140, 3), C(140, 3), EAREA(140), NPP1, & IES(140, 2), ESL(140, 3), BETA, XC(140, 3), YC(140, 3), DEFO,

NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70) \$ /SPLIN/TIME(3), TIMER(20), QSTAG(20), XP1(25), CP1(4,25), ND1, å XP2(60), CP2(4, 60), ND2, XP3(25), CP3(4, 25), ND3, TS,£ XP4(25), CP4(4,25), ND4, XP5(15), CP5(4,15), ND5, XP6(15), & CP6(4,15), XP7(15), CP7(4,15), ND7, XP8(15), CP8(4,15), £ ND6, ND8, XP9(15), CP9(4, 15), ND9, XP0(15), CP0(4, 15), ND0, 8 ELSS(30), TESL(30)٤ INTEGER NL, NU, NTIME, TS, GND, PNOD, K, KM1, KM2 IF(TS .LT. 3) THEN LTS = TSELSE LTS = 3END IF K = 2KM1 = 1KM2 = KM1 - 1IF (GND(M,3) . EQ. -PNOD(1,KM1) . AND. GND(M,2) . EQ. PNOD(1,K))50 & THEN IF (KM1 .EQ. 1) THEN XI = TESL(1)/(2.*TLENG)ELSE XI = (TESL(KM2) + ELSS(KM1)/2.)/TLENGEND IF ELSE K = K + 1KM1 = K - 1KM2 = KM1 - 1GO TO 50 END IF QSCALE = PCUBIC(XI,ND1,XP1,CP1) TMI = TIME(LTS)QSFLUX = PCUBIC(TMI,ND2,XP2,CP2) QES = ABS (QSCALE) *QSFLUX RETURN END SUBROUTINE SPLINE(N.XI.C) ******************* * SUBROUTINE SPLINE USES GAUSS ELIMINATION TO CALCULATE C2.I = * * SI WITH GIVEN THE NUMBER S C1, I=FI, AND C2, I = S1, C2, N+1=SN+1* DIMENSION XI(60), C(4,60), D(60), DIAG(60) DATA DIAG(1), D(1)/1., 0./ NP = N+1DO 10 M = 2, NPD(M) = XI(M) - XI(M-1)DIAG(M) = (C(1,M) - C(1,M-1))/D(M)10 CONTINUE $DO \ 20 \ M = 2.N$ C(2,M) = 3.*(D(M)*DIAG(M+1) + D(M+1)*DIAG(M))DIAG(M) = 2.*(D(M) + D(M+1))20 CONTINUE

```
DO 30 M = 2,N

G = -D(M+1)/DIAG(M-1)

DIAG(M) = DIAG(M) + G^{*}D(M-1)

C(2,M) = C(2,M) + G^{*}C(2,M-1)

30 CONTINUE

DO 40 M = 2,N

NP = NP - 1

C(2,NP) = (C(2,NP)-D(NP)^{*}C(2,NP+1))/DIAG(NP)

40 CONTINUE

RETURN

END
```

SUBROUTINE CALCF(N,XI,C)

* WITH FI STORED IN C1,I AND SI STORED IN C2,I, SUBROUTINE * * CALCULATES C3, I, C4, I , I = 1.....N DIMENSION XI(60), C(4, 60)DO 10 I = 1,NDX = XI(I+1) - XI(I)DIVDF1 = (C(1,I+1) - C(1,I))/DXDIVDF3 = C(2, I) + C(2, I+1) - 2.*DIVDF1C(3,I) = (DIVDF1 - C(2,I) - DIVDF3)/DXC(4,I) = DIVDF3/DX/DX10 CONTINUE RETURN END FUNCTION PCUBIC(XBAR, N, XI, C) DIMENSION XI(60), C(4, 60)I = 1DX = XBAR - XI(I)IF(DX) 10,30,20 IF(I .EQ. 1) GO TO 30 10 - I = I - 1DX = XBAR - XI(I)IF(DX) 10, 30, 30 I = I + 119 DX = DDXIF(I .EQ. N) GO TO 30 20 DDX = XBAR - XI(I+1)IF(DDX) 30,19,19 PCUBIC = $C(1, I) + DX^{*}(C(2, I) + DX^{*}(C(3, I) + DX^{*}C(4, I)))$ 30 RETURN END SUBROUTINE FORMF(L, CONF, QEF, RADF, M)

C ******

C * THIS SUBROUTINE FORMS THE GLOBAL COLUMN VECTORS [FLD] *

```
COMMON/MATG/ AMC(140,151), RM(140), THETA(140), FLD(140),
                    AM(140,140), BM(140), CIJ(3,3), KIJ(3,3)
    Ł
            /ELMT/ NEL, NP, GND(140,3), B(140,3), C(140,3), EAREA(140), NPP1,
    $
                    IES(140,2),ESL(140,3),BETA,XC(140,3),YC(140,3),DEFO,
     8
                   NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70)
     æ
      DIMENSION CONF(2,3), QEF(2,3), RADF(2,3)
      INTEGER GND
      DO 100 I = 1,3
        II = GND(M, I)
        FLD(II) = FLD(II) + CONF(L, I) + QEF(L, I) + RADF(L, I)
 100 CONTINUE
      RETURN
      END
                       SUBROUTINE FORMGM(P,TS,NTS,M)
               С
               * FORMS SYSTEM MATRICES AM(I.J) AMD BM(I) *
С
               **************************************
С
      COMMON/MATG/ AMC(140,151), RM(140), THETA(140), FLD(140),
                    AM(140,140), BM(140), CIJ(3,3), KIJ(3,3)
     &
             /TEPS/ TEMPR, TEMPI, TMEL, DETP, DELTD, TEMPG1(140), THETAG(140),
     ٤
                    THETAF (140), THETAO (140), THETTO (140), THETAB (70), TEMPD
     8
            /PROC/ HRSL, ALPAR, DIST, BI, KREF, ROUR, SPECR, EMIS, HTC (140, 3),
     &
                    BOLT, VOLSPR, WIDTH, QE (140, 3), NRESIS, RESIS, IX
     ۶
             /ELMT/ NEL, NP, GND(140,3), B(140,3), C(140,3), EAREA(140), NPP1,
     &
                    IES(140.2), ESL(140.3), BETA, XC(140.3), YC(140.3), DEFO,
     æ
                    NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70)
     ٤
      DIMENSION THETAI(140)
      INTEGER GND.P.TS
      REAL KIJ
      IF (TS .LE. NTS) THEN
      DO 100 I = 1,3
         II = GND(M, I)
         THETAI(II) = (TEMPG1(II) - TMEL)/(TMEL - TEMPI)
 100 CONTINUE
      DO 200 I =1,3
         II = GND(M, I)
         DO 210 J = 1,3
           JJ = GND(M, J)
           KIJ(I,J) = KIJ(I,J) * WIDTH/DIST
           CIJ(I,J) = CIJ(I,J) *WIDTH/DIST
           AM(II,JJ) = AM(II,JJ) + (KIJ(I,J)*BETA + CIJ(I,J)/DEFO)
           BM(II) = BM(II) + (CIJ(I,J)/DEFO-(1.-BETA) * KIJ(I,J)) * THETAI(JJ)
 210
        CONTINUE
 200
      CONTINUE
       DO 300 I = 1, NP
         BM(I) = BM(I) + FLD(I)*WIDTH/DIST
      CONTINUE
  300
       ELSE
       DO 400 I = 1.3
                                                                 ORIGINAL PAGE IS
         II = GND(M, I)
                                                                 OF POOR QUALITY
         DO 410 J = 1.3
```

```
JJ = GND(M, J)
         KIJ(I,J) = KIJ(I,J) * WIDTH/DIST
         CIJ(I,J) = CIJ(I,J) * WIDTH/DIST
         AM(II,JJ) = AM(II,JJ) + 3.*KIJ(I,J)/4. + CIJ(I,J)/DEFO
         BM(II) = BM(II) + (CIJ(I,J)/DEFO)*THETAO(JJ)
                 - KIJ(1.J)*THETTO(JJ)/4.
    $
410
       CONTINUE
400 CONTINUE
     DO 420 I = 1, NP
       BM(I) = BM(I) + FLD(I)*WIDTH/DIST
420
     CONTINUE
     END IF
     RETURN
     END
     SUBROUTINE GLOBMAX (TEMP. TEMPC. M. DUMK. NLEM. NFLUX. NRAD. NTS. IFN)
C* THIS SUBROUTINE ASSUMBLE ELEMENT MATRIX AND BOUNDARY CONDITION *
C* INTO GLOBAL SYSTEM MATRIX [AMC] EXCEPT SPECIFIED TEMPERATURE.
COMMON/MATG/ AMC(140,151), RM(140), THETA(140), FLD(140),
    &
                 AM(140, 140), BM(140), CIJ(3, 3), KIJ(3, 3)
    å
           /TEPS/ TEMPR, TEMPI, TMEL, DETP, DELTD, TEMPG1(140), THETAG(140),
                  THETAF (140), THETAO (140), THETTO (140), THETAB (70), TEMPD
    8
    $
           /PROC/ HRSL, ALPAR, DIST, BI, KREF, ROUR, SPECR, EMIS, HTC (140,3),
                 BOLT, VOLSPR, WIDTH, QE (140, 3), NRESIS, RESIS, IX
    5
    8
           /ELMT/ NEL, NP, GND(140,3), B(140,3), C(140,3), EAREA(140), NPP1.
                  IES (140, 2), ESL (140, 3), BETA, XC (140, 3), YC (140, 3), DEFO,
    8
    ٤
                 NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70)
    &
           /SPLIN/TIME(3),TIMER(20),QSTAG(20),XP1(25),CP1(4,25),ND1,
                 XP2(60), CP2(4,60), ND2, XP3(25), CP3(4,25), ND3, TS,
    &
     å
                  XP4(25), CP4(4,25), ND4, XP5(15), CP5(4,15), ND5, XP6(15),
                  CP6(4,15),XP7(15),CP7(4,15),ND7,XP8(15),CP8(4,15),
     å
     å
                  ND6, ND8, XP9(15), CP9(4, 15), ND9, XP0(15), CP0(4, 15), ND0,
                  ELSS(30), TESL(30)
     å
      INTEGER M.NLEM, L.P., IFN, TS
     DIMENSION TEMP (3), DUMK (140), CONK (3,3), RADK (3,3), CONF (2,3),
               QEF(2,3), RADF(2,3), TEMPC(140,3)
     £
CALL CONCP (X, Y, TEMP, M, DUMK, NLEM)
C TO EVALUATE SURFACE INTEGRAL (CONVECTION , HEAT FLUX,
C RADIATION BOUNDARY CONDITIONS)
DO 100 I = 1,3
        DO 150 J = 1,3
         CONK(I, J) = 0.
         RADK(I, J) = 0.
 150
        CONTINUE
```

100 CONTINUE DO 200 I = 1, NPFLD(I) = .0.0200 CONTINUE DO 300 L = 1,2DO 350 I = 1,3CONF(L, I) = 0.QEF(L, I) = 0.RADF(L, I) = 0.350 CONTINUE IF (HTC (M, IES (M, L)) .GT. 0.) THEN THETAC = (TEMPC(M, IES(M,L)) - TMEL)/(TMEL - TEMPI) CALL THIRDB (THETAC, L, CONF, M) END IF IF (QE (M, IES (M, L)) .NE. 0.) THEN CALL SECNDB(L,QEF,M,NFLUX) END IF IF (HTC (M, IES (M, L)) .GE. 0. .AND. NRAD .EQ. 1) THEN CALL RADB(L, TS, NTS, RADF, M, RADK) END IF C TO ASSEMBLE THE GLOBAL COLUMN VECTOR [FLD] CALL FORMF(L,CONF,QEF,RADF,M) 300 CONTINUE C....TO ASSEMBLE ELEMENT MATRIX INTO GLOBAL SYSTEM MATRIX[AMC]..... CALL FORMGM (P, TS, NTS, M) RETURN END SUBROUTINE FIRSTBC(IFN) C * THIS SUBROUTINE ENTERS THE SPECIFIED BOUNDARY * C * TEMPERATURES IN A SYSTEM OF EQUATIONS. * COMMON/MATG/ AMC(140,151), RM(140), THETA(140), FLD(140), AM(140,140), BM(140), CIJ(3,3), KIJ(3,3) å /TEPS/ TEMPR, TEMPI, TMEL, DETP, DELTD, TEMPG1 (140), THETAG (140), Ł THETAF (140), THETAO (140), THETTO (140), THETAB (70), TEMPD & /ELMT/ NEL,NP,GND(140,3),B(140,3),C(140,3),EAREA(140),NPP1, ۵ IES(140,2),ESL(140,3),BETA,XC(140,3),YC(140,3),DEFO, ۶ NE(140), TLENG, PNOD(5,30), EBC(3,3), CM(3,3), GNDB(70) 8 INTEGER GNDB DO 100 I = 1, IFNII = GNDB(I)IF(II .LT. 0) THEN GO TO 100 ELSE ORIGINAL PAGE IS BM(II) = THETAB(I)OF POOR QUALITY DO 110 J = 1, NP

```
IF(II .EQ. J) THEN

AM(II,J) = 1.

ELSE

BM(J) = BM(J) - THETAB(I)*AM(J,II)

AM(II,J) = 0.

AM(J,II) = 0.

END IF

110 CONTINUE

END IF

100 CONTINUE

RETURN

END
```

SUBROUTINE RESIDUL (RMAX)

C * THIS SUBROUTINE CALCULATE RESIDUALS AT EVERY NODES * COMMON/MATG/ AMC(140,151), RM(140), THETA(140), FLD(140), AM(140,140), BM(140), CIJ(3,3), KIJ(3,3) & å /TEPS/ TEMPR, TEMPI, TMEL, DETP, DELTD, TEMPG1(140), THETAG(140), å THETAF (140), THETAO (140), THETTO (140), THETAB (70), TEMPD 8 /ELMT/ NEL, NP, GND(140, 3), B(140, 3), C(140, 3), EAREA(140), NPP1, & IES(140,2), ESL(140,3), BETA, XC(140,3), YC(140,3), DEFO, NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70) ۶ DO 100 I = 1, NPDO 110 J = 1, NPRM(I) = RM(I) + AM(I, J) * THETA(J)110 CONTINUE RM(I) = RM(I) - BM(I)100 CONTINUE RMIN = 10000.RMAX = 0.DO 200 I = 1, NPIF (ABS (RM(I)) .GT. RMAX) THEN RMAX = ABS(RM(I))END IF IF (ABS (RM(I)) .LT. RMIN) THEN RMIN = ABS(RM(I))END IF 200 CONTINUE RETURN END

SUBROUTINE CHLSKY (TS, NTS, THETAX)

k

COMMON/MATG/ AMC(140,151), RM(140), THETA(140), FLD(140),

```
8
                    AM(140, 140), BM(140), CIJ(3, 3), KIJ(3, 3)
            /TEPS/ TEMPR, TEMPI, TMEL, DETP, DELTD, TEMPG1(140), THETAG(140),
     8
                    THETAF (140), THETAO (140), THETTO (140), THETAB (70), TEMPD
     8
             /ELMT/ NEL, NP, GND(140, 3), B(140, 3), C(140, 3), EAREA(140), NPP1,
     &
                    IES(140,2), ESL(140,3), BETA, XC(140,3), YC(140,3), DEFO,
     3
                    NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70)
     £
      DIMENSION THETAX(140)
      INTEGER TS
       DO 100 I = 1, NP
         DO 110 J = 1, NP
            AMC(I,J) = AM(I,J)
  110
         CONTINUE
  100 CONTINUE
C..TO SUBSTITUE RM(I) OR BM(I) INTO THE NPP1TH COLUMN OF MATRIX AMC(NP,NPP1)..
      DO 120 I = 1, NP
        IF(TS .LE. NTS) THEN
           AMC(I,NPP1) = AMC(I,NPP1) - RM(I)
        ELSE
           AMC(I,NPP1) = AMC(I,NPP1) + BM(I)
         END IF
 120 CONTINUE
C....TO CALCULATE FIRST ROW OF UPPER UNIT TRIANGULAR MATRIX....
      DO 200 J = 2, NPP1
         AMC(1, J) = AMC(1, J) / AMC(1, 1)
 200 CONTINUE
C....TO CALCULATE OTHER ELEMENTS OF U AND L MATRICES....
       DO 300 I = 2, NP
         J = I
         DO 310 II = J,NP
           SUM = 0.
           JM1 = J - 1
           DO 320 K = 1, JM1
             SUM = SUM + AMC(II,K) * AMC(K,J)
 320
           CONTINUE
           AMC(II, J) = AMC(II, J) - SUM
 310
         CONTINUE
         IP1 = I + \cdot 1
         DO 330 JJ = IP1, NPP1
           SUM = 0.
            IM1 = I - 1
            DO 340 \text{ K} = 1, \text{IM1}
              SUM = SUM + AMC(I,K) * AMC(K,JJ)
  340
            CONTINUE
            AMC(I,JJ) = (AMC(I,JJ) - SUM) / AMC(I,I)
  330
         CONTINUE
  300 CONTINUE
                                                                     ORIGINAL PAGE IS
 C....TO SOLVE FOR THETAX(I) BY BACK SUBSTITUTION....
```

OF POOR QUALITY

```
THETAX(NP) = AMC(NP, NPP1)

L = NP - 1

DO 400 NN = 1,L

SUM = 0.

I = NP - NN

IP1 = I + 1

DO 410 J = IP1, NP

SUM = SUM + AMC(I,J) * THETAX(J)

410 CONTINUE

THETAX(I) = AMC(I,NPP1) - SUM

400 CONTINUE

RETURN

END
```

SUBROUTINE INTFLUX (JFNT, JNT, TVU, TEMPV, TEMPS, QEI)

```
C * THIS SUBROUTINE CALCULATE HEAT FLUX AT LIQUID - VAPOR INT- *
C * FACE BY USING KINETIC THEORY WITH VAPOR AND INTERFACE TEMP*
DIMENSION GNDI (70), TEMPS (70), TEMPV (70), QEI (70), MASW (70)
     INTEGER GNDI
     REAL MASW
     KP = 0
     DO 50 I = 1, JFNT
       QEI(I) = 0.
50
      CONTINUE
     DO 100 I = 1, JNT
       TW = TEMPS(I)
       TV = TVU
       CALL NAVPROP(TW, DENV, VISV, HFG, HG, PSATI, KP)
       CALL NAVPROP(TV, DENV, VISV, HFGV, HG, PSATV, KP)
       MASW(I) = (2.*.7*(23./(2.*3.1416*8314.))**.5)*(PSATI/TW**.5
                - PSATV/TV**.5)
    Ł
       QEI(I) = MASW(I) * HFG
100
     CONTINUE
     RETURN
      END
```

SUBROUTINE COUPLE(JNT,QT,TVU,JFNT)

C*****************	* * * * * * * * * * * * * * * * * * * *
C* THIS SUBROUTINE	CALCULATES THERMAL RESISTANCE IN THE VAPOR *
C* SPACE BY USING H	NOWN HEAT FLUX AND EVALUATES NEW HEAT FLUX *
C* AND VAPOR TEMPER	* *
C****	's is it
COMMON/MATG/	AMC(140,151), RM(140), THETA(140), FLD(140),
<u>لا</u>	AM(140,140), BM(140), CIJ(3,3), KIJ(3,3)
& /TEPS/	TEMPR, TEMPI, TMEL, DETP, DELTD, TEMPG1(140), THETAG(140),
â	THETAF (140), THETAO (140), THETTO (140), THETAB (70), TEMPD
	· · · · · · · · · · · · · · · · · · ·

```
Ł
           /PROC/ HRSL, ALPAR, DIST, BI, KREF, ROUR, SPECR, EMIS, HTC(140,3),
    8
                   BOLT.VOLSPR.WIDTH.QE(140.3),NRESIS.RESIS.IX
            /ELMT/ NEL, NP, GND(140, 3), B(140, 3), C(140, 3), EAREA(140), NPP1,
    ۶
                   IES(140,2), ESL(140,3), BETA, XC(140,3), YC(140,3), DEFO,
    å
                   NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70)
    8
            /INOUT/TEMPS(70), TEMPV(70), TEMPVS(70), QEI(70), VX(70),
    ٤
                   GNDI (70) .VY1 (70) .VY2 (70) .VY3 (70) .ELSI (30) .
    8
                   VY4(70), VY5(70), VY6(70), HFG, TEMPF(70)
    å
           /SPLIN/TIME(3), TIMER(20), QSTAG(20), XP1(25), CP1(4,25), ND1,
    å
                   XP2(60), CP2(4,60), ND2, XP3(25), CP3(4,25), ND3, TS,
    3
                   XP4(25), CP4(4,25), ND4, XP5(15), CP5(4,15), ND5, XP6(15),
    8
                   CP6(4,15), XP7(15), CP7(4,15), ND7, XP8(15), CP8(4,15),
    8
    $
                   ND6, ND8, XP9(15), CP9(4, 15), ND9, XP0(15), CP0(4, 15), ND0,
    ۶
                   ELSS(30), TESL(30)
            /OUTPT/MO, IDAY, IYEAR, TITLE, CASE, NUMBER, NO, TEMPCC, HTCC, IOUT,
    $
                   TIMEN, DELT, DELT1, DELTP
    S.
     INTEGER JNT, IX, JNTL, JFNT
     REAL JCOB
     DIMENSION QT(70)
      JNT = NUMBER OF NODE WHOSE TEMPERATURE IS GREATER THAN TSTAR
      JNTL = NUMBER OF NODE WHOSE TEMPERATURE IS GREATER THAN TVU
      TEMPD = TEMP. DROP IN VAPOR SPACE [K]
      RESIS = RESISTANCE IN VAPOR SPACE [K/W]
      RESISN = ARTIFICIALLY ADDED RESISTANCE AT EACH NODE
      TEMPF(I) = TEMP. DROP DUE TO NEW RESISTANCE AT INTERFACE
      OTAL = 0.0
      IF (NRESIS .EQ. 2) THEN
        DO 100 I = 1.JNT
           QEI(I) = QT(I)
100
        CONTINUE
      END IF
      NRESIS = 2
      DO 150 I = 1, JNT
         IF (TEMPS(I) .GT. TVU) THEN
           JNTL = I
        ELSE IF (TEMPS(I) .LT. TVU .AND. TEMPS(I-1) .GT. TVU)
    å
         THEN
           XII = (TEMPS(JNTL) - TVU) * ELSI(I)
           XII = XII/(TEMPS(JNTL)-TEMPS(I))
         END IF
150
      CONTINUE
      DO 200 I = 1, JNT
         IF(QEI(I) .GT. 0.) THEN
           QTAL = QTAL • QEI(I)*ELSI(I)*WIDTH
         END IF
200
         CONTINUE
         QEI(JFNT) = 0.
         IF(IX .LE. 1) THEN
           CALL HPVAPOR (JNT, TS, DIST, IND, TIME)
           TEMPD = VY4(1) - VY4(JNT)
                                                                  ORIGINAL PAGE IS
           RESIS = TEMPD/OTAL
                                                                  OF POOR QUALITY
           RESIS = RESIS/23.
```

С

С

С

С

С

С

END IF

IF(IX .LE. 100) THEN IF (TEMPD .LE. 20.) THEN RESISN = RESISELSE RESISN = RESIS*IX*.01 END IF IX = IX + 1IF(IX .EQ. 100) THEN IX = 1END IF END IF DO 250 I = 1, JNTTEMPF(I) = RESISN*QEI(I)*WIDTH*ELSI(I) TEMPS(I) = TEMPS(I) - TEMPF(I)250 CONTINUE RESD = 0. 500 TELSI = 0. RESDC = 4.5E6*1.4*.021*2.29E11DO 260 I = 1, JNTRESDI = ELSI(I) * 10. * (-5567. / TEMPS(I)) / TEMPS(I)RESDV = ELSI(I)*10.**(-5567./TVU)/TVU RESD = RESD + RESDC*(RESDI - RESDV) TELSI = TELSI + ELSI(I)260 CONTINUE JCOB = (1 - 12818.5/TVU) * TELSIJCOB = JCOB * 10.**(-5567./TVU) JCOB = RESDC*JCOB/(TVU**2)TVO = TVUTVU = TVO - RESD/JCOBIF (ABS (RESD) .LT. .01) THEN CALL INTFLUX (JFNT, JNT, TVU, TEMPV, TEMPS, QEI) DO 270 I = 1, JNTQT(I) = QEI(I)270 CONTINUE ELSE GO TO 500 END IF RETURN END

C.....FOLLOWING SUBROUTINES ARE USED TO CALCULATE PRESSURE, VELOCITY, C.....DENSITY, TEMPERATURE, AND QUALITY IN VAPOR SPACE.....

SUBROUTINE HPVAPOR (JNTD, TS, DDIST, IND, TIME)

VARIABLES

С

С HEIGHT OF THE VAPOR SPACE[M] С DIST INCREMENT IN AXIAL DIRECTION [M] INTV С MASS FLOW AT WALL [KG/M**2] С MASW WALL TEMPERATURE [K] С TW NUMBER OF POINTS WHERE DATA ARE CALCULATED с JNT HEAT FLUX [W/M**2] С OW COMMON/VAPOR/ REYW(70), II, JNT, DIST, TW, QW, MASW, PSAT, Y1N, Y2N, Y3N, Y4N, Y6N & /INOUT/ TEMPS(70), TEMPV(70), TEMPVS(70), QEI(70), VX(70), ٤ GNDI (70), VY1 (70), VY2 (70), VY3 (70), ELSI (30), ٤ VY4(70), VY5(70), VY6(70), HFG, TEMPF(70) 8 DIMENSION C(24), W(5,9), TWI(70), Y(6), MACH(70), TIME(3) INTEGER II, N, NW, IND, GNDI, TS REAL MASW, MASWN, INTV, XEND, MACH, JCOB EXTERNAL FCN1 C.....INITIAL PARAMETERS..... = NUMBER OF DIFFERENTIAL EQUATIONS С N Y(1) = PRESSURE OF VAPOR [N/M**2] С Y(2) = VELOCITY[M/SEC.] С Y(3) = DENSITY[KG/M**3]С Y(4) = TEMPERATURE[K]С Y(5) = QUALITY OF VAPOR С Y(6) = SPECIFIC VOLUME [M**3/KG] С DIST = DDIST JNT = JNTD PH = 0.N = 5NW = NIND = 1TOL = .0001C.....CALAULATE INITIAL VALUES..... CALL INITV Y(4) = TEMPV(2)Y(1) = 2.29E11/(Y(4)**.5)*10.**(-5567./Y(4)) Y(3) = 23.*Y(1)/(8314.*Y(4))Y(5) = 1.Y(6) = 1./Y(3)KP = 1CALL NAVPROP(TEMPV(2), DENV, VISV, HFG, HG, PSATI, KP) Y(2) = QEI(1)*ELSI(1)/(HFG*DIST*Y(3)) C.....SET REFERENCE, VALUE TO NORMALIZE..... Y1N = Y(1)Y2N = Y(2)Y3N = Y(3)Y4N = Y(4)

ORIGINAL PAGE IS OF POOR QUALITY Y6N = Y(6) VX(1) = 0.0 VX(2) = ELSI(1) VY2(1) = 0.0 VY2(2) = Y(2) DO 100 I = 1,2 VY1(I) = Y(1) VY3(I) = Y(3) VY4(I) = Y(4) VY5(I) = Y(5) VY6(I) = Y(6) 100 CONTINUE TWI(1) = TEMPS(1) TWI(2) = TEMPS(2)

5

&

C.....CALCULATE P,V,DENSITY,T,QUALITY BY USING DVERK.....

DO 200 II = 3, JNT + 1 IM1 = II - 1 QW = QEI(IM1) PH = PH + 1 IF(PH .NE. 1.)THEN IND = 1 END IF INTV = ELSI(IM1) XEND = VX(II-1) + INTV VX(II) = XEND X = VX(IM1)

C.....NORMALIZE THE DEPENDANT VARIABLES.....

Y(1) = VY1(IM1)/Y1NY(2) = VY2(IM1)/Y2NY(3) = VY3(IM1)/Y3NY(4) = VY4(IM1)/Y4NY(5) = VY5(IM1)Y(6) = VY6(IM1)/Y6NIF(PH .EQ. 1.) THEN TW = TEMPS(II)ELSE TW = TWI(II)END IF CALL DVERK(N, FCNL, X, Y, XEND, TOL, IND, C, NW, W, IER) IF(IND .LT. 0 .OR. IER .GT. 0) THEN WRITE(4,*) IND, IER GO TO 300 END IF Y1 = Y(1) * Y1NY2 = Y(2) * Y2NY3 = Y(3) * Y3NY4 = Y(4) * Y4NMASWN = 2.*.7*(23./(2.*3.1416*8314.))**.5*(PSAT/TW**.5 - Y1/Y4**.5)DMAS = (MASW - MASWN) / (MASW)IF (ABS (DMAS) .LT. .02) THEN

```
VY1(II) = Y(1)*Y1N
          VY2(II) = Y(2) * Y2N
          VY3(II) = Y(3)*Y3N
          VY4(II) = Y(4)*Y4N
          VY5(II) = Y(5)
          VY6(II) = 1./VY3(II)
          \text{TEMPV}(\text{II}) = \text{VY4}(\text{II})
          TWI(II) = TW
          PH = 0.
        ELSE
          HFG = 4636437. - 180.82*TW
           RESD = MASW - MASWN
           JCOB = 180.82*QW/(HFG**2)
           JCOB = JCOB = 2.*.7*((23./(2.*3.1416*8314.))**.5)
               *(2.29E11*(12818.8/TW - 1.)*(10.**(-5567./TW))/TW**2)
    &
           TW = TW - (RESD/JCOB)
           TWI(II) = TW
           GO TO 5
         END IF
200
      CONTINUE
300
      CONTINUE
      IJNT = 2*JNT/3
      WRITE(6,400) TIME(3)
      WRITE(6,410) QW, DIST, INTV, REYW(2), REYW(IJNT)
      WRITE(6,420)
      WRITE(6,430)
      DO 350 II = 1, JNT+1
         MACH(II) = VY2(II)/SQRT(1.4*8314.*VY4(II)/23.)
         WRITE(6,440) VX(II),VY1(II),VY2(II),VY3(II),VY4(II),
                        VY5(II), MACH(II)
    &
      CONTINUE
350
      FORMAT(/2X,83('-')/28X,'**TIME = ',F9.3,2X,'SEC**'/)
FORMAT(4X,'HEAT INPUT = ',F8.1,2X,'DIST = ',F6.4,2X,'INTV = ',
400
410
    \& F5.3,3X, 'REYNOLD = ', F6.1,2X, F6.1/)
       FORMAT(8X, 'XL(I)', 6X, 'PRESSURE', 4X, 'VELOCITY', 5X,
420
              'DENSITY', 5X, 'TVAP', 6X, 'QUAL', 5X, 'MACH'/)
    8
       FORMAT(10X, 'M', 9X, 'N/M**2', 7X, 'M/SEC', 6X, 'KG/M**3', 7X, 'K',
430
              30X,/2X,83('-')/)
     å
440 FORMAT (5X, E9.2, 2X, E11.5, 2X, E10.3, 3X, E10.4, 2X, F7.2, 3X, F6.3, 3X, F6.3)
       RETURN
```

SUBROUTINE INITV

END

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```
NN = 0
      KP = 0
      PHI = 3.1416
      UGAS = 8314.
      TWI = TEMPS(2)
      TVI = TWI - .1
      CALL NAVPROP (TWI, DENV, VISV, HFG, HG, PSATW, KP)
100
      CALL NAVPROP(TVI, DENV, VISV, HFGV, HG, PSATV, KP)
      NN = NN + 1
      MASW = 2.*.7*(23./(2.*PHI*UGAS))**.5*(PSATW/TWI**.5
    ۶
             - PSATV/TVI**.5)
      QEIN = MASW*HFG
      DQEI = (QEIN - QEI(1))/QEIN
      IF (NN .LT. 5) THEN
      IF (ABS (DQEI) .LT. .01) THEN
        TEMPV(1) = TVI
        TEMPV(2) = TVI
      ELSE
        RESD = QEI(1) - QEIN
        JCOB = 2.*.7*HFG*(23./(2.*PHI*UGAS))**.5
        JCOB = JCOB * 2.29E11*10.**(-5567./TVI)/(TVI**2)
        JCOB = JCOB^{(12818.5/TVI-1.)}
        TVI = TVI - RESD/JCOB
        GO TO 100
      END IF
      END IF
      RETURN
      END
                 SUBROUTINE FCN1 (N.X.Y, YPR)
C * THIS SUBROUTINE PROVIDE DERIVITIVE OF GOVERNING EQUATIONS *
COMMON/VAPOR/ REYW(70), II, JNT, DIST, TW, QW, MASW, PSAT, Y1N, Y2N,
    Ł
                    Y3N, Y4N, Y6N
            /INOUT/ TEMPS(70), TEMPV(70), TEMPVS(70), QEI(70), VX(70),
    å
    å
                    GNDI (70), VY1 (70), VY2 (70), VY3 (70), ELSI (30),
    å
                    VY4(70), VY5(70), VY6(70), HFG, TEMPF(70)
      DIMENSION YPR(5), Y(6)
      REAL MASW
      IM1 = II - 1
      Y(6) = VY6(IM1)
      KP = 0
      CALL NAVPROP(TW, DENW, VISW, HFG, HGW, PSAT, KP)
      MASW = OW/HFG
      VW = MASW/(DENW)
      REYW(IM1) = - DENW*VW*DIST/VISW
      HCP = 904.
C.....THIS SUBROUTINE CALCULATES ALPAR, BETA, F2PO, AND F2P1.....
```

CALL FACTOR (ALPAR, BETA, F2P0, F2P1)

. .

```
TEMPK = Y(4) + Y4N
      KP = 1
      CALL NAVPROP (TEMPK, DDEN, VISV, HFGV, HG, DPAST, KP)
      Y1 = Y(1) * Y1N
      Y2 = Y(2) * Y2N
      Y3 = Y(3) * Y3N
      Y4 = Y(4) * Y4N
      Y6 = Y(6)
     RSTA = 8314./23.
      SPEV = 1./Y3
      SPEVF = 1./((.927 - .238E-3*(Y4 - 373))*1000.)
      IF(Y(5) .LE. 0.) THEN
        SPEVG = 0.
      ELSE IF (Y(5) . GT. 1.) THEN
        Y(5) = 1.
        SPEVG = SPEV
        SPEVF = 0.
      ELSE
        SPEVG = (SPEV - SPEVF) / Y(5) + SPEVF
      END IF
      SPERI = (SPEVG - SPEVF)/SPEV
      RTH = (1. - RSTA^*Y4/HFG\hat{\nabla})
      FIC = 8.*VISV*(F2P0 - F2P1)/(Y3*DIST*Y2)
      PY1 = ALPAR*MASW/(BETA*Y2*DIST)
      PY2 = 2.*HFGV
       PY3 = SPERI*(HGW-HG+(BETA*Y2**2)/2.+(VW**2)/2.)
       PY4 = HFGV/(BETA*SPEV)
       PY5 = SPERI/SPEV*Y2**2
       PY6 = - PY1*(PY2 + PY3)
       PY7 = PY6 - (PY4+PY5)*FIC/(8.*DIST)
       PY8 = ALPAR*HFGV*Y(5)*SPEVG*RTH/(BETA*Y1*SPEV**2)
       PY9 = ALPAR*SPERI*HCP*RSTA*Y4**2/(BETA*SPEV*HFGV*Y1)
       PY10 = SPERI + HFGV/(BETA*Y2**2) - PY8 - PY9
       PY = PY7/PY10
       YPR(1) = PY/Y1N
C.....CALCULATE THE DERIVITIVE OF QUALITY.....
       OUAL1 = (Y2^{**}2)^{*}Y(5)^{*}SPEVG^{*}RTH/(Y1^{*}SPEV^{**}2)
       QUAL2 = (-1./ALPAR + QUAL1)*PY
       QUAL3 = FIC*Y2**2/(8.*DIST*SPEV*ALPAR)
       QUAL4 = SPERI*Y2**2/SPEV
       QUAL5 = (QUAL2 - QUAL3)/QUAL4
```

```
QUAL6 = 2.*MASW*SPEV/(Y2*DIST*SPERI)
QUAL = QUAL5 - QUAL6
YPR(5) = QUAL
```

C.....CALCULATE THE DERIVITIVE OF VELOCITY.....

VEL1 = MASW*SPEV/DIST VEL2 = Y2*SPERI*QUAL VEL3 = Y2*Y(5)*SPEVG*(-RTH)*PY/(Y1*SPEV) ORIGINAL PAGE IS OF POOR QUALITY

```
VEL = VEL1 + VEL2 + VEL3
YPR(2) = VEL/Y2N
```

C.....CALCULATE THE DERIVITIVE OF DENSITY.....

```
ROU1 = SPERI*QUAL/SPEV

ROU2 = SPEVG*Y(5)*RTH*PY/(Y1*SPEV**2)

ROU = -ROU1 + ROU2

YPR(3) = ROU/Y3N

TY = PY*RSTA*Y4**2/(Y1*HFGV)

YPR(4) = TY/Y4N

RETURN

END
```

SUBROUTINE NAVPROP (TEMPK, DENV, VISV, HFG, HG, PSAT, KP)

```
C * THIS SUBROUTINE CALCULATES THE PROPERITIES OF THE SODIUM SUCH AS *
C * THE SATURATION PRESSURE, THE DENSITY, THE VISCOSITY, THE LATENT
                                                         72
C * HEAT OF VAPORIZATION, AND THE ENTHALPY.
T = TEMPK
      IF (KP . EQ. 0) THEN
      PSAT = (2.29E11/T^{**}.5)^{*10.**}(-5567./T)
      ELSE
      PSAT = 0.
      END IF
      DENV = 2.766E-3*PSAT/T
      VISV = 6.083E - 9*T + 1.2606E - 5
     HF = 98.973 + 1.4367 * (T - 273.16)
     HF = HF - 2.902E - 4*(T - 273.16)*2
      HF = 1000.*(HF + 2.4E4*EXP(-1.36E4/T))
      HFG = 182.*(25474.93 - .9935*T)
      HG = HF + HFG
      RETURN
      END
      SUBROUTINE FACTOR (ALPAR, BETA, F2P0, F2P1)
C * THIS SUBROUTINE PROVIDES THE VALUES OF ALPAR, BETA, F2PO, *
C * AND F2P1 CORRESPONDING TO THE GIVEN REYNOLDS NUMBERS.
                                                 75
COMMON/VAPOR/ REYW(70), II, JNT, DIST, TW, QW, MASW, PSAT, Y1N, Y2N,
    $
                 Y3N, Y4N, Y6N
      REYW1 = REYW(II-1)
      REYW2 = REYW1^{**2}
      IF(REYW1 .LT. 2. .AND. REYW1 .GT. -30.) THEN
       F2P0 = 6.0995 - .42198*REYW1 - 3.8013E-3 * REYW2
       F2P1 = -5.6405 - .2349 * REYW1 - 5.2913E - 3 * REYW2
       ALPAR = 1.2049 - 1.0386E - 3*REYW1
```

```
BETA = 1.5574 - 3.1837E-3*REYW1
      ELSE IF (REYW1 .GE. 2.) THEN
        F2P0 = 6.0995 - .42198*REYW1 - 3.8013E+3 * REYW2
        F2P1 = -6.548 - .1417*REYW1 - .1233*REYW2
        ALPAR = 1.22 - 1.5082E - 2 * REYW1 + 2.6689E - 3*REYW2
        BETA = 1.612 - 5.0904E-2 * REYW1 + 8.6570E-3*REYW2
      ELSE IF (REYW1 .LE. -30.) THEN
        F2P0 = 15.34 - .223*(REYW1 + 30)
        F2P1 = -3.06
        ALPAR = 1.227
        BETA = 1.63
      END IF
      RETURN
      END
      SUBROUTINE NEWRA(JNT, KN, QEI, QEIN, TEMPS, TEMPV, QW)
* CALCULATE NEW WALL TEMPERATURE BY USING NEWTON-RAPHSON *
 * METHOD FOR NEXT ITERATION.
 ******************
      DIMENSION TEMPS(70), TEMPV(70), QEI(70), QEIN(70)
      REAL MASW, MASWN, JCOB
      DO 100 I = 2, JNT+1
        TW = TEMPS(I)
        TV = TEMPV(I)
        MASW = QEI(I)
        MASWN = QEIN(I)
        RESD = MASW - MASWN
        JCOB = -364.*.7*(SORT(23./(2.*3.1416*8314.)))
        *((2.29E11*(10.**(-5567./TW))/TW)
    £
        *(-.9935 + (25474.93 - .9935*TW)*((12818.5-TW)/TW**2))
    £
        + .9935*(2.29E11/TV)*10.**(-5567./TV))
    £
        TW = TW - RESD/JCOB
 100
      CONTINUE
      RETURN
      END
              SUBROUTINE DATAIN (TA, JK, JNT, TIMEN,
                    FIRTS, TVU, QT, TEMPD)
    8
C* THIS SUBROUTINE READS IN INTERMEDIATE DATA FOR RESTARTING OF *
C* MAIN PROGRAM FROM LAST RUN
COMMON/PROC/ HRSL, ALPAR, DIST, BI, KREF, ROUR, SPECR, EMIS, HTC (140, 3),
                  BOLT, VOLSPR, WIDTH, QE (140, 3), NRESIS, RESIS, IX
     Ł
           /ELMT/ NEL, NP, GND(140,3), B(140,3), C(140,3), EAREA(140), NPP1,
     â
                  IES(140,2), ESL(140,3), BETA, XC(140,3), YC(140,3), DEFO,
     ٤.
                  NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70)
     8
           /INOUT/ TEMPS(70), TEMPV(70), TEMPVS(70), QEI(70), VX(70),
     6
```

C C

C

GNDI (70), VY1 (70), VY2 (70), VY3 (70), ELSI (30), \$ VY4(70), VY5(70), VY6(70), HFG, TEMPF(70) ٤ /SPLIN/TIME(3), TIMER(20), QSTAG(20), XP1(25), CP1(4,25), ND1, Ł XP2(60), CP2(4,60), ND2, XP3(25), CP3(4,25), ND3, TS, 8 XP4(25), CP4(4,25), ND4, XP5(15), CP5(4,15), ND5, XP6(15), 8 CP6(4,15), XP7(15), CP7(4,15), ND7, XP8(15), CP8(4,15), 8 ND6, ND8, XP9(15), CP9(4, 15), ND9, XP0(15), CP0(4, 15), ND0, 8 ELSS(30), TESL(30)8 DIMENSION TA(3,96), QT(70)INTEGER TS, JK, JNT, NPP1, FIRTS **REWIND 8** READ(8,*) TS, FIRTS, JK, JNT, NRESIS, IX READ(8,*) NPP1, TIMEN, RESIS, TEMPD IF(TS .LE. 3) THEN LTS = TS ELSE LTS = 3END IF READ(8,*) (TIME(I), I=1, LTS), TVU, DEFO READ(8,*) ((TA(I,J),I=2,3),J=1,NP) IF (FIRTS .GT. 1) THEN READ(8,*) ((QE(I,J),J=1,2),I=1,NEL) READ(8,*) (QT(I), I=1, JNT) END IF RETURN END SUBROUTINE DATAOUT (TA, JK, JNT, TIMEN, FIRTS, TVU, QT, TEMPD) ٤ INTERMEDIATE DATA FOR RESTARTING OF * C* THIS SUBROUTINE WRITES C* MAIN PROGRAM FROM LAST RUN COMMON/PROC/ HRSL, ALPAR, DIST, BI, KREF, ROUR, SPECR, EMIS, HTC (140, 3), BOLT, VOLSPR, WIDTH, QE (140, 3), NRESIS, RESIS, IX Ł /ELMT/ NEL, NP, GND(140, 3), B(140, 3), C(140, 3), EAREA(140), NPP1, 8 IES(140,2), ESL(140,3), BETA, XC(140,3), YC(140,3), DEFO, Ł NE(140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70) 5 /INOUT/TEMPS(70), TEMPV(70), TEMPVS(70), QEI(70), VX(70), \$ GNDI (70), VY1 (70), VY2 (70), VY3 (70), ELSI (30), & VY4(70), VY5(70), VY6(70), HFG, TEMPF(70) ۵ /SPLIN/TIME(3), TIMER(20), QSTAG(20), XP1(25), CP1(4,25), ND1, 8 XP2(60), CP2(4,60), ND2, XP3(25), CP3(4,25), ND3, TS, & XP4(25), CP4(4,25), ND4, XP5(15), CP5(4,15), ND5, XP6(15), 8 CP6(4,15), XP7(15), CP7(4,15), ND7, XP8(15), CP8(4,15), 8 ND6, ND8, XP9(15), CP9(4, 15), ND9, XP0(15), CP0(4, 15), ND0. & ELSS(30), TESL(30)Ł DIMENSION TA(3,96), QT(70)INTEGER TS, JK, JNT, NPP1, FIRTS **REWIND 8** IF(TS .LE. 3) THEN LTS = TSELSE

```
LTS = 3
     END IF
     WRITE(8,*) TS, FIRTS, JK, JNT, NRESIS, IX
     WRITE(8,*) NPP1, TIMEN, RESIS, TEMPD
     WRITE(8,*) (TIME(I), I=1, LTS), TVU, DEFO
     WRITE(8,*) ((TA(I,J),I=2,3),J=1,NP)
      IF(FIRTS .GT. 1) THEN
        WRITE(8,*) ((QE(I,J),J=1,2),I=1,NEL)
        WRITE(8,*) (QT(I), I=1, JNT)
      END IF
      RETURN
      END
         SUBROUTINE MAINOUT (TA, TSTAR, NTS, MN, NCOLT, NROWT)
 *************************
С
C * THIS SUBROUTINE PRINT OUT TEMPERATURES FOR HEAT PIPE SHELL *
C * AND WICK
COMMON/MATG/ AMC(140,151), RM(140), THETA(140), FLD(140),
                   AM(140, 140), BM(140), CIJ(3, 3), KIJ(3, 3)
     ۵
            /TEPS/ TEMPR, TEMPI, TMEL, DETP, DELTD, TEMPG1 (140), THETAG (140),
     8
                    THETAF (140), THETAO (140), THETTO (140), THETAB (70), TEMPD
     &
            /PROC/ HRSL, ALPAR, DIST, BI, KREF, ROUR, SPECR, EMIS, HTC (140, 3),
     8
                    BOLT, VOLSPR, WIDTH, QE (140, 3), NRESIS, RESIS, IX
     ٤
            /ELMT/ NEL, NP, GND(140, 3), B(140, 3), C(140, 3), EAREA(140), NPP1,
     8
                    IES(140,2),ESL(140,3),BETA,XC(140,3),YC(140,3),DEFO,
     8
     8
                    NE (140), TLENG, PNOD(5, 30), EBC(3, 3), CM(3, 3), GNDB(70)
            /INOUT/TEMPS(70), TEMPV(70), TEMPVS(70), QEI(70), VX(70),
     <u>گ</u>
                    GNDI(70), VY1(70), VY2(70), VY3(70), ELSI(30),
     8
                    VY4(70).VY5(70),VY6(70),HFG,TEMPF(70)
     ٤
            /SPLIN/TIME(3), TIMER(20), QSTAG(20), XP1(25), CP1(4,25), ND1,
     8
                    XP2(60), CP2(4,60), ND2, XP3(25), CP3(4,25), ND3, TS,
     ٤
                    XP4(25), CP4(4,25), ND4, XP5(15), CP5(4,15), ND5, XP6(15),
     ٤
                    CP6(4,15),XP7(15),CP7(4,15),ND7,XP8(15),CP8(4,15),
     8
                    ND6, ND8, XP9(15), CP9(4, 15), ND9, XPO(15), CPO(4, 15), ND0,
     ٤
                    ELSS(30), TESL(30)
     ۵
             /OUTPT/MO.IDAY.IYEAR, TITLE, CASE, NUMBER, NO, TEMPCC, HTCC, IOUT,
     ٤
                    TIMEN.DELT.DELT1.DELTP
     ۶
      INTEGER TS, PNOD, IT, IOUT
      DIMENSION TA(3,96)
C.....PRINT BASIC DATA ON FILE JANG.....
       IF(IOUT .EQ. 1) THEN
         WRITE(6,100) MO, IDAY, IYEAR
         WRITE(6,110) TITLE, CASE, NUMBER
         WRITE(6,120) NO
         WRITE(6,130) TLENG, DIST
                                                                 ORIGINAL PAGE IS
         WRITE(6,140) WIDTH, ELSI(15)
                                                                 OF POOR QUALITY
         WRITE(6,150) TEMPI, TSTAR
         WRITE(6,160) TMEL, DETP, HRSL
         WRITE(6,170) TEMPCC, HTCC
         WRITE(6,180) TEMPR, EMIS
```

WRITE(6,190) DELT, BETA, NTS, MN WRITE(6,200) NEL,NP • WRITE (6,210) WRITE(6,220) WRITE(6,230) WRITE(6, 240)WRITE(6, 250)IOUT = 2END IF C.....PRINT TEMPERATURE DISTRIBUTIONS..... IF(TS .LT. 3) THEN IT = TSELSE IT = 3END IF WRITE(6,300) TIME(IT) WRITE(6,310) DO 400 I = 1, NROWTWRITE(6,320) (TA(IT, PNOD(I, J)), J=1,11) 400 CONTINUE WRITE(6, 330)DO 420 I = 1, NROWTWRITE(6,320) (TA(IT, PNOD(I, J)), J=12, NCOLT) 420 CONTINUE C.....PRINT TEMPERATURE DISTRIBUTIONS FOR PLOT..... TMN = TIME(IT) - TIMENIF(TIME(IT) .EQ. TIMEN .OR. ABS(TMN) .LT. DELT/1000.) THEN WRITE(7,340) TIME(IT) WRITE(7,350) (TA(IT,J), J=1,NP) IF (TIMEN .EQ. DELT1) THEN TIMEN = DELTP ELSE TIMEN = TIMEN + DELTP END IF END IF 100 FORMAT(///20X,37('*')/20X, '*',10X, 'PROGRAM - HPMAIN',9X, '*'/20X, & '*',9X,'INPUT FILE - HPDAT',8X, '*'/20X, '*',11X, 'OUTPUT - JANG', & 11X, '*'/20X, '*', 7X, 'OUTPUT FOR PLOT - DATA', 6X, '*'/20X, '*', & 8X, 'FOR RESTART - RESTA', 8X, '*'/20X, & '*',8X,'DATE : ',I3,'/',I3,'/',I5,7X,'*'/20X,37('*')/) 110 FORMAT (/20X, 37('-')//20X, '**', 6X, 3A9, '**'//20X, 37('-')/) 120 FORMAT(/24X,'** CASE NUMBER ', 16, ' **'/72('-')//) 130 FORMAT(3X,'TOTAL LENGTH OF HEAT PIPE(TLENG)',6X,E10.3,4X,'M'/ & 3X, 'HEIGHT OF VAPOR SPACE(DIST)', 11X, E10.3, 4X, 'M') 140 FORMAT(3X, 'ELEMENT THICKNESS(WIDTH)', 14X, E10.3, 4X, 'M'/ & 3X, 'DISTANCE BETWEEN NODES(ELSI)', 10X, E10.3, 4X, 'M'/) 150 FORMAT (3X, 'INITIAL TEMP. (TEMPI)', 18X, F10.3, 4X, 'K'/ & 3X, 'TRANSIENT TEMP. OF VAPOR(TSTAR)', 7X, F10.3, 4X, 'K') 160 FORMAT(3X, 'PHASE CHANGE TEMP. (TMEL) ', 14X, F10.3, 4X, 'K'/ & 3X, 'TEMP. DIFFERENCE FROM TMEL(DETP)', 6X, F10.3, 4X, 'K'/ & 3X, 'LATENT HEAT OF PHASE CHANGE(HRSL)', 5X, E10.3, 4X, 'J/KG'/)

```
170 FORMAT(3X, 'REF. TEMP. FOR CONVECTION(TEMPC)', 6X, F10.3, 4X, 'K'/
    & 3X, 'HEAT TRANSFER COEF. (HTC)', 14X, F10.3, 4X, 'W/M**2*K')
180 FORMAT(3X, 'REF. TEMP. FOR RADIATION(TEMPR)', 7X, F10.3, 4X, 'K'/
    & 3X, 'EMISSIVITY', 28X, F10.3, 4X/)
190 FORMAT(3X, 'TIME STEP(DELT)', 23X, F10.3, 4X, 'SECOND'/
    & 3X, 'IMPLICIT TIME SCHEME (BETA) ', 12X, F10.3, 4X/
    & 3X, 'NUMBER OF STEP FOR IMPLICIT(NTS)', 6X, I10, 4X/
    & 3X, 'TOTAL NUMBER OF TIME STEP(MN)',9X, I10, 4X/)
200 FORMAT(3X, 'NUMBER OF ELEMENT(NEL)', 16X, 110, 4X/
    & 3X, 'NUMBER OF NODAL POINT(NP)', 13X, I10, 4X)
210 FORMAT(/3X, 'INITIAL TIME', 40X, 'SECOND')
220 FORMAT(3X, 'FINAL TIME', 42X, 'SECOND')
230 FORMAT(/3X, 'SRU')
240 FORMAT(3X, 'CPU TIME', 44X, 'SECOND')
250 FORMAT(3X, 'EXPENSE', 45X, 'DOLLARS'//72('-')////)
300 FORMAT(2X,83('-')/26X, '** TIME = ',2X,F9.3,2X, 'SECONDS**'/)
310 FORMAT (5X, 'LEADING EDGE (EVAPORATOR) '/)
320 FORMAT(1X,12F8.2)
330 FORMAT(/55X, 'TRAILING EDGE(CONDENSER)'/)
340 FORMAT(F9.3)
350 FORMAT(10(F8.2,1X))
     RETURN
```

```
END
```

APPENDIX C

SAMPLE INPUT DATA

Input data are needed for initial and boundary conditions, dimensions of the heat pipe, information on nodal points and elements, properties, and operating conditions of the program. Input file (HPDAT) has all these data. A grid generation program, which was written by Dr. J. G. Hartley, was used to generate data for the element grid. A sample for input data file HPDAT is listed in the following pages.

293., 371., 700., 1., 1.045E8, .0044, .0127 1.,10.,.025,100,2,10,1,1 2 0 6 138 96 0 1 6 0 2 3 1 2 2 5 3 2 18 4 • 3 18 3 5 5 3 6 3 .0000 .0000 .0250 1 90 86 87 .0000 .0250 .0020 .0000E+00 1 -1. 0. 2 -1. 0. 1 0. 2 0. .0000E+00 .5000E+01 .0250 .0020 .0000 2 90 87 91 .0000 .0000 .0020 .0000E+00 .5000E+01 .0000E+00 1 -1. 0. 2 -1. 0. 1 0. 2 0. 3 86 82 83 .0250 .0000 .0500 .0000 .0500 .0020 .5000E+01 .0000E+00 1 -1. 0. 2 -1. 0. 1 0. 2 0. .0000E+00 4 86 83 87 .0250 .0000 .0500 .0020 .0250 .0020 .5000E+01 .0000E+00 .0000E+00 1 -1. 0. 2 -1. 0. 1 0. 2 0. 5 82 78 79 .0000 .0750 . .0000 .0750 .0020 .0500 .0000E+00 1 -1. 0. 2 -1. 0. 1 0. 2 0. .5000E+01 .0000E+00 .0020 6 82 79 83 .0750 .0020 .0500 .0000 .0500 .0000E+00 1 -1. 0. 2 -1. 0. 1 0. 2 0. .5000E+01 .0000E+00 135 91 87 92 .0000 .0250 .0020 .0250 .0047 .0020 .0000E+00 .0000E+00 1 -1. 0. 2 -1. 0. 1 0. 2 0. .4000E+01 .0047 136 91 92 94 .0000 .0020 .0250 .0000 .0047 .4000E+01 .0000E+00 .0000E+00 1 -1. 0. 2 -1. 0. 1 0. 2 0. .0500 137 87 83 88 .0250 .0020 .0500 .0020 .0047 .4000E+01 .0000E+00 .0000E+00 1 -1. 0. 2 -1. 0. 1 0. 2 0. 138 87 88 92 .0250 .0020 .0500 .0047 .0250 .0047 .0000E+00 1 -1. 0. 2 -1. 0. 1 0. 2 0. .4000E+01 .0000E+00 -1 -1 -1 -1 -1 -1 0. 0. 0. 0. 0. 0. 90 86 82 78 74 70 66 62 58 54 50 46 42 38 34 30 26 22 18 14 10 6 2 3 0 0 0 0 0 0

293. .8

SCALE FACTOR

21							
.0	1.	.05	.87	.1	. 48	.15	.33
.2	.25	.25	.19	.3	.15	.35	.13
.4	.1	.45	.08	.5	.07	.55	.06
.6	.055	.65	.05	.7	.05	.75	.049
.8	.049	.85	.049	.9	.049	.95	.049
1.	.049						
-2.6	0.	.0					

HEAT FLUX

19 0. 75.E3 30.E3 360. 50.E3 0.0 120. 10.E3 240. 840. 140.E3 1375. 239.E3 720. 120.E3 100.E3 450. 600. 1250. 230.E3 236.E3 1300. 1350. 238.E3 1500. 240.E3 240.E3 240.E3 1400. 240.E3 1430. 1450. 1650. 240.E3 240.E3 2000. 240.E3 1800. 0.0 0.0

APPENDIX D

THERMAL PROPERTIES OF SODIUM

The properties of sodium in the vapor state are expressed in terms of temperatures, which are in degree Kelvin in the following property equations:

Saturation vapor pressure[60] $[N/m^2]$:

 $P = 2.29 \times 10^{11} \times \frac{1}{T^{0.5}} \times 10^{\frac{-5567}{T}}$

Density of sodium vapor[60] $[kg/m^3]$:

 $\rho = 6.335 \times 10^8 \times \frac{1}{T^{1.5}} \times 10^{\frac{-5567}{T}}$

Viscosity of sodium vapor[61] $[N-S/m^2]$:

 $\mu = 6.083 \times 10^{-9} \times T + 1.2606 \times 10^{-5}$

Enthalpy of sodium vapor [60] [J/kg]:

 $h_f = 271,831. - 1,595.3 \times T - 0.29024 \times T^2 + 2.4 \times 10^6 \times \exp{\frac{-13,600}{T}}$

 $h_{fg} = 4,636,437.26 - 180.817 \times T$

Thermal properties of sodium in the solid and liquid state [62,63] are tabulated as follows:

Density of solid sodium

T[K]	$\rho [kg/m^3]$	T[K]	ho [kg/m ³]
273. 293. 313. 333. 353. 371.	972.5 968.4 964.2 959.9 955.5 951.4	283. 303. 323. 343. 363.	970.5 966.3 962.1 957.7 953.2

Specific heat of solid sodium

T[K]	c _p [J/kg-K]	T[K]	c _p [J/kg-K]
273. 323. 371.	1200. 1256. 1364.	298. 348.	1223. 1308.

Conductivity of solid sodium

T[K]	K[W/m-K]	T[K]	K[W/m-K]
100. 200. 371.	136. 142. 141.	150. 250.	140. 143.

Density of liquid sodium

T[K]	$ ho[kg/m^3]$	T[K]	$\rho [kg/m^3]$
373.	927.	473.	904.
573.	882.	673.	859.
773.	834.	873.	809.
973.	783.	1073.	757.

Specific heat of liquid sodium

T[K]	c _p [J/kg-K]	T[K]	c _p [J/kg-K]
371.	1385.	373.	1384.
473.	1340.	573.	1305.
673.	1279.	773.	1262.
873.	1255.	973.	1255.
1073.	1269.	1173.	1289.

Conductivity of liquid sodium

T[K]	K[W/m-K]	T[K]	K[W/m-K]
473. 673. 873. 1073.	81.5 71.0 63.9 58.3	573. 773. 973.	75.7 67.2 61.0

APPENDIX E

THERMAL PROPERTIES OF HASTELLOY X AND STAINLESS STEEL

Thermal properties of hastelloy x[64] for heat pipe shell and type 316 stainless steel[64] for wick screen are tabulated as follow:

Conductivity of hastelloy x

T[K]	K[W/m-K]
373.	11.1
573.	14.7
773.	20.6
973.	22.8

Specific heat of hastelloy x

T[K]	c _p [J/kg-K]
588.	498.
923.	582.
1143.	699.

Conductivity of stainless steel

T[K]	K[W/m-K]	T[K]	K[W/m-K]
80.4 154.8 247.3 379.1 516.5 687.8 855.7 1182.1	8.3 11.5 14.2 16.5 18.4 20.8 22.8 26.9	107.6 195.2 299.3 442.5 611.1 763.7 980.9	9.7 12.8 15.2 17.5 19.8 21.7 24.7

Specific heat of stainless steel

T[K]	$c_p[J/kg-K]$	T[K]	c _p [J/kg-K]
71.8	286.5	114.0	329.7
162.9	367.0	197.9	392.3
270.0	433.4	337.3	465.0
435.1	500.7	587.6	540.7
736.5	561.8	967.7	604.5
1231.1	648.2	1468.5	690.2

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